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| Name | Brent P. Johnson Fields & Johnson, P | с. | | | | | |
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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In Re the Continuation-in-Part Application of Edwin L. Adair, Jeffrey L. Adair, Randall S. Adair Corresponding to U.S. Serial No. 08/944,322 Filed: October 6, 1997 "Reduced Area Imaging Devices" For: "Express Mail" mailing label number EL146014919US Date of Deposit: _____October 20, 1997 I hereby certify that the following: -- Patent application -- 11 sheets of formal drawings -- Declaration and Power of Attorney -- Declaration Under 37 CFR 1.102 -- Petition to Make Special Under 37 CFR 1.102 -- Verified Statement for Small Entity -- Patent Application Transmittal form -- 1 original and 1 copy of Fee Transmittal form and Fee Determination Record form -- Check for \$ 395.00 for the filing fees -- Return postcard

are being deposited with the United States Postal Service "Express Mail Post Office to Addressee" service under 37 CFR 1.10 on the date indicated above and are addressed to the BOX PATENT APPLICATION, Assistant Commissioner for Patents, Washington, D.C. 20231.

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Katherine L. Goncalves 8480 East Orchard Road, Suite 5600 Englewood, CO 80111 (303) 689-9100

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REDUCED AREA IMAGING DEVICES

This application is a continuation-in-part of U.S. Serial No. 08/944,322, filed October 6, 1997, and entitled "Reduced Area Imaging Devices Incorporated Within Surgical Instruments."

5 Technical Field

This invention relates to solid state image sensors and associated electronics, and more particularly, to solid state image sensors which are configured to be of a minimum size.

Background Art

In recent years, endoscopic surgery has become the accepted standard for conducting many types of surgical procedures, both in the medical and dental arenas. The availability of imaging devices enabling a surgeon or dentist to view a particular surgical area through a small diameter endoscope which is introduced into small cavities or openings in the body results in much less patient trauma as well as many other advantages.

In many hospitals, the rod lens endoscope is still used in endoscopic surgery. The rod lens endoscope includes a very precise group of lenses in an elongate and rigid tube which are able to accurately transmit an image to a remote camera in line with the lens group. The rod lens endoscope,

- because of its cost of manufacture, failure rate, and requirement to be housed within a rigid and straight housing, is being increasingly replaced by solid state imaging technology which enables the image sensor to be placed at the distal tip of the investigating device. The three most common
- 25 solid state image sensors include charged coupled devices (CCD), charge injection devices (CID) and photo diode arrays (PDA). In the mid-1980s,

complementary metal oxide semiconductors (CMOS) were developed for industrial use. CMOS imaging devices offer improved functionality and simplified system interfacing. Furthermore, many CMOS imagers can be manufactured at a fraction of the cost of other solid state imaging

5 technologies.

One particular advance in CMOS technology has been in the active pixel-type CMOS imagers which consist of randomly accessible pixels with an amplifier at each pixel site. One advantage of active pixel-type imagers is that the amplifier placement results in lower noise levels than

- 10 CCDs or other solid state imagers. Another major advantage is that these CMOS imagers can be mass produced on standard semiconductor production lines. One particularly notable advance in the area of CMOS imagers including active pixel-type arrays is the CMOS imager described in U.S. Patent No. 5,471,515 to Fossum, et al. This CMOS imager can
- 15 incorporate a number of other different electronic controls that are usually found on multiple circuit boards of much larger size. For example, timing circuits, and special functions such as zoom and anti-jitter controls can be placed on the same circuit board containing the CMOS pixel array without significantly increasing the overall size of the host circuit board.
- 20 Furthermore, this particular CMOS imager requires 100 times less power than a CCD-type imager. In short, the CMOS imager disclosed in Fossum, et al. has enabled the development of a "camera on a chip."

Passive pixel-type CMOS imagers have also been improved so that they too can be used in an imaging device which qualifies as a "camera on a chip." In short, the major difference between passive and active CMOS pixel arrays is that a passive pixel-type imager does not perform signal amplification at each pixel site. One example of a manufacturer which has developed a passive pixel array with performance nearly equal to known active pixel devices and being compatible with the read out circuitry disclosed in the U.S. Patent No. 5,471,515 is VLSI Vision, Ltd., 1190 Saratoga Avenue, Suite 180, San Jose, California 95129. A further

5 description of this passive pixel device may be found in co-pending application, Serial No. 08/976,976, entitled "Reduced Area Imaging Devices Incorporated Within Surgical Instruments," and is hereby incorporated by reference.

In addition to the active pixel-type CMOS imager which is disclosed in U.S. Patent No. 5,471,515, there have been developments in the industry for other solid state imagers which have resulted in the ability to have a "camera on a chip." For example, Suni Microsystems, Inc. of Mountain View, California, has developed a CCD/CMOS hybrid which combines the high quality image processing of CCDs with standard CMOS circuitry

- 15 construction. In short, Suni Microsystems, Inc. has modified the standard CMOS and CCD manufacturing processes to create a hybrid process providing CCD components with their own substrate which is separate from the P well and N well substrates used by the CMOS components. Accordingly, the CCD and CMOS components of the hybrid may reside on
- 20 different regions of the same chip or wafer. Additionally, this hybrid is able to run on a low power source (5 volts) which is normally not possible on standard CCD imagers which require 10 to 30 volt power supplies. A brief explanation of this CCD/CMOS hybrid can be found in the article entitled "Startup Suni Bets on Integrated Process" found in *Electronic*
- 25 News, January 20, 1997 issue. This reference is hereby incorporated by reference for purposes of explaining this particular type of imaging processor.

Another example of a recent development in solid state imaging is the development of CMOS imaging sensor which is able to achieve analog to digital conversion on each of the pixels within the pixel array. This type of improved CMOS imager includes transistors at every pixel to provide digital instead of analog output that enable the delivery of decoders and sense amplifiers much like standard memory chips. With this new technology, it may, therefore, be possible to manufacture a true digital "camera on a chip." This CMOS imager has been developed by a Stanford University joint project and is headed by Professor Abbas el-Gamal.

10 A second approach to creating a CMOS-based digital imaging device includes the use of an over-sample converter at each pixel with a one bit comparator placed at the edge of the pixel array instead of performing all of the analog to digital functions on the pixel. This new design technology has been called MOSAD (multiplexed over sample

- 15 analog to digital) conversion. The result of this new process is low power usage, along with the capability to achieve enhanced dynamic range, possibly up to 20 bits. This process has been developed by Amain Electronics of Simi Valley, California. A brief description of both of the processes developed by Stanford University and Amain Electronics can be
- 20 found in an article entitled "A/D Conversion Revolution for CMOS Sensor?," September 1998 issue of Advanced Imaging. This reference is also hereby incorporated by reference for purposes of explaining these particular types of imaging processors.

The above-mentioned developments in solid state imaging technology have shown that "camera on a chip" devices will continue to be enhanced not only in terms of the quality of imaging which may be

achieved, but also in the specific construction of the devices which may be manufactured by new breakthrough processes.

Although the "camera on a chip" concept is one which has great merit for application in many industrial areas, a need still exists for a

5 reduced area imaging device which can be used in even the smallest type of endoscopic instruments in order to view areas in the body that are particularly difficult to access, and to further minimize patient trauma by an even smaller diameter invasive instrument.

It is one object of this invention to provide reduced area imaging devices which take advantage of "camera on a chip" technology, but rearrange the circuitry in a stacked relationship so that there is a minimum profile presented when used within a surgical instrument or other investigative device. It is another object of this invention to provide low cost imaging devices which may be "disposable." It is yet another object

15 of this invention to provide reduced area imaging devices which may be used in conjunction with standard endoscopes by placing the imaging device through channels which normally receive other surgical devices, or receive liquids or gases for flushing a surgical area. It is yet another object of this invention to provide a surgical device with imaging capability which

20 may be battery powered and only requires one conductor for transmitting a pre-video signal to video processing circuitry within or outside the sterile field of the surgical area.

In addition to the intended use of the foregoing invention with respect to surgical procedures conducted by medical doctors, it is also contemplated that the invention described herein has great utility with respect to oral surgery and general dental procedures wherein a very small imaging device can be used to provide an image of particularly difficult to

access locations. Additionally, while the foregoing invention has application with respect to the medical and dental fields, it will also be appreciated by those skilled in the art that the small size of the imaging device set forth herein can be applied to other functional disciplines

5 wherein the imaging device can be used to view difficult to access locations for industrial equipment and the like. Therefore, the imaging device of this invention could be used to replace many industrial boroscopes.

The "camera on a chip" technology can be furthered improved with respect to reducing its profile area and incorporating such a reduced area imaging device into very small investigative instruments which can be used in the medical, dental, or other industrial fields.

Disclosure of the Invention

In accordance with the present invention, reduced area imaging devices are provided. The term "imaging device" as used herein describes the imaging elements and processing circuitry which is used to produce a video signal which may be accepted by a standard video device such as a television or video monitor accompanying a personal computer. The term "image sensor" as used herein describes the components of a solid state

- 20 imaging device which captures images and stores them within the structure of each of the pixels in the array of pixels found in the imaging device. As further discussed below, the timing and control circuits can be placed either on the same planar structure as the pixel array, in which case the image sensor can also be defined as an integrated circuit, or the timing and control
- 25 circuitry can be placed remote from the pixel array. The terms "signal" or "image signal" as used herein, and unless otherwise more specifically

Samsung Exhibit 1003 Page 12 of 208 defined, refer to an image which at some point during its processing by the imaging device, is found in the form of electrons which have been placed in a specific format or domain. The term "processing circuitry" as used herein refers to the electronic components within the imaging device which

5 receive the image signal from the image sensor and ultimately place the image signal in a usable format. The terms "timing and control circuits" or "circuitry" as used herein refer to the electronic components which control the release of the image signal from the pixel array.

In a first embodiment, the image sensor, with or without the timing and control circuitry, may be placed at the distal tip of the endoscopic instrument while the remaining processing circuitry may be found in a small remote control box which may communicate with the image sensor by a single cable.

In a second embodiment, the image sensor and the processing
circuitry may all be placed in a stacked arrangement of circuit boards and positioned at the distal tip of the endoscopic instrument. In this embodiment, the pixel array of the image sensor may be placed by itself on its own circuit board while the timing and control circuitry and processing circuitry are placed on one or more other circuit boards. Alternatively, the
circuit board, while the remaining processing circuitry can be placed on one or more of the other circuit boards.

In yet another embodiment, the imaging device may be adapted for use with a standard rod lens endoscope wherein the imaging device is placed within a standard camera housing which is configured to connect to a standard "C" or "V" mount connector. A generic endoscope may be used in the first and second embodiments which includes a very small diameter tubular portion which is inserted within the patient. The tubular portion may be made of a flexible material having a central lumen or opening therein for receiving

5 the elements of the imaging device. The tubular portion may be modified to include an additional concentric tube placed within the central lumen and which enables a plurality of light fibers to be placed circumferentially around the periphery of the distal end of the tubular portion. Additionally, control wires may extend along the tubular portion in order to make the endoscope steerable. The material used to make the endoscope can be

compatible with any desired sterilization protocol, or the entire endoscope can be made sterile and disposable after use.

For the configuration of the imaging device which calls for the array of pixels and the timing and control circuitry to be placed on the same .
15 circuit board, only one conductor is required in order to transmit the image signal to the processing circuitry. In the other configuration of the imaging device wherein the timing and control circuits are incorporated onto other circuit boards, a plurality of connections are required in order to connect the timing and control circuitry to the pixel array and the one conductor is also required to transmit the image signal.

Brief Description of the Drawings

Figure 1a illustrates a first embodiment including a fragmentary cross-sectional view of a generic endoscopic instrument, and a fragmentary perspective view of a control box, the endoscope and control box each

25 incorporating elements of a reduced area imaging device;

Samsung Exhibit 1003 Page 14 of 208 Figure 1b is an enlarged fragmentary partially exploded perspective view of the distal end of the endoscopic instrument specifically illustrating the arrangement of the image sensor with respect to the other elements of the tubular portion of the endoscope;

Figure 2a is a fragmentary cross-sectional view of a second embodiment of this invention illustrating another generic endoscope wherein the imaging device is incorporated in its entirety at the distal tip of the endoscope;

Figure 2b is an enlarged fragmentary partially exploded perspective view of the distal end of the endoscope of Figure 2a illustrating the imaging device;

Figure 3a is an elevational fragmentary cross-sectional view of the image sensor incorporated with a standard camera housing for connection to a rod lens endoscope;

Figure 3b is a fragmentary cross-sectional view of the imaging device incorporated within the camera housing of Figure 3a;

Figure 3c is a fragmentary cross-sectional view similar to that of Figure 3b illustrating a battery as an alternate source of power;

Figure 4 is a schematic diagram of the functional electronic components which make up the imaging device;

Figure 4a is an enlarged schematic diagram of a circuit board which may include the array of pixels and the timing and control circuitry;

Figure 4b is an enlarged schematic diagram of a video processing board having placed thereon the processing circuitry which 25 processes the pre-video signal generated by the array of pixels and which converts the pre-video signal to a post-video signal which may be accepted by a standard video device; and

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Figures 5a-5e are schematic diagrams that illustrate an example of specific circuitry which may be used to make the imaging device.

Best Mode for Carrying Out the Invention

In accordance with one embodiment of the invention as shown in 5 Figure 1a, an endoscope 10 is provided which incorporates a reduced area imaging device 11, shown in Figure 1b. As further discussed below, the elements of the imaging device may all be found at one location or the elements may be separated from one another and interconnected by the appropriate cable(s). The array of pixels making up the image sensor 10 captures images and stores them in the form of electrical energy by

conversion of light photons to electrons. This conversion takes place by the photo diodes in each pixel which communicate with one or more capacitors which store the electrons. The structure of the endoscope 10 includes a flexible or rigid tubular portion 14 which is inserted into the

15 body of the patient and is placed at the appropriate location for viewing a desired surgical area. The tubular portion 14 attaches at its proximal end to a handle portion 12 which may be grasped by a surgeon who is conducting the endoscopic procedure. The handle 12 may include a central lumen or channel 13 which receives therethrough one or more cables or other

20 structures which extend to the distal end 16 of tubular portion 14. Handle portion 12 may further include a supplementary channel 15 which intersects with central channel 13 and which may provide another point of entry for other cables, fluids or operative instruments to be placed through the endoscope.

Figure 1b illustrates the distal end of the endoscope 16. The distal end 16 may be characterized by an outer tube 18 which traverses the length

of the tubular portion 14 and connects to the handle portion 12. Placed concentrically within the outer tube 18 may be one or more inner tubes 20. In Figure 1b, the gap between inner tube 20 and outer tube 18 forms a space in which one or more light fibers 22 or control wires 24 may be

5 placed. As well understood by those skilled in the art, a plurality of circumferentially spaced light fibers as illustrated in Figure 1b can be used to illuminate the surgical site. Additionally, the control wires 24 may communicate with a control mechanism (not shown) integrated on the handle portion 12 for manipulating the distal end 16 of the endoscope in a 10 desired direction. The flexible tubular portion 14 coupled with a steerable feature enables the endoscope to be placed within winding bodily passages or other locations difficult to reach within the body.

An image sensor 40 may be placed within the central channel
defined by inner tube 20. In the configuration shown in Figure 1b, a cable
26 is used to house the conductors which communicate with the image
sensor 40. An intermediate support tube 28 may be placed concentrically
outside of cable 26 and concentrically within inner tube 20 to provide the
necessary support for the cable 26 as it traverses through the inner channel
defined by inner tube 20. In lieu of support tube 28, other well-known
means may be provided to stabilize the cable 26 such as clips or other
fastening means which may attach to the inner concentric surface of inner
tube 20.

A control box 30 may be placed remote from the endoscope 10. The control box 30 contains some of the processing circuitry which is used to process the image signal produced by image sensor 40. Therefore, the imaging device 11 as previously defined would include the processing circuitry within control box 30 and the image sensor 40 located at the distal

Samsung Exhibit 1003 Page 17 of 208 tip of the endoscope. Control box 30 communicates with image sensor 40 by means of cable 32 which may simply be an insulated and shielded cable which houses therein cable 26. Cable 32 is stabilized with respect to the handle portion 12 by means of a fitting 34 which ensures that cable 32

5 cannot be inadvertently pushed or pulled within channel 13. Additionally, an additional fitting 35 may be provided to stabilize the entry of a light cable 36 which houses the plurality of light fibers 22.

Image sensor 40 is illustrated as being a planar and square shaped member. However, the image sensor may be modified to be in a planar and circular shape to better fit within the channel defined by inner tube 20. Accordingly, Figure 1b further shows an alternate shaped image sensor 40' which is round. A lens group or system 42 may be incorporated at the distal end of the endoscope in order to manipulate the image prior to it being impinged upon the array of pixels on the image sensor 40. This lens

- 15 system 42 may be sealed at the distal end 16 of the endoscope so that the tubular portion 14 is impervious to fluids entering through the distal end 16. In the configuration of the imaging device 11 in Figures 1a and 1b, there are only three conductors which are necessary for providing power to the image sensor 40, and for transmitting an image from the image sensor
- 20 40 back to the processing circuitry found within control box 30. Namely, there is a power conductor 44, a grounding conductor 46, and an image signal conductor 48 each of which are hard wired to the image sensor. Thus, cable 26 may simply be a three-conductor 50 ohm cable.

Image sensor 40 can be as small as 1 mm in its largest dimension.
However, a more preferable size for most endoscopic procedures would dictate that the image sensor 40 be between 4 mm to 8 mm in its largest dimension. The image signal transmitted from the image sensor through

conductor 48 is also herein referred to as a pre-video signal. Once the prevideo signal has been transmitted from image sensor 40 by means of conductor 48, it is received by video processing board 50. Video processing board 50 then carries out all the necessary conditioning of the

- 5 pre-video signal and places it in a form so that it may be viewed directly on a standard video device, television or standard computer video monitor. The signal produced by the video processing board 50 can be further defined as a post-video signal which can be accepted by a standard video device. As shown in Figure 1a, a conductor 49 is provided which transmits
- 10 the post-video signal to an output connector 58 on the exterior surface of control box 30. The cable (not shown) extending from the desired video device (not shown) may receive the post-video signal by means of connector 58. Power supply board 52 may convert incoming power received through power source 54 into the desired voltage. In the preferred
- imager incorporated in this invention, the power to the imaging device is simply a direct current which can be a 1.5 volt to a 12 volt source. Incoming power from, for example, a wall receptacle, communicates with power supply board 52 by connector 56. Power supply board 52 takes the incoming power source and regulates it to the desired level. Additionally,
 ground 46 is also shown as extending back to the source of power through connector 56.

Figure 2a illustrates a second embodiment of this invention wherein the imaging device is self-contained entirely within the distal end 16 of the endoscope, and a power source which drives the circuitry within the

25 imaging device may come from a battery 66 housed within handle portion 12. As shown in Figure 2b, the video processing board 50 may be placed directly behind image sensor 40. A plurality of pin connectors 62 serve to electrically couple image sensor 40 with video processing board 50 depending upon the specific configuration of image sensor 40, pin

5 connectors 62 may be provided either for structural support only, or to provide a means by which image signals are transmitted between image sensor 40 and board 50. When necessary, one or more supplementary boards 60 may be provided which further contain processing circuitry to process the image signal and present it in a form which may be directly

- 10 received by a desired video device. The area which is occupied by image sensor 40 may be defined as the profile area of the imaging device and which determines its critical dimensions. Any imaging elements that are found on boards 50 or 60 must be able to be placed on one or more circuit boards which are longitudinally aligned with image sensor 40 along
- 15 longitudinal axis XX. If the profile area is not critical in terms of limiting the largest sized imaging element within the imaging device, then the additional circuit boards 50 and 60 which are normally placed in line with image sensor 40 can be aligned in an offset manner or may be larger than the profile area of image sensor 40. In the configuration of Figure 2b, it is
- 20 desirable that elements 40, 50 and 60 be approximately the same size so that they may fit uniformly within the central channel of the endoscope. Additionally, image sensor 40 may be bonded to lens system 42 in order to provide further structural support to the imaging device 11 when mounted within the distal end 16.

Referring back to the handle portion 12 in Figure 2a, an additional channel 64 may be provided in order that a power supply cable 68 may communicate with battery 66. Conveniently, battery 66 may itself be

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mounted within a well 65 formed in handle portion 12. Cable 68 carries the conductor 44 and ground 46. Cable 68 may intersect with cable 33 within channel 13, cables 68 and 33 extending then to the distal end 16. Cable 33 can be a single conductor cable which transmits the post-video

5 signal to a desired video device. In other words, cable 33 may simply be an insulated and shielded housing for conductor 49 which carries the post-video signal. Because a preferred image sensor of the imaging device 11 may only require a 5 volt power supply, a battery is an ideal power source in lieu of a conductor which would trail the endoscope. Accordingly, the endoscope is made more mobile and easier to handle by eliminating at least one of the trailing cables.

Figure 3a illustrates yet another preferred embodiment of this invention, wherein the imaging device can be used in conjunction with a standard rod lens endoscope 70. As shown, rod lens endoscope 70 includes
a lens train 72 which includes a plurality of highly precise lenses (not shown) which are able to transmit an image from the distal end of the endoscope, to a camera in line with the endoscope. The rod lens endoscope is equipped with a light guide coupling post 74. Light guide post 74 connects to a source of light in the form of a cable 77 having a plurality of

- fiber optic strands (not shown) which communicate with a source of light (not shown). The most common arrangement of the rod lens endoscope also includes a "C" or "V" mount connector 78 which attaches to the eyepiece 76. The "C" or "V" mount attaches at its other end to a camera group 80. The camera group 80 houses one or more of the elements of the imaging device. In this embodiment, the small size of the investor is a size.
- 25 imaging device. In this embodiment, the small size of the imaging device is not a critical concern since the imaging device is not being placed at the distal end of the endoscope. However, the incorporation of the imaging

Samsung Exhibit 1003 Page 21 of 208 device in a housing which would normally hold a traditional camera still provides an advantageous arrangement. As shown, the camera group 80 may include a housing 82 which connects to a power/video cable 86. Fitting 87 is provided to couple cable 86 to the interior elements of the

5 camera group 80 found within housing 82. Figure 3a illustrates an arrangement of the imaging device 11 wherein the image sensor 40 is placed by itself within the housing 82 and the processing circuitry of the imaging device can be positioned in a remote control box as shown in Figure 1a. Accordingly, only three conductors 44, 46 and 48 are necessary

10 for providing power to the image sensor 40 and for transmitting the prevideo signal to the control box. Alternatively, as shown in Figure 3b, the entire imaging device 11 may be incorporated within camera group 80, each of the elements of the imaging device being placed in the stacked arrangement similar to Figure 2b. As discussed above, size is not as much 15 of a concern in the embodiment of Figure 3a and 3b since the camera group housing 82 is much larger than the distal tip of the endoscope of Figures 1a and 2a.

Figure 3c also illustrates the use of a battery 66 which provides source of power to the imaging device in either Figure 3a or 3b. In this arrangement, housing 82 is altered to include a battery housing 69 which houses the battery 66 therein. Battery housing 69 may include a very small diameter channel which may allow conductor 48 or 49 to communicate directly with the processing circuitry or video device, respectively. It will also be understood that the embodiment in Figure 1a may incorporate the

25 use of a battery 66 as the source of power. Thus, handle 12 in Figure 1a may be altered in the same way as housing 82 to allow a battery to be attached to the handle portion 12.

Samsung Exhibit 1003 Page 22 of 208 Figure 4 is a schematic diagram illustrating one way in which the imaging device 11 may be constructed. As illustrated, the image sensor 40 may include the timing and control circuits on the same planar structure. Power is supplied to image sensor 40 by power supply board 52. The

- 5 connection between image sensor 40 and board 52 may simply be a cable having two conductors therein, one for ground and another for transmitting the desired voltage. These are illustrated as conductors 44 and 46. The output from image sensor 40 in the form of the pre-video signal is input to video processor board 50 by means of the conductor 48. In the
- 10 configuration of Figure 4, conductor 48 may simply be a 50 ohm
 conductor. Power and ground also are supplied to video processing board
 50 by conductors 44 and 46 from power supply board 52. The output
 signal from the video processor board 50 is in the form of the post-video
 signal and which may be carried by conductor 49 which can also be a 50
 ohm conductor.

In the first embodiment illustrated in Figure 1a, cable 32 can be used to house conductors 44, 46 and 48. In the embodiment shown in Figure 2a, cable 33 can be used to house conductor 49 by itself when a battery power source is used, or alternatively, cable 33 may house conductors 44, 46 and to itself when a battery power

20 49 if the embodiment of Figure 2a utilizes a power source from board 52.

Optionally, a supplementary processing board 60 may be provided to further enhance the pre-video signal. As shown in Figure 4, the supplementary board 60 may be placed such that the pre-video signal from image sensor 40 is first sent to the supplementary board and then output to the video processor board 50. In this case, the output from board 50 can be carried along conductor 51. This output can be defined as an enhanced prevideo signal. Furthermore, the post-video signal from video processor

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Samsung Exhibit 1003

Samsung Exhibit 1003 Page 23 of 208 board 50 may return to the supplementary board 60 for further processing, as further discussed below. The conductor used to transmit the post-video signal back to the supplementary board is shown as conductor 59. The power supply board 52 may also provide power to the supplementary board

5 in the same manner as to image sensor 40 and board 50. That is, a simple hard-wired connection is made onto the supplementary board for the ground and voltage carrying conductors. As discussed above, image sensor 40 may be placed remotely from boards 50 and 60. Alternatively, image sensor 40, and boards 50 and 60 each may be placed within the distal end 10 of the endoscope.

Although Figure 4 illustrates the image sensor and the timing and control circuits being placed on the same planar structure, it is possible to separate the timing and control circuits from the pixel array and place the timing and control circuits onto video processing board 50. The advantage
in placing the timing and control circuits on the same planar structure as the image sensor is that only three connections are required between image sensor 40 and the rest of the imaging device, namely, conductors 44, 46 and 48. Additionally, placing the timing and control circuits in the pre-video signal having

- 20 less noise. Furthermore, the addition of the timing and control circuits to the same planar structure carrying the image sensor only adds a negligible amount of size to one dimension of the planar structure. If the pixel array is to be the only element on the planar structure, then additional connections must be made between the planar structure and the video
- 25 processing board 50 in order to transmit the clock signals and other control signals to the pixel array. For example, a ribbon-type cable (not shown) or a plurality of 50 ohm coaxial cables (not shown) must be used in order to

Page 24 of 208

control the downloading of information from the pixel array. Each of these additional connections would be hard wired between the boards.

Figure 4a is a more detailed schematic diagram of image sensor 40 which contains an array of pixels 90 and the timing and control circuits 92.
One example of a pixel array 90 which can be used within the invention is similar to that which is disclosed in U.S. Patent No. 5,471,515 to Fossum, et al., said patent being incorporated by reference herein. More specifically, Figure 3 of Fossum, et al. illustrates the circuitry which makes up each pixel in the array of pixels 90. The array of pixels 90 as described

10 in Fossum, et al. is an active pixel group with intra-pixel charged transfer. The image sensor made by the array of pixels is formed as a monolithic complementary metal oxide semiconductor integrated circuit which may be manufactured in an industry standard complementary metal oxide semiconductor process. The integrated circuit includes a focal plane array

- 15 of pixel cells, each one of the cells including a photo gate overlying the substrate for accumulating the photo generated charges. In broader terms, as well understood by those skilled in the art, an image impinges upon the array of pixels, the image being in the form of photons which strike the photo diodes in the array of pixels. The photo diodes or photo detectors
- 20 convert the photons into electrical energy or electrons which are stored in capacitors found in each pixel circuit. Each pixel circuit has its own amplifier which is controlled by the timing and control circuitry discussed below. The information or electrons stored in the capacitors is unloaded in the desired sequence and at a desired frequency, and then sent to the video processing board 50 for further processing.

Although the active pixel array disclosed in U.S. Patent No. 5,471,515 is mentioned herein, it will be understood that the hybrid

Samsung Exhibit 1003 Page 25 of 208 CCD/CMOS described above, or any other solid state imaging device may be used wherein timing and control circuits can be placed either on the same planar structure with the pixel array, or may be separated and placed remotely. Furthermore, it will be clearly understood that the invention

5 claimed herein is not specifically limited to an image sensor as disclosed in the U.S. Patent No. 5,471,515, but encompasses any image sensor which may be configured for use in conjunction with the other processing circuitry which makes up the imaging device of this invention.

The timing and control circuits 92 are used to control the release of the image information or image signal stored in the pixel array. In the image sensor of Fossum, et al., the pixels are arranged in a plurality of rows and columns. The image information from each of the pixels is first consolidated in a row by row fashion, and is then downloaded from one or more columns which contain the consolidated information from the rows.

15 As shown in Figure 4a, the control of information consolidated from the rows is achieved by latches 94, counter 96, and decoder 98. The operation of the latches, counter and decoder is similar to the operation of similar control circuitry found in other imaging devices. That is, a latch is a means of controlling the flow of electrons from each individual addressed pixel in

20 the array of pixels. When a latch 94 is enabled, it will allow the transfer of electrons to the decoder 98. The counter 96 is programmed to count a discrete amount of information based upon a clock input from the timing and control circuits 92. When the counter 96 has reached its set point or overflows, the image information is allowed to pass through the latches 94

25 and be sent to the decoder 98 which places the consolidated information in a serial format. Once the decoder 98 has decoded the information and placed it in the serial format, then the row driver 100 accounts for the serial

Samsung Exhibit 1003 Page 26 of 208

information from each row and enables each row to be downloaded by the column or columns. In short, the latches 94 will initially allow the information stored in each pixel to be accessed. The counter 96 then controls the amount of information flow based upon a desired time

- 5 sequence. Once the counter has reached its set point, the decoder 98 then knows to take the information and place it in the serial format. The whole process is repeated, based upon the timing sequence that is programmed. When the row driver 100 has accounted for each of the rows, the row driver reads out each of the rows at the desired video rate.
- 10 The information released from the column or columns is also controlled by a series of latches 102, a counter 104 and a decoder 106. As with the information from the rows, the column information is also placed in a serial format which may then be sent to the video processing board 50. This serial format of column information is the pre-video signal carried by conductor 48. The column signal conditioner 108 places the column serial information in a manageable format in the form of desired voltage levels. In other words, the column signal conditioner 108 only accepts desired voltages from the downloaded column(s).
- The clock input to the timing and control circuits 92 may simply be a quartz crystal timer. This clock input is divided into many other frequencies for use by the various counters. The run input to the timing and control circuit 92 may simply be an on/off control. The default input can allow one to input the pre-video signal to a video processor board which may run at a frequency of other than 30 hertz. The data input
- 25 controls functions such as zoom. At least for a CMOS type active pixel array which can be accessed in a random manner, features such as zoom

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are easily manipulated by addressing only those pixels which locate a desired area of interest by the surgeon.

A further discussion of the timing and control circuitry which may be used in conjunction with an active pixel array is disclosed in U.S. Patent No. 5.471,515 and is also described in an article entitled "Active Pixel 5 Image Sensor Integrated With Readout Circuits" appearing in NASA Tech Briefs, October 1996, pp. 38 and 39. This particular article is also incorporated by reference.

Once image sensor 40 has created the pre-video signal, it is sent to 10 the video processing board 50 for further processing. At board 50, as shown in Figure 4b, the pre-video signal is passed through a series of filters. One common filter arrangement may include two low pass filters 114 and 116, and a band pass filter 112. The band pass filter only passes low frequency components of the signal. Once these low frequency

- 15 components pass, they are then sent to detector 120 and white balance circuit 124, the white balance circuit distinguishing between the colors of red and blue. The white balance circuit helps the imaging device set its normal, which is white. The portion of the signal passing through low pass filter 114 then travels through gain control 118 which reduces the
- 20 magnitude or amplitude of this portion to a manageable level. The output from gain control 118 is then fed back to the white balance circuit 124. The portion of the signal traveling through filter 116 is placed through the processor 122. In the processor 122, the portion of the signal carrying the luminance or non-chroma is separated and sent to the Y chroma mixer 132. Any chroma portion of the signal is held in processor 122. 25

Referring to the output of the white balance circuit 124, this chroma portion of the signal is sent to a delay line 126 where the signal is then

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further reduced by switch 128. The output of switch 128 is sent through a balanced modulator 130 and also to the Y chroma mixer 132 where the processed chroma portion of the signal is mixed with the processed non-chroma portion. Finally, the output from the Y chroma mixer 132 is sent to

5 the NTSC/PAL encoder 134, commonly known in the art as a "composite" encoder. The composite frequencies are added to the signal leaving the Y chroma mixer 132 in encoder 134 to produce the post-video signal which may be accepted by a television.

Referring back to Figure 4, it further illustrates supplementary board 60 which may be used to digitally enhance or otherwise further condition the pre-video signal produced from image sensor 40. For example, digital enhancement can brighten or otherwise clarify the edges of an image viewed on a video screen. Additionally, the background images may be removed thus leaving only the foreground images or vice versa. The

15 connection between image sensor 40 and board 60 may simply be the conductor 48 which may also transfer the pre-video signal to board 50. Once the pre-video signal has been digitally enhanced on supplementary board 60, it is then sent to the video processor board 50 by means of another conductor 51. The pre-video signal is an analog signal. The

20 digitally enhanced pre-video signal may either be a digital signal or it may be converted back to the analog domain prior to being sent to board 50.

In addition to digital enhancement, supplementary board 60 may further include other circuitry which may further condition the post-video signal so that it may be viewed in a desired format other than NTSC/PAL.

25 As shown in Figures 4, intermediate conductor 59 may transmit the signal output from Y chroma mixer 132 back to the supplementary board 60 where the signal is further encoded for viewing in a particular format. One

Samsung Exhibit 1003 Page 29 of 208

common encoder which can be used includes an RGB encoder 154. The RGB encoder separates the signal into three separate colors (red, green and blue) so that the surgeon may selectively choose to view only those images containing one or more of the colors. Particularly in tissue analysis where dyes are used to color the tissue, the RGB encoder may help the surgeon to

identify targeted tissue.

The next encoder illustrated in Figure 4 is a SVHS encoder 156 (super video home system). This encoder splits or separates the luminance portion of the signal and the chroma portion of the signal prior to entering the video device. Some observers believe that a cleaner signal is input to the video device by such a separation which in turn results in a more clear video image viewed on the video device. The last encoder illustrated in Figure 4 is a VGA encoder 158 which enables the signal to be viewed on a standard VGA monitor which is common to many computer monitors.

One difference between the arrangement of image sensor 40 and the outputs found in Figure 3 of the Fossum, et al. patent is that in lieu of providing two analog outputs [namely, VS out (signal) and VR out (reset)], the reset function takes place in the timing and control circuitry 92. Accordingly, the pre-video signal only requires one conductor 48.

Figures 5a-5e illustrate in more detail one example of circuitry which may be used in the video processing board 50 in order to produce a post-video signal which may be directly accepted by a video device such as a television. The circuitry disclosed in Figures 5a-5e is very similar to circuitry which is found in a miniature quarter-inch Panasonic camera,

25 Model KS-162. It will be understood by those skilled in the art that the particular arrangement of elements found in Figures 5a-5e are only exemplary of the type of video processing circuitry which may be

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incorporated in order to take the pre-video signal and condition it to be received by a desired video device.

As shown in Figure 5a, 5 volt power is provided along with a ground by conductors 44 and 46 to board 50. The pre-video signal carried

5 by conductor 48 is buffered at buffer 137 and then is transferred to amplifying group 138. Amplifying group 138 amplifies the signal to a usable level as well as achieving impedance matching for the remaining circuitry.

The next major element is the automatic gain control 140 shown in
Figure 5b. Automatic gain control 140 automatically controls the signal from amplifying group 138 to an acceptable level and also adds other characteristics to the signal as discussed below. More specifically, automatic gain control 140 conditions the signal based upon inputs from a 12 channel digital to analog converter 141. Converter 141 retrieves stored information from EEPROM (electrically crasable programmable read only memory) 143. EEPROM 143 is a non-volatile memory element which may store user information, for example, settings for color, tint, balance and the like. Thus, automatic gain control 140 changes the texture or visual characteristics based upon user inputs. The signal leaving the automatic
gain control 140 is an analog signal until being converted by analog to

digital converter 142.

Digital signal processor 144 of Figure 5c further processes the converted signal into a serial type digital signal. One function of the microprocessor 146 is to control the manner in which digital signal

25 processor 144 sorts the digital signals emanating from converter 142. Microprocessor 146 also controls analog to digital converter 142 in terms of when it is activated, when it accepts data, when to release data, and the

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Samsung Exhibit 1003 Page 31 of 208 rate at which data should be released. Microprocessor 146 may also control other functions of the imaging device such as white balance. The microprocessor 146 may selectively receive the information stored in the EEPROM 143 and carry out its various commands to further control the

5 other elements within the circuitry.

After the signal is processed by digital signal processor 144, the signal is sent to digital encoder 148 illustrated in Figure 5d. Some of the more important functions of digital encoder 148 are to encode the digital signal with synchronization, modulated chroma, blanking, horizontal drive, and the other components necessary so that the signal may be placed in a

condition for reception by a video device such as a television monitor. As also illustrated in Figure 5d, once the signal has passed through digital encoder 148, the signal is reconverted into an analog signal through digital to analog converter 150.

This reconverted analog signal is then buffered at buffers 151 and then sent to amplifier group 152 of Figure 5e which amplifies the signal so that it is readily accepted by a desired video device. Specifically, as shown in Figure 5e, one SVHS outlet is provided at 160, and two composite or NTSC outlets are provided at 162 and 164, respectively.

From the foregoing, it is apparent that an entire imaging device may be incorporated within the distal tip of an endoscope, or may have some elements of the imaging device being placed in a small remote box adjacent to the endoscope. Based upon the type of image sensor used, the profile area of the imaging device may be made small enough to be placed into an

25 endoscope which has a very small diameter tube. Additionally, the imaging device may be placed into the channels of existing endoscopes to provide additional imaging capability without increasing the size of the

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Samsung Exhibit 1003 Page 32 of 208 endoscope. The imaging device may be powered by a standard power input connection in the form of a power cord, or a small lithium battery may be used.

This invention has been described in detail with reference to 5 particular embodiments thereof, but it will be understood that various other modifications can be effected within the spirit and scope of this invention.

Samsung Exhibit 1003 Page 33 of 208

CLAIMS

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What is claimed is:

A reduced area imaging device comprising: 1.

Sut D' an image sensor lying in a first plane and including an array of pixels for receiving images thereon, said image sensor further including circuitry means on said first plane and coupled to said array of pixels for timing and control of said array of pixels, said image sensor producing a pre-video signal;

> a pre-video conductor før transmitting said pre-video signal. said pre-video conductor having first and second ends, said first end communicating with said image/sensor;

a first circuit board lying in a second plane and longitudinally aligned with said image sensor, said first circuit board being connected to said pre-video conductor at said second end thereof, said first circuit board including circuitry means for converting said pre-video signal to a postvideo signal for reception by a standard video device; and

a power supply electrically coupled with said image sensor for driving said array of pixels and said timing and control means, and electrically coupled to said first circuit board for driving said circuit board.

2. A reduced area imaging device, as claimed in claim 1, wherein:

said image sensor defines a profile area in said first plane, and said first circuit board being positioned so as not to extend substantially beyond said profile area.

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3. A reduced area imaging device, as claimed in claim 1, further including:

a second circuit board electrically coupled with said first circuit board and said image sensor for enhancing said pre-video signal prior to reception by said circuit board, said second circuit board being longitudinally aligned with said first circuit board and said image sensor so as not to extend substantially beyond said profile area.

4. A reduced area imaging device, as claimed in claim 1, wherein:

said first and second planes are offset from and substantially parallel to one another.

5. A reduced area imaging device, as claimed in claim 3, wherein:

said second circuit board lies in a third plane which is offset from and extends substantially parallel to said first and second planes.

Sub DZ 6.

A reduced area imaging device comprising:

an image sensor lying in a first plane and including an array of pixels for receiving images thereon, said image sensor further including circuitry means on said first plane and coupled to said array of pixels for

5 timing and control of said array of pixels, said image sensor producing a pre-video signal;

a control box remote from said image sensor, said control box including circuitry means for receiving said pre-video signal from said

image sensor, and for converting said pre-video signal to a post-video

10 signal which may be received by a standard video device; and

a power supply coupled to said control box and said image sensor for providing power thereto.

7. A reduced area imaging device, as claimed in claim 6, wherein said control box further includes:

a supplementary circuit board for digitally enhancing the prevideo signal, said supplementary circuit board coupled to said circuitry

means for receiving said pre-video signal and for converting said pre-video signal.

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Samsung Exhibit 1003 Page 36 of 208
SeriaL Number-175-685

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ABSTRACT

A reduced area imaging device is provided for use in medical or dental instruments such as an endoscope. In one configuration of the imaging device, the image sensor is placed remote from the remaining

5 circuitry. In another configuration, all of the circuitry to include the image sensor is placed in a stacked fashion at the same location. In a first embodiment of the invention, the entire imaging device can be placed at the distal tip of an endoscope. In a second embodiment, the image sensor is remote from the remaining circuitry according to the first configuration,

10 and wherein a control box can be provided which communicates with the image sensor and is placed remotely from the endoscope. In yet another embodiment, the imaging device can be incorporated in the housing of a standard medical camera which is adapted for use with traditional rod lens endoscopes. In any of the embodiments, the image sensor may be placed 15 alone on a first circuit board, or timing and control circuits may be included

on the first circuit board containing the image sensor. One or more video processing boards can be stacked in a longitudinal fashion with respect to the first board, or the video processing boards may be placed in the control box.

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DECLARATION FOR UTILITY OR DESIGN PATENT APPLICATION (37 CFR 1.63)

Declaration Submitted Declaration Submitted
 with Initial Filing
 (surcharge [37 CFR])

| ttorney Docket Numb | er: F97.13 CIP2 | |
|------------------------|------------------------|---|
| First Named Inventor:_ | Edwin L. Adair, et al. | _ |

COMPLETE IF KNOWN

| Application Number: | |
|---------------------|--|
| Filing Date: | |
| Group Art Unit: | |
| Examiner Name: | |

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

1.16(e)] required)

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled "Reduced Area Imaging Devices"
the specification of which

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is attached hereto

15 attach

DD.

OR

| was filed on (MM/DD/YY) | as United States Application Number or PCT International Application |
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Number ______ as was amended on (MM/DD/YY) ______ (if applicable).

In I hereby state that I have reviewed and understand the contents of the above identified specification, including the claims, as

I acknowledge the duty to disclose information which is material to patentability as defined in 37 CFR § 1.56.

I hereby claim foreign priority benefits under 35 U.S.C. 119(a)-(d) or 365(b) of any foreign application(s) for patent or Inventor's certificate, or 365(a) of any PCT International application which designated at least one country other than the United States, listed below and have also identified below, by checking the box, any foreign application for patent or Inventor's certificate, or PCT International application having a filing date before that of the application on which priority is claimed.

Prior Foreign Application(s)

| D | | | and March 1 | Certified Cop | y Attached ? |
|------------------------------|--------------------|-----------------------------------|-----------------------------|---------------|--------------|
| | | P | riority Not Claimed | Yes | No |
| (Number) | (Country) | (Foreign Filing Date) | 四 | | |
| (Number) | (Country) | (Day/Month/Year Filed) | | D | |
| Additional foreign applicati | on numbers are lie | ted on a supplementation interior | and the state of the second | | |

Additional foreign application numbers are listed on a supplemental priority data sheet PTO/SB/02B attached.

I hereby claim the benefit under 35 U.S.C. 119(e) of the United States provisional application(s) listed below.

(Application Number) (Filing Date)

(Application Number)

(Filing Date)

Additional provisional application numbers are listed on supplemental priority data sheet PTO/SB/02B attached hereto.

[Page 1 of 3]

I hereby claim the benefit under 35 U.S.C. §120 of any United States application(s), or §365(c) of any PCT International application designating the United States, listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States or PCT International application in the manner provided by the first paragraph of 35 U.S.C. 112, I acknowledge the duty to disclose information which is material to patentability as defined in 37 C.F.R. 1.56 which became available between the filing date of the prior application and the national or PCT International filing date of this application.

| 08/944.322 | October 6, 1997 | pend | ng |
|---|------------------------------------|---|---|
| U.S. Parent Application or PCT Parent Number | Parent Filing Date | Pare | ent Patent Number (<i>if applicable</i>) |
| U.S. Parent Application or PCT Parent Number | Parent Filing Date | Par | ent Patent Number (if applicable) |
| □ Additional U.S. or PCT Internation attached. | onal application numbers are list | ted on a supplemental pric | ority data sheet PTO/SB/02B |
| As named inventor, I hereby appoin | t the following practitioner(s) to | prosecute this application | and to transact all business in the |
| Patent and Trademark Office connect | cted therewith: Registered P | ractitioner(s) name/regist | ration number listed below |
| | Registration N | | |
| Gary D. Fields | 19, 604 | | |
| D | | | |
| Brent P. Johnson | 38,031 | | |
| Direct all correspondence to: | 1700 Lincoln Street, Suite 3030 | , Denver, CO 80203 | |
| (| Country: U.S.A. Telep | hone: (303) 861-9100 | Fax: (303) 861-9111 |
| I hereby declare that all statements m belief are believed to be true; and fur like so made are punishable by fine o jeopardize the validity of the applicat | in imprisonment, or both under | made with the knowledge | 41 |
| Name of Sole or First Inventor | | | |
| Given Name (first and middle [if any |] Edwin L. Fan | a petition has been filed for nily Name or Surname | or this unsigned inventor |
| 2 1 | | inty realize of Suffame | Adair |
| Inventor's signature | " Lalapi | Da | te 6.1 10 1998 |
| Residence 317 Parage | on Way | Citiz | enship <u>U.S.A.</u> |
| Post Office Address 317 Parage | Jn wav | | |
| City, State, Zip, Country Castle Pine | es Village. CO 80104 | | |
| Full name of second joint inventor, if | any (given name, family name) | Jeffrey L. Adair | |
| Second Inventor's signature | Add Di | Dat | e |
| Post Office Address 1861 East 1 | | | enship U.S.A. |
| City, State, Zip, Country Highlands | Ranch CO 20126 | ~~~~~ | |
| City, State, Zip, Country <u>Highlands</u> | Cediox Place | | |

Additional inventors are being named on separately numbered sheets attached hereto.

[Page 2 of 3]

DECLARATION FOR PATENT APPLICATION

Attorney Docket No. F97.13.CIP2

| Third Inventor's signat | inventor, if any (given name, family name) <u>Randa</u> | Date 10-20-98 |
|-------------------------|---|--------------------|
| Residence | 3082 South Flamingo Way | Citizenship U.S.A. |
| Post Office Address | 3082 South Flamingo Way | |
| | Denver, CO 80222 | |

[Page 3 of 3]

EXPRESS MAIL NO. EL146014919US

Applicant or Patentee: Edwin L. Adair, Jeffrey L. Adair, Randall S. Adair Attorney's Serial No. or Patent No.: Docket No.: F97.13CIP2 Filed or Issued:

For: "Reduced Area Imaging Devices"

VERIFIED STATEMENT (DECLARATION) CLAIMING SMALL ENTITY STATUS (37 CFR 1.9(f) AND 1.27(b)) - INDEPENDENT INVENTOR

As a below named inventor, I hereby declare that I qualify as an independent inventor as defined in 37 CFR 1.9(c) for purposes of paying reduced fees under Section 41(a) and (b) of Title 35, United States Code, to the Patent and Trademark Office with regard to the invention entitled "Reduced Area Imaging Devices"

described in:

[x] the specification filed herewith.

[] application serial no. _____, filed _____. [] patent no. _____, issued _____.

have not assigned, granted, conveyed or licensed and am under no obligation under contract or law to assign, grant, convey or license, any rights in the invention to any person who could not be classified as an independent inventor under 37 CFR 1.9(c) if that person had made the invention, or to any concern which would not qualify as a small business concern under 37 CFR 1.9(d) or a nonprofit organization under 37 CFR 1.9(e). 0Ĵ

Each person, concern or organization to which I have assigned, granted, conveyed, or licensed or am under an obligation under contract or law to assign, grant, convey or license any rights in the invention is listed below:

[x] no such person, concern or organization.

1

I acknowledge the duty to file, in this application or patent, notification of any change in status resulting in loss of entitlement to small entity status prior to paying, or at the time of paying, the

earliest of the issue fee or any maintenance fee due after the date on which status as a small entity is no longer appropriate (37 CFR 1.28(b)).

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the Unites States Code, and that such willful false statements may jeopardize the validity of the application, any patent issuing thereon, or any patent to which this verified statement is directed.

| Edwin L. Adair | Jeffrey L. Adair | Randall S. Adair |
|----------------|-------------------|-------------------|
| | NAME OF INVENTOR: | NAME OF INVENTOR: |
| | | |

Edwin L hdan Signature of Inventor

film 1 Aut

Kander S. e.d.

Signature of Inventor:

Samsung Exhibit 1003 Page 41 of 208



Samsung Exhibit 1003 Page 42 of 208



Samsung Exhibit 1003 Page 43 of 208



Samsung Exhibit 1003 Page 44 of 208







Page 47 of 208



Samsung Exhibit 1003 Page 48 of 208



Page 49 of 208

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9/11 Fig. 5c



Samsung Exhibit 1003 Page 50 of 208

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Samsung Exhibit 1003 Page 51 of 208



Samsung Exhibit 1003 Page 52 of 208



⁹Samsung Exhibit 1003 Page 53 of 208



APPREVED O.G. FIG. SV CLASS SUBCLASS URAFTSMAN

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Samsung Exhibit 1003 Page 55 of 208



Samsung Exhibit 1003 Page 56 of 208



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Samsung Exhibit 1003 Page 57 of 208



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Samsung Exhibit 1003 Page 58 of 208

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Samsung Exhibit 1003 Page 59 of 208

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Samsung Exhibit 1003 Page 60 of 208

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9/11 Fig. 5c



Page 61 of 208



Samsung Exhibit 1003 Page 62 of 208



Samsung Exhibit 1003 Page 63 of 208

| Under the Paper | +) inside this box \rightarrow $+$ | Approved for us Patent and Trademark Office as are required to respond to a col | PTO/SB/21 (6-98) e through 09/30/2000. OMB 0651-0031 E U.S. DEPARTMENT OF COMMERCE lection of information unless it displays a |
|--|--|---|---|
| FE C TRAN | SMITTAL ORM respondence after initial filing) | Application Number Filing Date First Named Inventor Group Art Unit | 09/175,685 10/20/98 Edwin L. Adair, et al. |
| Ca TRADEW BY | | Examiner Name Attorney Docket Numbe | FEB 2 5 1999 |
| Total Number of Pag | es in This Submission 283 | Allothey Docket Humbe | Group 1700 |
| Extension of Tir Express Abando X Information Disc Certified Copy of Document(s) Response to M Incomplete App Respons Parts un | Form (for an) hed Drawing esponse Licensi al Licensi al Petition and Ac Addres change | ment Papers Application) | After Allowance Communication to Group Appeal Communication to Board of Appeals and Interferences Appeal Communication to Group (Appeel Notice, Brief, Reply Brief) Proprietary Information Status Letter Additional Enclosure(s) (please identify below): Copies of references cited Return postcard |
| 1.52 or 1 | | ICANT, ATTORNEY, OR | AGENT |
| | Frent P. Johnson Fields & Johnson, P. | с. | |
| Date 2 | /16/99 | | |
| | CERTIFIC | ATE OF MAILING | |
| I hereby certify that this envelope addressed to | | sited with the United States F | Postal Service as first class mail in an 31 on this date: 2/16/99 |
| Typed or printed name | Brent P. Johnson | | |
| Signature | -BAtakin | _ Date | 2/16/99 |
| Burden Hour Statement: Th | | | |

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In Re the Application of

Edwin L. Adair, Jeffrey L. Adair,) Randall S. Adair)

Serial No.: 09/175,685

Filed: October 20, 1998

For: "Reduced Area Imaging Devices"

Assistant Commissioner for Patents Washington, D.C. 20231

SUBMISSION OF INFORMATION DISCLOSURE CITATION

nercey certily that this correspondence is being sposited with the United States Postal Service as irst class mail in an envelope addressed to: Assistant Commesioner for Patents, Washington, 196 16 D.C. 20231.0 14 ne of apploant, apploade, or Registered Pop.

Sir:

FEB 2 5 1999

INCLEIVED

Enclosed for the Examiner's consideration is an Information 700 Disclosure Citation In An Application along with copies of each of the references cited. These references include all the references cited by the applicant or by the Patent Office in co-pending applications Serial Nos. 08/944,322 and 08/976,976. This Information Disclosure Citation also includes two additional references which were cited in the International Search Report of a related PCT application, International Application No. PCT/US98/19379.

Respectfully submitted,

FIELDS & JOHNSON, P.C.

Gary D. Fields Brent P. Johnson Attorneys For Applicant 8480 East Orchard Road, Suite 5600 Englewood, CO 80111 (303) 689-9100

Date: ________

EXPRESS MAIL NO. EL146014919US



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In Re the Continuation-in-Part Application of

Edwin L. Adair, Jeffrey L. Adair, Randall S. Adair

Corresponding to U.S. Serial No.: 08/944,322 Filed: October 6, 1997) <u>PETITION TO MAKE</u>) <u>SPECIAL UNDER</u>) <u>37 C.F.R. §1.102</u>

For: "Reduced Area Imaging Devices")

Assistant Commissioner for Patents Washington, D.C. 20231

PETITION TO MAKE SPECIAL

Dear Sir\Madam:

One of the Applicant hereby petitions to make the above-identified application special under 37 C.F.R. §1.102(c). According to this rule, this petition may be filed without a fee because the basis for this petition is the Applicant's age.

Samsung Exhibit 1003 Page 66 of 208 Attached with this Petition is Applicant's Declaration indicating that Applicant is 65 years of age, or older.

Respectfully submitted,

FIELDS & JOHNSON, P.C.

Gary D. Fields Brent P. Johnson Attorneys for Applicant 8480 East Orchard Road, Suite 5600 Englewood, CO 80111 (303) 689-9100

Date: 10/20/98

EXPRESS MAIL NO. EL146014919US

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In Re the Continuation in Part Application of) <u>DECLARATION UNDER</u>) 37 C.F.R.<u>§ 1.102</u>

Edwin L. Adair, Jeffrey L. Adair, Randall S. Adair

Corresponding to U.S. Serial No. 08/944,322 Filed: October 6, 1997

For: "Reduced Area Imaging Devices")

Assistant Commissioner for Patents Washington, D.C. 20231

DECLARATION OF EDWIN L. ADAIR

I, Edwin L. Adair, hereby declare that, as of the filing date of the above-identified application, I am 65 years of age or older.

I further declare under penalty of perjury pursuant to the laws of the United States of America that the foregoing is true and correct, and that this Declaration was executed by me on $\frac{10}{20}$, 1998.

Respectfully submitted,

Edam Ladan

Edwin L. Adair

Samsung Exhibit 1003 Page 68 of 208



UNITED ST4 ; DEPARTMENT OF COMMERCE Patent and T ... emark Office ASSISTANT SECRETARY AND COMMISSIONER OF PATENTS AND TRADEMARKS Washington, D.C. 20231

Paper No. 31

Mailed

APR 9 1999

Director's Office Group 2700

Fields & Johnson, P.C. 1700 Lincoln Street, Suite 3030 Denver, CO 80203

In re application of Edwin L. Adair, et al. Application No.: 09/175,685 Filed: October 20, 1998 For: REDUCED AREA IMAGING DEVICES

DECISION ON PETITION

This is a decision on the petition under 37 C.F.R. § 1.102, filed October 20, 1998, to make the above-identified application special.

Petitioner requests that the above-identified application be made special under the accelerated examination procedure set forth in M.P.E.P. § 708.02, Section IV: Applicant's Age.

A grantable petition to make special under 37 C.F.R. § 1.102 and in accordance with M.P.E.P. § 708.02, Section IV must include a showing, as by a birth certificate or the applicant's statement that the applicant is sixty five (65) years of age or more. No fee is required for this petition.

The petition includes a declaration showing that the applicant, Edwin L. Adair, is over sixty five (65) years of age.

Accordingly, the petition is **GRANTED.**

The application is being forwarded to the examiner for expedited prosecution.

If the examiner can make this application special without prejudice to any possible interfering applications, and he or she should make a rigid search for such, he or she is authorized to do so for the next action. Should the application be rejected, the application will not be

| MAR 1 1 1999 Piece type a plus sign (+) inside this box — Under the Paperwork Reduction Act or valid OMB control number. TRANSMITT FORM (to be used for all correspondence after | AL | Approved for us Patent and Trademark Office is are required to respond to a col Application Number Filing Date First Named Inventor Group Art Unit Examiner Name | RECEIVED 27/13,415 HAR 2 4 1999 PTOGET N(6-98) INAR 2 4 1999 PTOGET N(6-98) INAR 2 4 1999 PTOGET N(6-98) INAR 2 4 1999 INAR 2 4 |
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| Signature Signature | Johnson | C.C. | AGENT |
| Date 3/8/99 | <u>j prov</u> | | |
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Page 70 of 208

| EE TRANSMITTAL for FY 1999 Patent lees are subject to annual revision. | | | Complete if Known | | | | | | |
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| | | | Application Number 09/ | | | /175.685 | | | |
| | | | Filing Date | | 10/ | 10/20/98 ECEIVER | | | |
| | | | First Named Inventor | | | Edwin L. Adair 4109 | | | |
| Small Entity payments <u>must</u> be supported by a small entity state otherwise large entity fees must be paid. See Forms PTO/SB/0 | | | | | | | | | |
| TOTAL AMOUNT OF PAYMENT (\$) 159.00 | | | Group / Art Unit 2713 Attorney Docket No. F97, 13 CIP2 | | | | 270 | | |
| TOTAL AMOUNT OF PATMENT (5) 159.00 | | Attor | ney Doo | cket No. | F97 | .13 CIP2 | | | |
| METHOD OF PAYMENT (check one) | - | | | | CALCULA | ATION (continu | | | |
| 1. The Commissioner is hereby authorized to charge indicated fees and credit any over payments to: | Large | Entity Fee | Small E | Fee | | Description | F | | |
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| 2. EXTRA CLAIM FEES Fee from | 1.1.2 | 2.252.772 | 242 605 | | y issue fee (d | or reissue) | _ | | |
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| "or number previously paid, if greater; For Reissues, see below Large Entity Small Entity | 126 | 240 1 | 26 240 | | | ormation Disclosure | | | |
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| 109 78 209 39 "Reissue Independent claims over original patent | Other fee | Innat | 6.0 | SAGIN | tion (or off | 1.129(0)) | - | | |
| 110 18 210 9 ** Reissue claims in excess of 20 | | | | - | | | | | |
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| SUBMITTED BY | | - | - | - | | | | | |
| Typed or Printed Name Brent P. Johnson | | | | | - | Complete (i | 38,031 | | |
| Printed Name | | | | | | Reg. Number | | | |

Burden Hour Statement: This form is estimated to take 0.2 hours to complete. Time will vary depending upon the needs of the individual case. Any comments on the amount of time you are required to complete this form should be sent to the Chief Information Officer, Patent and Trademark Office, Washington, DC 20231. DO NOT SEND FEES OR COMPLETED FORMS TO THIS ADDRESS. SEND TO: Assistant Commissioner for Patents.



Assistant Commissioner for Patents Washington, D.C. 20231

Sir:

Please amend the above-identified application as follows:

IN THE CLAIMS:

Add the following new claims:

8. A reduced area imaging device, as claimed in claim 1,



wherein said image sensor further includes:

81.00 DP

78.00 OP

an array of passive CMOS pixels, wherein individual passive CMOS pixels of said array of passive CMOS pixels each includes a photo

diode for producing photoelectrically generated signals; and

an access transistor communicating with said photo diode to control the release of said photoelectrically generated signals.

9. A reduced area imaging device, as claimed in claim 6, wherein said array of pixels includes:

a plurality of passive CMOS pixels, and wherein individual passive CMOS pixels of said plurality of passive CMOS pixels each

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5 includes a photo diode for producing photoelectrically generated signals; and

an access transistor communicating with said photo diode to control the release of said photoelectrically generated signals.

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10. A reduced area imaging device, as claimed in claim 6,

wherein:

individual pixels within said array of pixels each includes an amplifier.

A reduced area imaging device comprising: an array of CMOS pixels defining a profile area and lying in a first plane, said array of CMOS pixels for receiving images thereon;

a circuit board longitudinally aligned with and electrically
couples to said array of CMOS pixels, said circuit board lying in a second plane which is offset from said first plane and substantially parallel to said first plane, said circuit board including circuitry means for timing and control of said array of CMOS pixels, said timing and control means producing a pre-video signal, said circuit board further including circuitry
means for receiving said pre-video signal from said timing and control means and converting said pre-video signal to a post-video output signal for reception by a video device; and

a power supply electrically coupled to said array of said CMOS pixels and said circuit board.

10. 12. A reduced area imaging device, as claimed in claim 11 wherein:

> Samsung Exhibit 1003 Page 73 of 208

said array of CMOS pixels includes an array of passive CMOS pixels.

11. 13. A reduced area imaging device, as claimed in claim N. further including:

a supplementary circuit board communicating with said array
of CMOS pixels and said circuit board for enhancing said pre-video signal,
said supplementary circuit board being longitudinally aligned with said
array of CMOS pixels and said circuit board, and being positioned so as not
to extend substantially beyond said profile area.

5 14. An endoscope with integral imaging capability comprising: a tubular portion including a distal end, a proximal end and a central passageway extending therethrough;

means for providing light to said distal end to illuminate a te:

5 surgical site;

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a CMOS image sensor lying in a first plane and positioned at said distal end of said tubular portion for receiving images of the surgical site, said CMOS image sensor defining a profile area, and said CMOS image sensor producing an image signal;

circuitry means electrically coupled to said CMOS image sensor for timing and control of said CMOS image sensor, said circuitry means for timing and control placed within said tubular portion;

a video processor board lying in a second plane spaced from and longitudinally aligned with said CMOS image sensor within said tubular portion and adjacent said distal end thereof, said video processor board including circuitry means for processing said image signal and

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converting said image signal to a post-video signal, said video processor board being positioned so as not to extend substantially beyond said profile area, said video processor board communicating with said CMOS image sensor to receive said image signal; and

a power supply electrically coupled to said CMOS image sensor and said video processor board.

> 13. 15. An endoscope, as claimed in claim 14, wherein:

said CMOS image sensor includes an array of CMOS pixels, and wherein individual CMOS pixels within said array of CMOS pixels each includes an amplifier.

16. An endoscope, as claimed in claim 14, wherein:
 said CMOS image sensor includes a plurality of passive
 CMOS pixels.

An endoscope, as claimed in claim 14, wherein:
 said CMOS image sensor includes a plurality of passive
 CMOS pixels, and wherein individual passive CMOS pixels of said
 plurality of passive CMOS pixels each includes a photo diode for

5 producing photoelectrically generated signals, and an access transistor communicating with said photo diode to control the release of said photoelectrically generated signals.

18. An endoscope, as claimed in claim 14, wherein: said circuitry means for timing and control is placed on said first plane adjacent said CMOS image sensor.

17. 19. An endoscope, as claimed in claim 14, wherein: said circuitry means for timing and control is placed on said

second plane adjacent said circuitry means for processing and converting.

الكر 20, An endoscope, as claimed in claim 14, further including: a handle connected to said proximal end of said tubular portion for grasping by surgeon.

An endoscope, as claimed in claim 12, further including:
 a lens positioned at said distal end of said tubular portion and
 distally of said CMOS image sensor for producing a modified image on
 said CMOS image sensor.

22. An endoscope, as claimed in claim 14, wherein:
said power supply is a battery attached to said handle.

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An endoscope, as claimed in claim 14, wherein:

said second plane is offset from and substantially parallel to said first plane.

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An endoscope comprising:

a tubular portion including a central passageway extending therethrough, a proximal end and a distal end;

a CMOS imáge sensor positioned at said distal end of said
 tubular portion for receiving images of a surgical site, said CMOS imager
 defined by an array of CMOS pixels wherein individual pixels within said

array of said CMOS pixels each include an amplifier, said CMOS imager lying in a first plane;

circuitry means for timing and control of said CMOS image sensor placed adjacent to said CMOS image sensor on said first plane; a control box remote from said tubular portion and coupled to said CMOS image sensor, said control box including circuitry means for receiving a pre-video signal from said CMOS image sensor, and for converting said pre-video signal to a post-video signal which may be

a power supply coupled to said control box and said CMOS image sensor for providing power thereto.

received by a standard video device; and

23, 23, 23, 23, 25, An endoscope, as claimed in claim 24, wherein: said power supply is located in said control box.

24, 22.
26. An endoscope, as claimed in claim 24, further including: a handle connected to said proximal end of said tubular portion for grasping by a surgeon.

 25
 27
 An endoscope, as claimed in claim 24, further including: a supplementary circuit board for digitally enhancing said pre-video signal, said supplementary circuit board electrically coupled to

said circuitry means for receiving and converting.

Sut Db An endoscope, as claimed in claim 24, further including: 28.

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27, 22, 29, An endoscope, as claimed in claim 24, wherein: said power supply is a battery attached to said handle.

REMARKS

The foregoing Claims 8-29 have been added. It is respectfully requested that these added claims be examined in conjunction with the original Claims 1-7. Enclosed herewith is a check for \$141.00 for the fees for the additional claims. Any shortfall may be charged to Deposit Account No. 06-0778.

Respectfully submitted,

FIELDS & JOHNSON, P.C.

Gary D. Fields Brent P. Johnson 8480 East Orchard Road, Suite 5600 Englewood, CO 80111 (303) 689-9100

Date:___3/8/99

P. 02 FAX NO. 3036699250 MAR-24-99 WED 02:38 PM FIELDS & JOHNSON, P.C. Fax Received MAR 2 5 1999 Group 2700 IN THE UNITED STATES PATENT AND TRADEMARK OFFICE SUPPLEMENTARY In Re the Application of PRELIMINARY AMENDMENT Edwin L. Adair, et al. Examiner: A. Rao Serial No.: 09/175,685 Art Unit: 2713 Filed: 10/20/98 CERTIFICATE OF FACSIMILE TRANSMISSION I hareby certify that this paper for reg./cer. no. "Reduced Area Imaging For: 09/175,685 to being facsimile transmitted to the Devices" 5399 Patent and Trademark Office fax num on the date shown below irginia AIN AT ZHE Assistant Commissioner for Patents Washington, D.C. 20231 3/24/99

Sir/Madam:

Please further amend the above-identified application as follows:

IN THE CLAIMS

Add the following new claims:

SUBER 30. Are

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0. A reduced area imaging device comprising:

an array of CMOS pixels defining a profile area and lying in a first plane, said array of said CMOS pixels for receiving images thereon; a circuit board longitudinally aligned with and electrically

coupled to said array of CMQS pixels, said circuit board lying in a second plane which is offset from said first plane and substantially parallel to said first plane, said circuit board including timing and control means for controlling the release of information from said array of CMOS pixels, said timing and control means producing a pre-video signal; 10

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a control box remote from said array of said CMOS pixels and said circuit board, said control box including circuitry means for receiving said pre-video signal, and for converting said pre-video signal to a post-video signal which may be received by a standard video device; and a power supply coupled to said control box, said array of

2

15 CMOS pixels and said timing and control means for providing power thereto.

29. 31. A reduced area imaging device, as claimed in claim 30, wherein said array of CMOS pixels further includes:

an array of passive CMOS pixels, wherein individual passive CMOS pixels of said array of passive CMOS pixels each includes a photo diode for producing photoelectrically generated signals; and

an access transistor communicating with said photo diode to control the release of said photoelectrically generated signals.

30, 32. A reduced area imaging device, as claimed in claim 30, wherein said array of CMOS pixels further includes:

an array of active CMOS pixels, wherein individual active CMOS pixels within said array of active CMOS pixels each includes an amplifier.

REMARKS

The foregoing Claims 30 through 32 have been added. It is respectfully that these added claims be examined in conjunction with original Claims 1-7, and Claims 8-29 added in the first Preliminary Amendment. Enclosed herewith is a check for \$57.00 to cover the fees for these additional claims. Any shortfall may be charged to Deposit Account No. 06-0778.

Respectfully submitted,

FIELDS & JOHNSON, P.C.

Gary D. Fields Brent P. Johnson Attorneys for Applicant 8480 East Orchard Avenue, Suite 5600 Englewood, CO 80111 (303) 689-9100

Date: 3/24/99

Samsung Exhibit 1003 Page 81 of 208

| IN THE UNITED STATES PA | GP 2713 |
|--|---|
| | SUBMISSION OF DECLARATIONS ROSE |
| In Re the Application of) | SUBMISSION OF DECLARATIONS UNDER 37 C.F.R. §1.132 |
| Edwin L. Adair, Jeffrey L. Adair,) | |
| Randall S. Adair) | Examiner: A. Rao |
|) Serial No.: 09/175,685) | Art Unit: 2713 |
| Filed: October 20, 1998) | I hereby carely that this correspondence is Gaing N deposited with the United States Postal Service as first class mail in an envelope addressed to D |
| For: "Reduced Area Imaging) Devices" | D.C. 20231, on7 |
| Assistant Commissioner for Patents Washington, D.C. 20231 | Katherine L Americalula Morris of apploant, assigned, or Registered Rep. |

Dear Sir:

Enclosed are two Declarations Under 37 C.F.R. §1.132. It is respectfully requested that the Examiner consider these Declarations in conjunction with the examination of the above-identified application.

Respectfully submitted,

FIELDS & JOHNSON, P.C.

Gary D. Fields Brent P. Johnson 8480 East Orchard Road, Suite 5600 Englewood, CO 80111 (303) 689-9100

Date: 4/1/99

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

)

)

In Re the Application of

Edwin L. Adair, Jeffrey L. Adair,) Randall S. Adair)

Serial No.: 09/175,685

Filed: October 20, 1998

For: "Reduced Area Imaging Devices"

Assistant Commissioner for Patents Washington, D.C. 20231

DECLARATION UNDER 37 C.F.R. §1.132

Examiner: A. Rao

Art Unit: 2713



I, Jeffrey L. Adair, declare as follows:

1. I am Chief Engineer of Medical Dynamics, Inc. I am responsible for the design and manufacture of medical camera systems and peripheral components such as light sources, insuflators, etc. I am also responsible for overseeing the transition from prototype development to full production of said camera systems and peripherals. I am also responsible for assisting in prototype development which includes being present during medical procedures conducted in a hospital when our devices are being tested by a surgeon.

2. I received an Associate of Applied Sciences degree in Electrical Engineering from Denver Technical University in 1985.

3. I have held the position of Chief Engineer at Medical Dynamics, Inc. since 1987. During that time, I have headed up design teams which have produced more the 45 different types of surgical cameras including 17 models of electronic video laparoscopes in which CCD devices were placed at the distal ends of such laparoscopes. All of these devices have been commercially successful for Medical Dynamics, Inc.

 As a result in my experience in designing electronic endoscopes, I have extensively studied and researched CCD technology and I am very familiar with all aspects of CCD cameras.

5. I have closely followed the emergence of new CMOS imagers and I have tested several CMOS imagers from various manufacturers over the past two years. Medical Dynamics, Inc. has documented several well-known advantages which CMOS imagers have over CCD image devices such as low power consumption, lower production/manufacture costs, and a high level of on-chip circuit integration in comparison to CCD imagers.

6. As a co-inventor, I have read and am familiar with the aboveidentified patent application, and the invention described and claimed therein. I have also read and am familiar with the new claims appearing in the Preliminary Amendment dated March 8, 1999 and the Supplemental Preliminary Amendment dated March 24, 1999.

7. Prior to my development of the above-identified invention, I was aware of no other person or entity who had developed an imaging device or endoscope which utilized a CMOS pixel array with timing control circuitry placed together on one plane or circuit board, and remaining processing circuitry either placed in a remote control box, or on other circuit boards placed closely adjacent the CMOS pixel array.

8. There has been great skepticism in the industry as to the capability to use CMOS technology in medical imaging applications. CMOS imagers have been characterized as not being capable of producing high quality images. Despite

this skepticism, we were able to locate companies developing CMOS technology that might be usable within an imaging device configured as described in Paragraph 7 above.

9. After extensive testing, we were able to develop an imaging device which produced an extremely high quality image, was of incredibly small size, yet maintained the well-known advantages of CMOS imagers.

10. During our testing of the devices claimed in this invention, we discovered an unknown, but very important advantage that our device has over CCD imagers. This advantage is the capability of our device to reject radio frequency interference (RFI) which is emitted by electrosurgical generators used during surgery. In many surgical procedures, an endoscope is used in order to view the surgical area while another device, such as an electrosurgical generator, is used to actually manipulate (*i.e.*, cut or cauterize) the tissue.

11. CCD devices cannot be used near an electrical surgical generator without requiring significant shielding for the CCD device. Such shielding requires intense grounding techniques for the CCD camera cables/conductors which trail the CCD imager, and also grounding for the actual CCD pixel array. These shielding techniques not only add significantly to the size of the CCD device, but also to the overall cost of the CCD camera system. Even when such shielding is incorporated, RFI levels are only brought to a reasonable level which may still result in an obstructed view of the surgical area.

12. After testing several types of CMOS configurations, we concluded that remoting the processing circuitry from the CMOS imager and timing and control circuits eliminated the need for shielding. In other words, we found that this configuration was not susceptible to RFI. Such an unexpected result allowed

us to consider even smaller diameter endoscopes which can be used directly with the electrosurgical generators. This remoting feature can be achieved by removing the processing circuitry from the same circuit board or plane as the pixel array and then placing the processing circuitry in either a remote box/unit or on another circuit board adjacent and spaced from the pixel array.

 This feature of remoting the processing circuitry is recited in all of the independent claims.

14. Even with standard CMOS devices which have processing circuitry on chip with the CMOS pixel array, at least some shielding is required to prevent RFI in order to optimize the image. Thus, our efforts in redesigning certain CMOS technologies still produced the unexpected result of RFI rejection.

15. Independent Claims 1, 6, and 24 claim this particular feature of the invention wherein processing circuitry is remoted from a co-planar pixel array and timing and control circuitry.

16. In addition to the configuration in which the pixel array and the timing and control circuit is placed on a single plane, we also observed the same advantageous results with respect to RFI rejection when we placed the CMOS pixel array by itself on one plane, and connected the timing and control circuitry to the pixel array on a second plane spaced from the pixel array. In this configuration, the processing circuitry was also remoted in either a remote control box or on circuit boards separated from, but adjacent to the pixel array. This particular feature is specifically claimed in Claim 30.

17. I have also read and understand the following prior art references which are cited in this application:

A. "Imaging Options Expand With CMOS Technology", Laser Focus World, June 1997;

B. "NASA"s Tiny Camera Has a Wide-Angle Future", Business Week, March 6, 1995;

C. U.S. Patent No. 5, 754,313 to Pelchy, et al.; and

D. U.S. Patent No. 5,471,515 to Fossum, et al.

18. In my review of Pelchy, et al., I see no applicability of this patent disclosure with regard to the imaging device claimed in this invention. Pelchy is directed to an improvement wherein tape automated bonding (TAB) is used to connect timing and control circuitry for a CCD imager.

Pelchy, et al., column 1, lines 7-11, states: "The increased 19. availability of smaller solid state imagers based on CCD or CMOS technologies has surpassed the ability of conventional wire bonding techniques to take full advantage of the space savings afforded by these small imagers." This general statement may be true; however, I find no discussion or disclosure within this reference as to how TAB is advantageous for the imaging device and endoscopes claimed in our application. When timing and control circuitry is placed co-planar with the CMOS pixel array as claimed Claims 1, 6 and 24, the TAB shown in Pelchy is absolutely not needed. As disclosed in the description of my invention, there are only three imager leads which are required to interconnect the processing circuitry to the pixel array and timing and control circuits. These leads exit from the plane of the CMOS pixel array through the back side and well within the edges of the CMOS pixel array. Pelchy, on the other hand, requires that the leads be connected at the edge or periphery of the imaging plane which results in the imaging device having a larger profile. Additionally, because the leads are

exposed in this manner, they require reinforcement in the form of protective strips which are shown in Pelchy as protective strips 31. Because of the type of TAB being disclosed in Pelchy, I believe that this reference actually teaches away from any combination with attributes of a CMOS imager. Thus, the type of TAB disclosed in this reference has no advantage or applicability to any CMOS device I have ever known.

20. The other references mentioned above all discuss a CMOS-based imager or hybrid imager wherein all of the imaging elements or components are found on the same plane. In short, these other references describe what are becoming known as "cameras on a chip." I find no suggestions in these references that these types of imagers should be split up in various configurations to include processing circuitry remoted from a co-planar pixel array and timing and control circuits, or even that the timing and control circuits should be remoted from the pixel array. This would obviously detract from the "camera on a chip" concept if the circuitry were split up.

21. Based on the foregoing, I believe that the invention has satisfied a long felt need to provide an imaging device which is of a minimum profile, is readily compatible with the electrosurgical generators, and still provides the other well-known advantages of CMOS imagers over CCD imagers.

I declare that all statements made on information contained of my own knowledge are true, and that all statements made on information and belief are believed to be true, and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine

or imprisonment or both under Section 1001 of Title 18 of United States Code, and that such willful false statements may jeopardize the validity of this document.

Dated this 31 day of MARCH, 1999.

Jeffrey L. Adair



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

| In Re | the Application of |) |
|------------------------|-------------------------------|---|
| | |) |
| Edwir | h L. Adair, Jeffrey L. Adair, |) |
| Randall S. Adair | |) |
| | |) |
| Serial No.: 09/175,685 | |) |
| oona | |) |
| Filed: | October 20, 1998 |) |
| I nee. | |) |
| For: | "Reduced Area Imaging |) |
| T 011 | Devices" | |

DECLARATION UNDER 37 C.F.R. §1.132

Examiner: A. Rao

Art Unit: 2713

Assistant Commissioner for Patents Washington, D.C. 20231

I, Jack Baird, Ph.D., declare as follows:

 I received my Bachelor of Science (1958), a Master of Science (1959), and my Doctorate degree (1963) from the University of Illinois, Urbana, Illinois.

 From 1963-1967 I was a full Professor in the electrical engineering department at the University of Illinois.

 From 1967-1981, I was a full Professor and Associate Department Chairman of the electrical engineering department at the University of Colorado, Boulder, Colorado.

4. From 1981-1988, I was the President and Chief Engineer for LED Systems, Inc. As President and Chief Engineer, my technical responsibilities included research and development, design and testing of electronic equipment and systems. 5. From 1988-1998, I was President and Chief Engineer of Video Accessory Corporation. As President and Chief Engineer, my technical responsibilities also included research and development, design and testing of electronic equipment and systems.

 Since 1998, I have been retired, but continue with consulting work in the electrical engineering field.

7. I have read and I am familiar with the above-identified patent application and the invention described and claimed therein by the inventors. I have also read and am familiar with the new claims appearing in the Preliminary Amendment dated March 8, 1999 and the Supplemental Preliminary Amendment dated March 24, 1999.

 As a result of my experience, I am knowledgeable regarding existing imaging technology to include standard CCD, CMOS and emerging hybrid type imagers.

9. I have also read and understand the following prior art references which are made of record in this application:

A. "Imaging Options Expand With CMOS Technology", Laser Focus World, June 1997;

B. "NASA's Tiny Camera Has A Wide Angle Future", Business Week, March 6, 1995;

C. U.S. Patent No. 5,754,313 to Pelchy, et al.; and

D. U.S. Patent No. 5,471,515 to Fossum, et al.

10. Business Week's article is correct in explaining why standard CCD technology is impractical for making a reasonably small CCD imaging device with all imaging elements on a single plane.

11. Fossum, et al. appears to have overcome this problem with a new imaging technology which may be found on a relatively small chip, and which previously required multiple chips of much larger size.

12. I agree with the *Business Week* article and the Fossum, et al. patent which state that on-chip processing is impractical with standard CCD technology, particularly for imagers in the medical field which must be kept at a minimum size. In fact, the CCD process is so unique that it simply is not possible to put timing and control circuits co-planar with the pixel array.

13. Pelchy, et al. is directed to an imager which is made shorter in length as compared to the prior art. This reduced length requires tape automated bonding (TAB) to connect the image sensor to the timing and control circuitry. I believe that Pelchy is simply representative of standard CCD technology which requires timing and control circuitry to be closely situated, but remote from the pixel array in order to minimize size and interference. Because of the size of timing and control circuitry required for standard CCD imaging devices and interference problems, standard CCD imaging devices simply do not have such circuitry placed co-planar with the pixel array. Furthermore, processing circuitry is required to be remote from the distal tip of a CCD imaging device because such circuitry is so large and bulky.

14. Although Pelchy, et al. is silent as to the specific type of circuitry found on the circuit boards placed perpendicular to the pixel array, I believe that this circuitry can be no other than that of the timing and control circuitry of a standard CCD device. Pelchy, et al. illustrates a large number of transmission wires 33 which interconnect the circuit boards placed perpendicular to the pixel array with an external processor 13. Specifically, there are twelve conductors

which are shown to interconnect the external processor 13 to the circuit boards 27 and 28. It would be clearly undesirable for a CMOS imager to incorporate the configuration shown in Pelchy, et al. wherein there are a large number of transmission wires because CMOS imagers can transmit a pre-video signal to some external processor with only three conductors. This three conductor configuration greatly simplifies shielding efforts to prevent radio frequency interference (RFI). Thus, based upon the disclosure of Pelchy, et al., I find that Pelchy is clearly directed to a standard CCD imaging device and overcoming the problems with CCD devices.

15. Since the timing and control circuitry for CMOS imagers is so small in comparison to timing and control circuitry for CCD devices, timing and control circuitry can be placed co-planar with the CMOS pixel array without adding any significant size to the overall imager profile. Even if it is desired to remote the timing and control circuitry from the CMOS pixel array, the TAB process in Pelchy, et al. is inefficient and undesirable. Much fewer leads or transmission wires are needed in CMOS and such leads or transmission wires can be in the form of pins attached within the edges of the adjacent circuit boards. This feature of the applicant's invention is shown in Figure 2b. Pelchy requires bonding to the edges or periphery of the imager which adds size to the imager profile. The exposure of the transmission wires at the edges also requires additional support, which is shown in Pelchy as protective strips 31. No extra support is needed for the pins disclosed in Figure 2b

16. Therefore, it is my belief that the TAB process disclosed in this Pelchy, et al. reference is only applicable and advantageous with respect to

standard CCD imagers and actually teaches away from any use with CMOS technology.

17. Pelchy at column 1, lines 7-11 reads "The increased availability of smaller solid state imagers based on CCD or CMOS technologies has surpassed the ability of conventional wire bonding techniques to take full advantage of the space savings afforded by these small imagers." This general statement may be factually correct; however, the TAB process actually disclosed in this patent is not needed for CMOS and clearly detracts from the advantages of CMOS if such a TAB process were used. Therefore, this statement cannot be interpreted as meaning that the TAB process of Pelchy has any applicability to or lends itself for use with a CMOS imager of the type claimed in this application.

18. On the other hand, if a CMOS imager of the type disclosed in the *Business Week* article or the Fossum, et al. patent were substituted with the imager of Pelchy, this would defeat the need for TAB in the first place, because the timing and control circuitry of CMOS is so small that it does not materially affect the size of the imaging plane.

19. I find no indication or suggestion in any of the prior art references discussed above of providing a CMOS imager which has timing and control circuitry placed on the same plane while other remaining circuitry is either remoted in a control box or placed on other circuit boards adjacent and spaced from the co-planar CMOS imager and timing and control circuitry.

20. My comments above specifically apply to independent Claims 1, 6 and 24 which claim co-planar imaging and timing and control elements.

21. I understand that the invention according to Claims 1, 6 and 24 does not require any type of shielding in order to avoid RFI effects. I believe that this is

an unexpected and advantageous result which is not generally known in my field of expertise. Typically, great efforts are required to protect a device from RFI, particularly for CCD devices, and at least some shielding is required for CMOS devices.

22. In addition to the claimed configuration in which the pixel array and timing and control circuitry is placed on a single plane, it is my understanding that advantageous results with respect to RFI rejection were achieved when the pixel array was placed by itself on one plane or structure, and timing and control circuitry was connected to the pixel array from a second plane spaced from the pixel array. This particular feature is specifically claimed in claim 30. I also believe that this is an unexpected and advantageous result which is not generally known in my field of expertise.

23. I also believe that the claimed invention responds to a long felt need in the industry to provide any type of imaging device which is of a minimum size, and can produce an image which is of high quality.

I declare that all statements made on information contained of my own knowledge are true, and that all statements made on information and belief are believed to be true, and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment or both under Section 1001 of Title 18 of United States Code, and that such willful false statements may jeopardize the validity of this document.

Dated this 31 day of March, 1999.

Jack Baird, Ph.D.

Samsung Exhibit 1003 Page 95 of 208



Assistant Commissioner for Patents Washington, D.C. 20231

Sir:

Enclosed is a Supplemental Information Disclosure Citation. This Citation is being submitted in accordance with 37 C.F.R. §1.97(b)(3). It is respectfully requested that the Examiner consider this additional reference in the examination of this application.

Respectfully submitted,

FIELDS & JOHNSON, P.C.

Gary D. Fields U Brent P. Johnson Attorneys For Applicant 8480 East Orchard Road, Suite 5600 Englewood, CO 80111 (303) 689-9100

Date: _ 4/22/99



UNITED STATES JEPARTMENT OF COMMERCE Patent and Trademark Office

Address: COMMISSIONER OF PATENTS AND TRADEMARKS Washington, D.C. 20231

| APPLICATION NO. | FILING DATE | FIRST NAMED INVENTOR | | 1 | ATTORNEY DOCKET NO. | | |
|--|-------------|----------------------|---|-----------------------|---------------------|--|--|
| 097175,685 | 10/20/98 | ADAIR | | E F | F97.13-CIP2 | | |
| BRENT P JOHN | | LM61/0306 | ٦ | RAD, A | EXAMINER | | |
| FIELDS & JOH SUITE 5600 8480 EAST OF | | | | ART UNIT | PAPER NUMBER | | |
| ENGLEWOOD CO | 80111 | | | DATE MAILED: 08/06/99 | | | |

Please find below and/or attached an Office communication concerning this application or proceeding.

Commissioner of Patents and Trademarks

| | Application No. 09/175,685 | Applicar | Applicar Adair et al. | | |
|---|--|--------------------------------------|--------------------------|----------------|--|
| Office Action Summary | | | Group Art Unit 2713 | | |
| Responsive to communication(s) filed on | | | | | |
| This action is FINAL. | | | | | |
| Since this application is in condition for allowance e in accordance with the practice under Ex parte Qua | | | | rits is closed | |
| A shortened statutory period for response to this action is longer, from the mailing date of this communication. application to become abandoned. (35 U.S.C. § 133). 37 CFR 1.136(a). | Failure to respond with | nin the peri | od for response | will cause the | |
| Disposition of Claims | | | | | |
| X Claim(s) <u>1-32</u> | | is/are | e pending in the a | application. | |
| Of the above, claim(s) | | is/are | withdrawn from | consideration. | |
| Claim(s) | | | | | |
| X Claim(s) 1-27 and 29-32 | | | | | |
| X Claim(s) 28 | | | | 0. | |
| Claims | | | | | |
| The drawing(s) filed on is/a The proposed drawing correction, filed on The specification is objected to by the Examiner. The oath or declaration is objected to by the Examiner. The oath or declaration is objected to by the Examiner. Priority under 35 U.S.C. § 119 Acknowledgement is made of a claim for foreign All Some* None of the CERTIFIED of received. received. received in Application No. (Series Code/Second Code/Second | is ap niner, priority under 35 U.S.C copies of the priority doo trial Number) om the International Bu | pproved § 119(a)- cuments ha | (d). Ive been | | |
| "Certified copies not received: | | | | | |
| Acknowledgement is made of a claim for domestic Acknowledgement is claim for domestic Acknowledgement is made of a c | aper No(s). <u>2 and 8</u> | C.§119{e |). , | | |
| tent and Trademark Office | N ON THE FOLLOWING P. | 4 <i>GES</i> | | | |
| 326 (Rev. 9-95) Office / | Action Summary | | Part of P | apor No 9 | |

Part of Paper No. 9

Samsung Exhibit 1003 Page 98 of 208

Art Unit: 2713

DETAILED ACTION

Response to Amendment

As per the Applicant's instructions filed in Paper 5 on 3/11/99 and in Paper 6 on 3/25/99,
 claims 8-32 have been canceled.

Specification

2. The lengthy specification has not been checked to the extent necessary to determine the presence of all possible minor errors. Applicant's cooperation is requested in correcting any errors of which applicant may become aware in the specification.

Claim Objections

3. Claim 28 is objected to under 37 CFR 1.75(c), as being of improper dependent form for failing to further limit the subject matter of a previous claim. Applicant is required to cancel the claim(s), or amend the claim(s) to place the claim(s) in proper dependent form, or rewrite the claim(s) in independent form.

A). Claim 28, line 1, it is unclear what claim 28 "further includes"....

Correction is necessary.

Art Unit: 2713

Claim Rejections - 35 USC § 103

4. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

(a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.

5. Claims 1-3, and 6-10, 14-21, and 24-27 are rejected under 35 U.S.C. 103(a) as being unpatentable over Pelchy et al. (hereinafter referred to as "Pelchy") in view of the 6/97 Laser Focus article entitled "Imaging options expand with CMOS technology" (hereinafter referred to as "Laser Focus").

Pelchy discloses a reduced area imaging device (Pelchy: figure 4), comprising : an image sensor lying in a first plane and including an array of pixels for receiving images thereon, said image sensor producing a pre-video signal; (Pelchy: column 3, lines 45-50; column 1, lines 8-10), a pre-video conductor for transmitting said pre-video signal from said first circuit board to a second circuit board (Pelchy: column 4, lines 5-17); a first circuit board lying in second plane and longitudinally aligned with said image sensor, said first circuit board being connected to said pre-video conductor at said second end thereof, said first circuit board including circuitry means for converting said pre-video signal to a post-video signal for reception by a standard video device (Pelchy: column 3, lines 10-15 and 54-65); and a power supply device coupled with said image sensor for driving said array of pixels, and electrically coupled to said first circuit board for driving said circuit board (Pelchy: column 4, lines 17-25),

Art Unit: 2713

as specified in claim 1. However, Pelchy fails to disclose the that the image sensor further includes timing and control circuitry means on said first plane and coupled to said pixel array such as a CMOS imager (Pelchy: column 3, lines 45-50), even though the reference recognizes that the use of a TAB imager could be also apply CMOS based imager (Pelchy: column 1, lines 7-10). The <u>Laser Focus</u> article discloses that the use of a passive CMOS image sensor timing and control circuitry at each CMOS pixel (<u>Laser Focus</u>: third page, right most column, lines 32-60) is preferable to using a CCD because the standard CCD imagers as contained by the original Pelchy endoscope waste more power (<u>Laser Focus</u>: second page, leftmost column, lines 35-50). Accordingly, given the <u>Laser Focus</u> article's teaching of advantageously using a passive CMOS image sensor, it would have been obvious for one of ordinary skill in the art to modify the Pelchy apparatus by incorporating the <u>Laser Focus</u> article's disclosed passive CMOS imager for the standard Pelchy imager (Pelchy: figure 2, element 20) in order to minimize power consumption. The Pelchy apparatus, as modified with the inclusion of the <u>Laser Focus</u>'s passive CMOS imager which has timing and control circuitry at each pixel site, has all of the features of claim 1.

Regarding claim 2, the Pelchy apparatus, as modified with the inclusion of the <u>Laser</u> <u>Focus</u>'s passive CMOS imager which has timing and control circuitry at each pixel site, would have the image sensor defining a profile area (Pelchy: figure 2, element 21: defining profile area), and said first circuit board being positioned not to extend beyond said profile area (Pelchy: figure 2, element 28), as specified.

Samsung Exhibit 1003 Page 101 of 208 Art Unit: 2713

Regarding claim 3, the Pelchy apparatus, as modified with the inclusion of the <u>Laser</u> <u>Focus</u>'s passive CMOS imager which has timing and control circuitry at each pixel site, has a second circuit board electronically coupled with said first circuit board and said image sensor for enhancing said pre-video signal as specified, and second circuit board being longitudinally aligned with said first circuit board and said image sensor so as to not extend substantially beyond said profile area (Pelchy: figure 2, element 27), as specified.

Regarding claim 8, the Pelchy apparatus, as modified with the inclusion of the Laser Focus's passive CMOS imager which has timing and control circuitry at each pixel site, has an array of passive CMOS pixels which includes a photo diode and access transistor pair (Laser Focus: page 3, rightmost column, lines 28-38), as specified.

Pelchy discloses a reduced area imaging device (Pelchy: figure 4), comprising : an image sensor lying in a first plane and including an array of pixels for receiving images thereon, said image sensor producing a pre-video signal; (Pelchy: column 3, lines 45-50; column 1, lines 8-10), a pre-video conductor for transmitting said pre-video signal from said first circuit board to a second circuit board (Pelchy: column 4, lines 5-17); a control box remote from said image sensor, said control box including circuitry means for receiving said pre-video signal from the image sensor as specified (Pelchy: column 3, lines 10-15); and a power supply device coupled with said image sensor for driving said array of pixels, and electrically coupled to said first circuit board for driving said circuit board (Pelchy: column 4, lines 17-25), as specified in claim 6. However, Pelchy fails to disclose the that the image sensor further includes timing and control circuitry

Art Unit: 2713

means on said first plane and coupled to said pixel array such as a CMOS imager (Pelchy: column 3, lines 45-50), even though the reference recognizes that the use of a TAB imager could be also apply CMOS based imager (Pelchy: column 1, lines 7-10). The Laser Focus article discloses that the use of a passive CMOS image sensor timing and control circuitry at each CMOS pixel (Laser Focus: third page, right most column, lines 32-60) is preferable to using a CCD because the standard CCD imagers as contained by the original Pelchy endoscope waste more power (Laser Focus: second page, leftmost column, lines 35-50). Accordingly, given the Laser Focus article's teaching of advantageously using a passive CMOS image sensor, it would have been obvious for one of ordinary skill in the art to modify the Pelchy apparatus by incorporating the Laser Focus article's disclosed passive CMOS imager for the standard Pelchy imager (Pelchy: figure 2, element 20) in order to minimize power consumption. The Pelchy apparatus, as modified with the inclusion of the Laser Focus's passive CMOS imager which has timing and control circuitry at each pixel site, has all of the features of claim 6.

Regarding claim 7, the Pelchy apparatus, as modified with the inclusion of the Laser Focus's passive CMOS imager which has timing and control circuitry at each pixel site, has a supplementary circuit board electronically coupled with said first circuit board and said image sensor for enhancing said pre-video signal as specified (Pelchy: figure 2, element 27), as specified.

Regarding claim 9, the Pelchy apparatus, as modified with the inclusion of the <u>Laser</u> <u>Focus</u>'s passive CMOS imager which has timing and control circuitry at each pixel site, has an

Samsung Exhibit 1003 Page 103 of 208

Art Unit: 2713

array of passive CMOS pixels which includes a photo diode and access transistor pair (Laser Focus: page 3, rightmost column, lines 28-38), as specified.

Pelchy discloses a reduced area imaging device (Pelchy: figure 4), comprising : an image sensor lying in a first plane and including an array of pixels for receiving images thereon, said image sensor producing a pre-video signal; (Pelchy: column 3, lines 45-50; column 1, lines 8-10), a pre-video conductor for transmitting said pre-video signal from said first circuit board to a second circuit board (Pelchy: column 4, lines 5-17); a control box remote from said image sensor, said control box including circuitry means for receiving said pre-video signal from the image sensor as specified (Pelchy: column 3, lines 10-15); and a power supply device coupled with said image sensor for driving said array of pixels, and electrically coupled to said first circuit board for driving said circuit board (Pelchy: column 4, lines 17-25), as specified in claim 6. However, Pelchy fails to disclose the that the image sensor further includes timing and control circuitry means on said first plane and coupled to said pixel array such as a CMOS imager (Pelchy: column 3, lines 45-50), even though the reference recognizes that the use of a TAB imager could be also apply CMOS based imager (Pelchy: column 1, lines 7-10). The Laser Focus article discloses that the use of a active CMOS image sensor timing and control circuitry at each CMOS pixel (Laser Focus: second page, rightmost column, lines 4-8) is preferable to using a CCD because the standard CCD imagers as contained by the original Pelchy endoscope waste more power (Laser Focus: second page, leftmost column, lines 35-50). Accordingly, given the Laser Focus article's teaching of advantageously using a active CMOS image sensor, it would have been obvious for

Art Unit: 2713

one of ordinary skill in the art to modify the Pelchy apparatus by incorporating the <u>Laser Focus</u> article's disclosed active CMOS imager for the standard Pelchy imager (Pelchy: figure 2, element 20) in order to minimize power consumption. The Pelchy apparatus, as modified with the inclusion of the <u>Laser Focus</u>'s active CMOS imager which has timing and control circuitry at each pixel site, has all of the features of claim 6.

Regarding claim 10, the Pelchy apparatus, as modified with the inclusion of the Laser Focus's active CMOS imager which has timing and control circuitry at each pixel site, has an amplifier for each individual pixel (Laser Focus: page 2, rightmost column, lines 4-9), as in the claim.

Pelchy an endoscope with integral imaging capability (Pelchy: figure 4), comprising: a tubular portion including a distal end, a proximal end, and a central passageway extending therethrough (Pelchy: column 3, lines 25-30; column 4, lines 55-60); means for providing light to said distal end to illuminate a surgical site (Pelchy: column 5, lines 5-10); an image sensor lying in a first plane and positioned at said distal end of said tubular portion for receiving images of the surgical site thereon, said image sensor defining a profile area (Pelchy: figure 2, element 21: profile area established by the circumference of element 21), said image sensor producing a prevideo signal (Pelchy: column 3, lines 45-50; column 1, lines 8-10); a video processor board lying in a second plane spaced apart from and longitudinally aligned with said image sensor within said tubular portion and adjacent said distal end thereof, said video processor board including circuitry for processing said image signal as specified, said video processing board being positioned so as

Art Unit: 2713

not extend substantially beyond said profile area, as specified (Pelchy: column 3, lines 10-15 and 53-55); and a power supply device coupled with said image sensor for driving said array of pixels, and electrically coupled to said first circuit board for driving said circuit board (Pelchy: column 4, lines 17-25), as specified in claim 14. However, Pelchy fails to disclose the that the image sensor is a CMOS image and further includes timing and control circuitry means thereon, even though the reference recognizes that the use of a TAB imager could be also apply CMOS based imager (Pelchy: column 1, lines 7-10). The Laser Focus article discloses that the use of a active CMOS image sensor timing and control circuitry at each CMOS pixel (Laser Focus: second page, rightmost column, lines 4-8) is preferable to using a CCD because the standard CCD imagers as contained by the original Pelchy endoscope waste more power (Laser Focus: second page, leftmost column, lines 35-50). Accordingly, given the Laser Focus article's teaching of advantageously using a active CMOS image sensor, it would have been obvious for one of ordinary skill in the art to modify the Pelchy apparatus by incorporating the Laser Focus article's disclosed active CMOS imager for the standard Pelchy imager (Pelchy: figure 2, element 20) in order to minimize power consumption. The Pelchy apparatus, as modified with the inclusion of the Laser Focus's active CMOS imager which has timing and control circuitry at each pixel site, has all of the features of claim 14.

Regarding claim 15, the Pelchy apparatus, as modified with the inclusion of the Laser Focus's active CMOS imager which has timing and control circuitry at each pixel site, has an

amplifier for each individual pixel (Laser Focus: second page, rightmost column, lines 4-9), as in the claim.

Pelchy an endoscope with integral imaging capability (Pelchy: figure 4), comprising: a tubular portion including a distal end, a proximal end, and a central passageway extending therethrough (Pelchy: column 3, lines 25-30; column 4, lines 55-60); means for providing light to said distal end to illuminate a surgical site (Pelchy: column 5, lines 5-10); an image sensor lying in a first plane and positioned at said distal end of said tubular portion for receiving images of the surgical site thereon, said image sensor defining a profile area (Pelchy: figure 2, element 21: profile area established by the circumference of element 21), said image sensor producing a prevideo signal (Pelchy: column 3, lines 45-50; column 1, lines 8-10); a video processor board lying in a second plane spaced apart from and longitudinally aligned with said image sensor within said tubular portion and adjacent said distal end thereof, said video processor board including circuitry for processing said image signal as specified, said video processing board being positioned so as not extend substantially beyond said profile area, as specified (Pelchy: column 3, lines 10-15 and 53-55); and a power supply device coupled with said image sensor for driving said array of pixels, and electrically coupled to said first circuit board for driving said circuit board (Pelchy: column 4, lines 17-25), as specified in claim 14. The Laser Focus article discloses that the use of a passive CMOS image sensor timing and control circuitry at each CMOS pixel (Laser Focus: third page, right most column, lines 32-60) is preferable to using a CCD because the standard CCD imagers as contained by the original Pelchy endoscope waste more power (Laser Focus: second

Art Unit: 2713

page, leftmost column, lines 35-50). Accordingly, given the <u>Laser Focus</u> article's teaching of advantageously using a passive CMOS image sensor, it would have been obvious for one of ordinary skill in the art to modify the Pelchy apparatus by incorporating the <u>Laser Focus</u> article's disclosed passive CMOS imager for the standard Pelchy imager (Pelchy: figure 2, element 20) in order to minimize power consumption. The Pelchy apparatus, as modified with the inclusion of the <u>Laser Focus</u>'s passive CMOS imager which has timing and control circuitry at each pixel site, has all of the features of claim 14.

Regarding claims 16-17, the Pelchy apparatus, as modified with the inclusion of the Laser Focus's passive CMOS imager which has timing and control circuitry at each pixel site, has an array of passive CMOS pixels which includes a photo diode and access transistor pair (Laser Focus: third page, rightmost column, lines 28-38), as specified.

Regarding claims 18-19, the Pelchy apparatus, as modified with the inclusion of the Laser Focus's passive CMOS imager which has timing and control circuitry at each pixel site, has the timing and control circuitry placed on said first plane (Laser Focus: first page, rightmost column, lines 3-13) or wherein said timing and control circuitry means for processing and converting (Pelchy: column 4, lines 15-25), as in the claims.

Regarding claim 20, the Pelchy apparatus, as modified with the inclusion of the <u>Laser</u> <u>Focus</u>'s passive CMOS imager which has timing and control circuitry at each pixel site, has an endoscope with a gripping handle (Pelchy: column 3, lines 15-18: "steering capability"), as in the claim.
Regarding claim 21, the Pelchy apparatus, as modified with the inclusion of the <u>Laser</u> <u>Focus</u>'s passive CMOS imager which has timing and control circuitry at each pixel site, has a lens positioned at said distal end (Pelchy: column 5, lines 1-4), as specified.

Pelchy an endoscope (Pelchy: figure 4), comprising: a tubular portion including a distal end, a proximal end, and a central passageway extending therethrough (Pelchy: column 3, lines 25-30; column 4, lines 55-60); an image sensor lying in a first plane and positioned at said distal end of said tubular portion for receiving images of the surgical site thereon, said image sensor defining a profile area (Pelchy: figure 2, element 21: profile area established by the circumference of element 21), said image sensor producing a pre-video signal (Pelchy: column 3, lines 45-50; column 1, lines 8-10); a control box remote from said image sensor, said control box including circuitry means for receiving said pre-video signal from the image sensor as specified (Pelchy: column 3, lines 10-15); and a power supply device coupled with said image sensor for driving said array of pixels, and electrically coupled to said first circuit board for driving said circuit board (Pelchy: column 4, lines 17-25), as specified in claim 24. The Laser Focus article discloses that the use of a passive CMOS image sensor timing and control circuitry at each CMOS pixel (Laser Focus: third page, right most column, lines 32-60) is preferable to using a CCD because the standard CCD imagers as contained by the original Pelchy endoscope waste more power (Laser Focus: second page, leftmost column, lines 35-50). Accordingly, given the Laser Focus article's teaching of advantageously using a passive CMOS image sensor, it would have been obvious for one of ordinary skill in the art to modify the Pelchy apparatus by incorporating the Laser Focus

Serial Number: 09/175,685

Art Unit: 2713

article's disclosed passive CMOS imager for the standard Pelchy imager (Pelchy: figure 2, element 20) in order to minimize power consumption. The Pelchy apparatus, as modified with the inclusion of the Laser Focus's passive CMOS imager which has timing and control circuitry at each pixel site, has all of the features of claim 24.

Regarding claim 25, Pelchy apparatus, as modified with the inclusion of the <u>Laser Focus</u>'s passive CMOS imager which has timing and control circuitry at each pixel site, has a power supply located in said control box (Pelchy: column 3, lines 5-16), as in claim 25.

Regarding claim 26, the Pelchy apparatus, as modified with the inclusion of the <u>Laser</u> <u>Focus</u>'s passive CMOS imager which has timing and control circuitry at each pixel site, has an endoscope with a gripping handle (Pelchy: column 3, lines 15-18: "steering capability"), as in the claim.

Regarding claim 27, the Pelchy apparatus, as modified with the inclusion of the Laser Focus's passive CMOS imager which has timing and control circuitry at each pixel site, has a supplementary circuit board electronically coupled with said first circuit board and said image sensor for enhancing said pre-video signal as specified (Pelchy: figure 2, element 27), as specified. 6. Claims 11-13 and 30-32 are rejected under 35 U.S.C. 103(a) as being unpatentable over Pelchy in view of 6/97 Laser Focus article entitled "Imaging options expand with CMOS technology" (hereinafter referred to as "Laser Focus") and further in view of Danna et al., (hereinafter referred to as "Danna").

Pelchy discloses a reduced area imaging device (Pelchy: figure 4), comprising : an image sensor lying in a first plane and including an array of pixels for receiving images thereon (Pelchy: column 3, lines 45-50; column 1, lines 8-10); a circuit board longitudinally aligned with and second plane and electrically coupled to with said image sensor, said first circuit board including circuitry means for converting said pre-video signal to a post-video signal for reception by a stand video device signal for reception by a standard video device (Pelchy: column 3, lines 10-15 and 54-65); and a power supply device coupled with said image sensor for driving said array of pixels, and electrically coupled to said first circuit board for driving said circuit board (Pelchy: column 4, lines 17-25) and that the circuit board is substantially parallel to the image sensor plane, as specified in claim 11. However, Pelchy fails to disclose the that the image sensor further includes timing and control circuitry means on said first plane and coupled to said pixel array such as a CMOS imager (Pelchy: column 3, lines 45-50), even though the reference recognizes that the use of a TAB imager could be also apply CMOS based imager (Pelchy: column 1, lines 7-10). The Laser Focus article discloses that the use of a passive CMOS image sensor timing and control circuitry at each CMOS pixel (Laser Focus: third page, right most column, lines 32-60) is preferable to using a CCD because the standard CCD imagers as contained by the original Pelchy endoscope waste more power (Laser Focus: second page, leftmost column, lines 35-50). Accordingly, given the Laser Focus article's teaching of advantageously using a passive CMOS image sensor, it would have been obvious for one of ordinary skill in the art to modify the Pelchy apparatus by incorporating the Laser Focus article's disclosed passive CMOS imager for the

Serial Number: 09/175.685

Art Unit: 2713

standard Pelchy imager (Pelchy: figure 2, element 20) in order to minimize power consumption. The Pelchy apparatus, as modified with the inclusion of the Laser Focus's passive CMOS imager which has timing and control circuitry at each pixel site, has a majority of the features of claim 11, but fails to disclose the parallel positioning of the circuit boards with the image sensor board as in the claim 11. Danna discloses that the parallel arrangement of an image sensor and a circuit board in an endoscopic imaging housing in order to make the imaging head more compact (Danna: column 4, lines 20-68) and thereby reducing patient discomfort (Danna: column 2, lines 35-45). Accordingly, given the Danna teaching it would have been obvious for one of ordinary skill in the art to modify the Pelchy-Laser Focus apparatus to have it's CMOS imager and circuitry boards aligned in a parallel fashion as taught by Danna in order to reduce patient discomfort suffer to the larger arrangement as taught by the primary reference (Pelchy: figures 6-7). The Pelchy-Laser-Focus apparatus, further modified by Danna's parallel implementation of the image sensor and circuit board configuration, has all of the features of claim 11.

Regarding claim 12, the Pelchy-Laser-Focus apparatus, further modified by Danna's parallel implementation of the image sensor and circuit board configuration, has an array of passive CMOS pixels which includes a photo diode and access transistor pair (Laser Focus: third page, rightmost column, lines 28-38), as specified.

Regarding claim 13, the Pelchy-Laser-Focus apparatus, further modified by Danna's parallel implementation of the image sensor and circuit board configuration, has a supplementary

Serial Number: 09/175,685

Art Unit: 2713

circuit board electronically coupled with said first circuit board and said image sensor for enhancing said pre-video signal as specified (Danna: column 4, lines 30-60), as specified.

Pelchy discloses a reduced area imaging device (Pelchy: figure 4), comprising : an image sensor lying in a first plane and including an array of pixels for receiving images thereon (Pelchy: column 3, lines 45-50; column 1, lines 8-10); a circuit board longitudinally aligned with and second plane and electrically coupled to with said image sensor, said first circuit board including circuitry means for converting said pre-video signal to a post-video signal for reception by a stand video device signal for reception by a standard video device (Pelchy: column 3, lines 10-15 and 54-65); a control box remote from said image sensor, said control box including circuitry means for receiving said pre-video signal from the image sensor as specified (Pelchy: column 3, lines 10-15); and a power supply device coupled with said image sensor for driving said array of pixels, and electrically coupled to said first circuit board for driving said circuit board (Pelchy: column 4, lines 17-25) and that the circuit board is substantially parallel to the image sensor plane, as specified in claim 30. However, Pelchy fails to disclose the that the image sensor is a CMOS image and further includes timing and control circuitry means thereon, even though the reference recognizes that the use of a TAB imager could be also apply CMOS based imager (Pelchy: column 1, lines 7-10). The Laser Focus article discloses that the use of a active CMOS image sensor timing and control circuitry at each CMOS pixel (Laser Focus: second page, rightmost column, lines 4-8) is preferable to using a CCD because the standard CCD imagers as contained by the original Pelchy endoscope waste more power (Laser Focus: second page, leftmost column,

Art Unit: 2713

lines 35-50). Accordingly, given the Laser Focus article's teaching of advantageously using a active CMOS image sensor, it would have been obvious for one of ordinary skill in the art to modify the Pelchy apparatus by incorporating the Laser Focus article's disclosed active CMOS imager for the standard Pelchy imager (Pelchy: figure 2, element 20) in order to minimize power consumption. The Pelchy apparatus, as modified with the inclusion of the Laser Focus's active CMOS imager which has timing and control circuitry at each pixel site, has all of the features of . of claim 30, but fails to disclose the parallel positioning of the circuit boards with the image sensor board as in the claim 30. Danna discloses that the parallel arrangement of an image sensor and a circuit board in an endoscopic imaging housing in order to make the imaging head more compact (Danna: column 4, lines 20-68) and thereby reducing patient discomfort (Danna: column 2, lines 35-45). Accordingly, given the Danna teaching it would have been obvious for one of ordinary skill in the art to modify the Pelchy-Laser Focus apparatus to have it's CMOS imager and circuitry boards aligned in a parallel fashion as taught by Danna in order to reduce patient discomfort suffer to the larger arrangement as taught by the primary reference (Pelchy: figures 6-7). The Pelchy-Laser-Focus apparatus, further modified by Danna's parallel implementation of the image sensor and circuit board configuration, has all of the features of claim 30.

Regarding claim 31, the Pelchy-Laser-Focus apparatus, further modified by Danna's parallel implementation of the image sensor and circuit board configuration, has an array of passive CMOS pixels which includes a photo diode and access transistor pair (Laser Focus: third page, rightmost column, lines 28-38), as specified.

Art Unit: 2713

Pelchy discloses a reduced area imaging device (Pelchy: figure 4), comprising : an image sensor lying in a first plane and including an array of pixels for receiving images thereon (Pelchy: column 3, lines 45-50; column 1, lines 8-10); a circuit board longitudinally aligned with and second plane and electrically coupled to with said image sensor, said first circuit board including circuitry means for converting said pre-video signal to a post-video signal for reception by a stand video device signal for reception by a standard video device (Pelchy: column 3, lines 10-15 and 54-65); a control box remote from said image sensor, said control box including circuitry means for receiving said pre-video signal from the image sensor as specified (Pelchy: column 3, lines 10-15); and a power supply device coupled with said image sensor for driving said array of pixels, and electrically coupled to said first circuit board for driving said circuit board (Pelchy: column 4, lines 17-25) and that the circuit board is substantially parallel to the image sensor plane, as specified in claim 30. However, Pelchy fails to disclose the that the image sensor further includes timing and control circuitry means on said first plane and coupled to said pixel array such as a CMOS imager (Pelchy: column 3, lines 45-50), even though the reference recognizes that the use of a TAB imager could be also apply CMOS based imager (Pelchy: column 1, lines 7-10). The Laser Focus article discloses that the use of a passive CMOS image sensor timing and control circuitry at each CMOS pixel (Laser Focus: third page, right most column, lines 32-60) is preferable to using a CCD because the standard CCD imagers as contained by the original Pelchy endoscope waste more power (Laser Focus: second page, leftmost column, lines 35-50). Accordingly, given the Laser Focus article's teaching of advantageously using a passive CMOS

Serial Number: 09/175,685

Art Unit: 2713

image sensor, it would have been obvious for one of ordinary skill in the art to modify the Pelchy apparatus by incorporating the Laser Focus article's disclosed passive CMOS imager for the standard Pelchy imager (Pelchy: figure 2, element 20) in order to minimize power consumption. The Pelchy apparatus, as modified with the inclusion of the Laser Focus's passive CMOS imager which has timing and control circuitry at each pixel site, has a majority of the features of claim 30, but fails to disclose the parallel positioning of the circuit boards with the image sensor board as in the claim 30. Danna discloses that the parallel arrangement of an image sensor and a circuit board in an endoscopic imaging housing in order to make the imaging head more compact (Danna: column 4, lines 20-68) and thereby reducing patient discomfort (Danna: column 2, lines 35-45). Accordingly, given the Danna teaching it would have been obvious for one of ordinary skill in the art to modify the Pelchy-Laser Focus apparatus to have it's CMOS imager and circuitry boards aligned in a parallel fashion as taught by Danna in order to reduce patient discomfort suffer to the larger arrangement as taught by the primary reference (Pelchy: figures 6-7). The Pelchy-Laser-Focus apparatus, further modified by Danna's parallel implementation of the image sensor and circuit board configuration, has all of the features of claim 30.

Regarding claim 32, Pelchy-Laser-Focus apparatus, further modified by Danna's parallel implementation of the image sensor and circuit board configuration, has an amplifier for each individual pixel (Laser Focus: second page, rightmost column, lines 4-9), as in the claim.

7. Claims 4-5, and 23 are rejected under 35 U.S.C. 103(a) as being unpatentable over Pelchy in view of 6/97 Laser Focus article entitled "Imaging options expand with CMOS technology"

(hereinafter referred to as "Laser Focus") as applied to preceding claims 1, 3, and above, and further in view of Danna et al., (hereinafter referred to as "Danna").

The Pelchy apparatus, as modified with the inclusion of the Laser Focus disclosed CMOS imager, has all of the features of claims 1, 3, and 23, but fails to disclose the parallel positioning of the circuit boards with the image sensor board as in the claims 4-5 and 23. Danna discloses that the parallel arrangement of an image sensor and a circuit board in an endoscopic imaging housing in order to make the imaging head more compact (Danna: column 4, lines 20-68) and thereby reducing patient discomfort (Danna: column 2, lines 35-45). Accordingly, given the Danna teaching it would have been obvious for one of ordinary skill in the art to modify the Pelchy-Laser Focus apparatus to have it's CMOS imager and circuitry boards aligned in a parallel fashion as taught by Danna in order to reduce patient discomfort suffer to the larger arrangement as taught by the primary reference (Pelchy: figures 6-7). The Pelchy-Laser-Focus apparatus, further modified by Danna's parallel implementation of the image sensor and circuit board configuration, has all of the features of claims 4-5, and 23.

8. Claims 22 and 29 are rejected under 35 U.S.C. 103(a) as being unpatentable over Pelchy in view of 6/97 <u>Laser Focus</u> article entitled "Imaging options expand with CMOS technology" (hereinafter referred to as "<u>Laser Focus</u>") as applied to claims 14 and 24 above, and further in view of Steinberg.

The Pelchy apparatus, as modified with the inclusion of the Laser Focus disclosed CMOS imager, has all of the features of claims 22 and 29, but fails to disclose the use of a power supply

Serial Number: 09/175,685

Art Unit: 2713

as being configured as a battery attached to the handle of the endoscope, as in claims 22 and 29. Steinberg discloses that it is known to incorporate the use of an attachably detachable battery as a power source (Steinberg: column 4, lines 60-68; column 5, lines 1-40; figure 7, element 208) within an endoscope's handle (Steinberg: column 3, lines 50-55) in order the make the endoscope useable at remote sites (i.e portable) and further decrease the set-up time the use of the apparatus (Steinberg: column 2, lines 18-43). Given Steinberg's teaching of using a battery as a power source within the handle of an endoscope, it would have been further obvious for one of ordinary skill in the art to incorporate the handle contained battery of Steinberg into the composite Pelchy-Laser Focus article discussed apparatus, in order to reduce to the set-up time of the original Pelchy-Laser Focus article discussed apparatus. The Pelchy endoscope now incorporating both the Laser Focus article discussed CMOS imager and the Steinberg's battery handled power supply, has all of the features of claim 22 and 29.

Conclusion

9. Any inquiry concerning this communication or earlier communications from the examiner should be directed to Anand Rao whose telephone number is (703)-305-4813.

Patent Examiner Anand S. Rao Art Unit 2713

Samsung Exhibit 1003 Page 118 of 208 Serial Number: 09/175,685

Art Unit: 2713



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EXAMINER: Initial if citation considered, whether or not citation is in conformance with MPEP §609. Draw line through citation if not in conformance and not considered, Include copy of this form with next communication to the applicant.

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Patent and Trademark Office: U.S. DEPARTMENT OF COMMERCE

Form PTO 948 (Rev. 8-98) U.S. DEPARTMENT OF COMMERCE - Patent and Trademark Office Application No. (

NOTICE OF DRAFTSPERSON'S PATENT DRAWING REVIEW

9

ATTACHMENT TO PAPER NO.

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2,005 B

| 1. DRAWINGS. 37 CFR 1.84(a): Acceptable categories of drawings: | 8. ARRANGEMENT OF VIEWS. 37 CFR 1.84(i) |
|---|--|
| Black ink. Color. | Words do not appear on a horizontal, left-to-right fashion |
| Color drawings are not acceptable until petiton is granted. | when page is either upright or turned so that the top |
| Fig(s) | becomes the right side, except for graphs. Fig(s) |
| Pencil and non black ink not permitted. Fig(s) | 9. SCALE. 37 CFR 1.84(k) |
| 2. PHOTOGRAPHS. 37 CFR 1.84 (b) | Scale not large enough to show mechanism without |
| 1 full-tone set is required. Fig(s) | crowding when drawing is reduced in size to two-thirds in |
| Photographs not properly mounted (must use brystol board or | reproduction. |
| photographic double-weight paper). Fig(s) | Fig(s) |
| Foor quality (half-tone). Fig(s) | 10. CHARACTER OF LINES, NUMBERS, & LETTERS. |
| | 37 CFR 1.84(i) |
| 3. TYPE OF PAPER. 37 CFR 1.84(e) | |
| :Paper not flexible, strong, while, and durable. | Lines, numbers & letters not uniformly thick and well |
| Fig(s) | defined, clean, durable, and black (poor line quality). |
| Erasures, alterations, overwritings, interlineations, | Fig(s) |
| folds, copy machine marks not accepted. Fig(s) | 11. SHADING. 37 CFR 1.84(m) |
| Mylar, velum paper is not acceptable (too thin). | Solid black areas pale. Fig(s) |
| Fig(s) | Solid black shading not permitted. Fig(s) |
| 4. SIZE OF PAPER. 37 CFR 1.84(f): Acceptable sizes: | Shade lines, pale, rough and blurred. Fig(s) |
| 21.0 cm by 29.7 cm (DIN size A4) | 12. NUMBERS, LETTERS, & REFERENCE CHARACTERS. |
| 21.6 cm by 27.9 cm (8 1/2 x 11 inches) | 37 CFR 1.84(p) |
| | |
| All drawing sheets not the same size. | Numbers and reference characters not plain and legible. |
| Shect(s) | Fig(s) |
| Drawings sheets not an acceptable size. Fig(s) | Figure legends are poor. Fig(s) |
| 5. MARGINS. 37 CFR 1.84(g): Acceptable margins: | Numbers and reference characters not oriented in the |
| 이 귀엽을 하는 해외에서 가지 않는 것이 많은 것이 없다. ㅠ~ | same direction as the view, 37 CFR 1.84(p)(1) |
| Top 2.5 cm Left 2.5 cm Right 1.5 cm Bottom 1.0 cm | Fig(s) |
| SIZE: A4 Size | English alphabet not used. 37 CFR 1.84(p)(2) |
| Top 2.5 cm Left 2.5 cm Right 1.5 cm Bottom 1.0 cm | Figs |
| SIZE: 81/2 x 11 | Numbers, letters and reference characters must be at least |
| Margins not acceptable. Fig(s) | .32 cm (1/8 inch) in height. 37 CFR 1.84(p)(3) |
| Top (T) Left (L) | Fig(s) |
| Right (R) Bottom (B) | |
| 6. VIEWS. 37 CFR 1.84(h) | 13. LEAD LINES. 37 CFR 1.84(q) |
| REMINDER: Specification may require revision to | Lead lines cross each other. Fig(s) |
| REMITTIDER. Specification may require revision to | — Lead lines missing. Fig(s) |
| correspond to drawing changes. | 14. NUMBERING OF SHEETS OF DRAWINGS. 37 CFR 1.84(I) |
| Partial views. 37 CFR 1.84(h)(2) | Sheets not numbered consecutively, and in Arabic numerals |
| Brackets needed to show figure as one entity. | beginning with number 1. Sheet(s) |
| Fig(s) | 15. NUMBERING OF VIEWS, 37 CFR 1.84(u) |
| Views not labeled separately or properly. | Views not numbered consecutively, and in Arabic numerals, |
| Fig(s) | beginning with number 1. Fig(s) |
| Enlarged view not labeled separetely or properly. | 16. CORRECTIONS. 37 CFR 1.84(w) |
| Fig(s) | |
| 7. SECTIONAL VIEWS. 37 CFR 1.84 (h)(3) | Corrections not made from prior PTO-948 dated |
| Hatching not indicated for sectional portions of an object. | OBICO |
| Fig(s) | 17. DESIGN DRAWINGS, 37 CFR 1.152 |
| Sectional designation should be noted with Arabic or | Surface shading shown not appropriate. Fig(s) |
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Samsung Exhibit 1003 Page 123 of 208

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| valid OMB control number. | Application Number | 09/175,685 | | |
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| TRANSMITTAL | Filing Date | October 20, 1998 | | |
| FORM | First Named Inventor | Edwin L. Adair, et a | | |
| (to be used for all correspondence after initial filing | Group Art Unit | 2713 | | |
| | Examiner Name | A. Rao | | |
| Total Number of Pages in This Submission 3 | Attorney Docket Number | F97.13 CIP2 | | |
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| or Individual name | P.C. | | | |
| Signature BARL | | | | |
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| I hereby certify that this correspondence is being de envelope addressed to: Assistant Commissioner fo | eposited with the United States P | | | |
| Typed or printed name Brent P. JohnsA | n | | | |
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| Patent fees are subject to annual revision. | First Named Inventor | Edwin L. Adair, et | al. |
| Small Entity payments <u>must</u> be supported by a small entity state otherwise large entity fees must be paid. See Forms PTO/SB/0 | ment, 9-12. Examiner Name | A. Rao | |
| See 37 C.F.R. §§ 1.27 and 1.28. | Group / Art Unit | 2713 | |
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| SUBMITTED BY | | | |
| Name (Print/Type) Brent P. Johnson | Registration No. 38 031 | Complete (if applicable) | |
| Signature B + 1/Q.Q. | (Attorney/Agent) 38,031 | Telephone 303-689-9 | 100 |
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Burden Hour Statement: This form is estimated to take 0.2 hours to complete. Time will vary depending upon the needs of the individual case. Any comments on the amount of time you are required to complete this form should be sent to the Chief Information Officer, Patent and Trademark Office, Washington, DC 20231, DO NOT SEND FEES OR COMPLETED FORMS TO THIS ADDRESS. SEND TO: Assistant Commissioner for Patents, Washington, DC 20231.

J. Douglas ATES PATENT AND TRADEMARK OFFICE IN THE SECOND SUPPLEMENTAL In Re the Continuation in Part PRELIMINARY Application of AMENDMENT Edwin L. Adair, Jeffrey L. Adair,) Examiner: A. Rao Randall S. Adair Art Unit: 2713 Serial No.: 09/175,685 I hereby carsty that the contractorise due to being deposited with the United States Postal Service do Filed: October 20, 1998 first class mail in an envelope addressed to Apaistant Commissioner for Patonts Washington "Reduced Area Imaging For: Devices" ne of epplicant, ascanoe, or Registered Rep Assistant Commissioner for Patents Washington, D.C. 20231 ς. Sir: Please amend the above-identified application as follows: IN THE CLAIMS: 2 (Amended) An endoscope comprising: SUBFI 24. a tubular portion including a central passageway extending therethrough, a proximal end and a distal end; a CMOS image sensor positioned at said distal end of said tubular portion for receiving images of a surgical site, said CMOS imager 5 defined by an array of CMOS pixels and [wherein individual pixels within said array of said CMOS pixels each include an amplifier], said CMOS imager lying in a first plane;

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sensor placed adjacent to said CMOS image sensor on said first plane; a control box remote from said tubular portion and coupled to said CMOS image sensor, said control box including circuitry means for receiving a pre-video signal from said CMOS image sensor, and for

circuitry means for timing and control of said CMOS image

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converting said pre-video signal to a post-video signal which may be received by a standard video device; and

a power supply coupled to said control box and said CMOS image sensor for providing power thereto.

Add the following new claims:

33. An endoscope, as claimed in claim 24, wherein: individual pixels within said array of CMOS pixels each include an amplifier.

34. An endoscope, as claimed in claim 24, wherein: said array of CMOS pixels includes a plurality of passive CMOS pixels, and wherein individual passive CMOS pixels of said plurality of passive CMOS pixels each include a photo diode for producing photo electrically generated signals, and an access transistor communicating with said photo diode to control the release of said photo electrically generated signals.

REMARKS

By the foregoing, Claim 24 has been amended, and new Claims 33 and 34 have been added. As a review of the claims in this application, Claims 1-7 were filed originally with the application, Claims 8-29 were added in the Preliminary Amendment filed on March 8, 1999, and Claims 30-32 were added in a first Supplementary Preliminary Amendment filed on March 24, 1999. Enclosed herewith is a check in the amount of \$18.00 to cover the additional fees for new Claims 33 and 34. Any shortfall may be charged to Deposit Account No. 06-0778.

Respectfully submitted,

FIELDS & JOHNSON, P.C.

Gary D. Fields Brent P. Johnson 8480 East Orchard Road, Suite 5600 Englewood, CO 80111 (303) 689-9100

Date: 7/29/99



UNITED STATES .PARTMENT OF COMMERCE Patent and Trademark Office Address: COMMISSIONER OF PATENTS AND TRADEMARKS Washington, D.C. 20231

| APPLICATION NO. FILING DATE FIRST NAM | | FIRST NAMED | INVENTOR | | ATTORNEY DOCKET NO. |
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Please find below and/or attached an Office communication concerning this application or proceeding.

Commissioner of Patents and Trademarks

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| dentification of prior art discussed: US Patent 5,754,313 to Pelchy et al. | | | | |
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| Date of Interview Aug 3 | 31, 1999 | | | |
| 2) Mr. Brent Johnson (#38,031) | | (4) | 3 | |
| 1) Anand Rao | | | | |
| | representative, P | TO personnel): | | |
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| | | Examiner Name | A. Rao |
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| Firm or Individual name | Brent P. Johnson | | |
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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

| In Re the Continuation in Part Application of |))) Examiner: A. Rao | 2 | |
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| Edwin L. Adair, Jeffrey L. Adair, Randall S. Adair |) Art Unit: 2713 | | |
| Serial No.: 09/175,685 |) | 1 | |
| Filed: October 20, 1998 |)) | | |
| - In the Interior Devices | ") | | |

For: "Reduced Area Imaging Devices")

Assistant Commissioner for Patents Washington, D.C. 20231

"Express Mail" mailing label number <u>EL245411015US</u>

Date of Deposit: September 1, 1999

I hereby certify that the following:

- -- Transmittal Form
- -- Amendment
- -- Return postcard

are being deposited with the United States Postal Service "Express Mail Post Office to Addressee" service under 37 CFR 1.10 on the date indicated above and are addressed to Assistant Commissioner For Patents, Washington, DC 20231.

Uriginia A. Sawatshe Virginia A. Sawatzke

Virginia A. Sawatzke 8480 East Orchard Road, Suite 5600 Englewood, CO 80111 (303) 689-9100 Date: <u>Sect. 1</u>, 1997

Samsung Exhibit 1003 Page 132 of 208



THE UNITED STATES PATENT AND TRADEMARK OFFICE

In Re the Continuation in Part Application of

Edwin L. Adair, Jeffrey L. Adair, Randall S. Adair

Serial No.: 09/175,685

Filed: October 20, 1998

For: "Reduced Area Imaging Devices")

Assistant Commissioner for Patents Washington, D.C. 20231

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| Examiner: A. Rao | 24 | | | |
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Sir:

This Amendment is responsive to the Office Action dated

August 6, 1999, the above-identified application being amended as follows:

IN THE CLAIMS:

Amend Claim 1 as follows:

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 (Amended) A reduced area imaging device comprising: an imager sensor lying in a first plane and including an array

of <u>CMOS</u> pixels for receiving images thereon, said image sensor further including circuitry means on said first plane and coupled to said array of <u>CMOS</u> pixels for timing and control of said array of <u>CMOS</u> pixels, said image sensor producing a pre-video signal;

a pre-video conductor for transmitting said pre-video signal. said pre-video conductor having first and second ends, said first end communicating with said image sensor;

a first circuit board lying in a second plane and longitudinally aligned with said image sensor, said first circuit board being connected to said pre-video conductor at said second end thereof, said first circuit board including circuitry means for converting said pre-video signal to a postvideo signal for <u>direct</u> reception by a standard video device; and

a power supply electrically coupled with said image sensor for driving said array of pixels and said timing and control means, and electrically coupled to said first circuit board for driving said circuit board.

Claim 3, line 5, after "said" insert -- first--.

Amend Claim 6 as follows:

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 6. (Amended) A reduced area imaging device comprising: an image sensor lying in a first plane and including an array of <u>CMOS</u> pixels for receiving images thereon, said image sensor further including circuitry means on said first plane and coupled to said array of

<u>CMOS</u> pixels for timing and control of said array of <u>CMOS</u> pixels, said image sensor producing a pre-video signal;

a control box remote from said image sensor, said control box including circuitry means for receiving said pre-video signal from said image sensor, and for converting said pre-video signal to a post-video

signal which may be received by a standard video device; and a power supply coupled to said control box and said image

sensor for providing power thereto.

Samsung Exhibit 1003 Page 134 of 208

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Amend Claim 8 as follows:

8. (Amended) A reduced area imaging device, as claimed in claim 1, wherein said [image sensor] <u>array of CMOS pixels</u> further includes:

an array of passive CMOS pixels, wherein individual passive CMOS pixels of said array of passive CMOS pixels each includes a photo diode for producing photoelectrically generated signals[;] and an access transistor communicating with said photo diode to control the release of said photoelectrically generated signals.

Cancel Claims 9 and 10 without prejudice.

Amend Claim 11 as follows:

14. (Amended) A reduced area imaging device comprising: an array of CMOS pixels defining a profile area and lying in

a first plane, said array of CMOS pixels for receiving images thereon;

a circuit board longitudinally aligned with and electrically [couples] <u>coupled</u> to said array of CMOS pixels, said circuit board lying in a second plane which is offset from said first plane and substantially parallel to said first plane, said circuit board including circuitry means for timing and control of said array of CMOS pixels, said timing and control means producing a pre-video signal, said circuit board further including

10 circuitry means for receiving said pre-video signal from said timing and control means and converting said pre-video signal to a post-video output signal for <u>direct</u> reception by a video device; and

a power supply electrically coupled to said array of said CMOS pixels and said circuit board.

> Samsung Exhibit 1003 Page 135 of 208

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Amend Claim 14 as follows:

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12. 14. (Amended) An endoscope with integral imaging capability for producing images to be viewed on a video device, said endoscope comprising:

a tubular portion including a distal end, a proximal end and a 5 central passageway extending therethrough;

means for providing light to said distal end to illuminate a surgical site;

a CMOS image sensor lying in a first plane and positioned at said distal end of said tubular portion for receiving images of the surgical site, said CMOS image sensor defining a profile area, and said CMOS image sensor producing an image signal;

circuitry means electrically coupled to said CMOS image sensor for timing and control of said CMOS image sensor, said circuitry means for timing and control placed within said tubular portion;

15 a video processor board lying in a second plane spaced from and longitudinally aligned with said CMOS image sensor within said tubular portion and adjacent said distal end thereof, and communicating with said CMOS image sensor to receive said image signal, said video processor board including circuitry means for processing said image signal

20 and converting said image signal to a post-video signal <u>for direct reception</u> by the video device, said video processor board being positioned so as not to extend substantially beyond said profile area, [said video processor board communicating with said CMOS image sensor to receive said image signal]; and

a power supply electrically coupled to said CMOS image sensor and said video processor board.

Samsung Exhibit 1003 Page 136 of 208

| | Amend Claim 28 as follows: 26, 28, (Amended) An endoscope, as claimed in claim 24, further | |
|----|---|--|
| De | including: | |
| Y | a lens positioned at said distal end of said tubular portion of | |
| | sensor. | |

REMARKS

Applicant's attorney sincerely appreciates the personal interview so courteously granted by Examiner Rao on August 31, 1999. Pursuant to the interview, it was understood that each of the claims as amended above would define over the prior art. The following includes applicant's full response to the Office Action, and supporting arguments as presented in the interview.

Claim 28 was objected to. Claim 28 has been rewritten. Apparently when Claim 28 was originally filed, a line of text was deleted in the page containing this claim which caused the discrepancy. Therefore, the objection to Claim 28 should be withdrawn.

Claims 1-3, 6-10, 14-21 and 24-27 were rejected under 35 U.S.C. §103 as being unpatentable over Pelchy, et al. in view of the 6/97 *Laser Focus* article entitled "Imaging Options Expand With CMOS Technology." The Examiner stated that Pelchy fails to disclose that the image sensor further includes timing and control circuitry means on said first plane and coupled to said pixel array such as a CMOS imager, even though the reference recognizes that the use of a TAB imager could also apply to a CMOS-based imager. The Examiner further stated that the *Laser Focus*

> Samsung Exhibit 1003 Page 137 of 208

article is preferable to using a CCD imager because CMOS imagers minimize power consumption.

Obviousness can only be established by combining or modifying the teachings of the prior art to produce the claimed invention where there is some teaching, suggestion, or motivation to do so found either in the references themselves or in the knowledge generally available to one of ordinary skill in the art. In re Fine, 837 Fed.2d 1071 (Fed. Cir. 1988). A reference should be considered as a whole, and portions arguing against or teaching away from the claimed invention must be considered. Bausch & Lombe, Inc. v. Barnes/Hinde/Hydrocurve, Inc., 796 Fed.2d 443 (Fed. Cir. 1996). Where the teachings of two or more prior art references conflict, the Examiner must weigh the power of each reference to suggest solutions to one of ordinary skill in the art, considering the degree to which one reference might accurately discredit another. In re Young, 927 Fed.2d 588 (Fed. Cir. 1991). If the proposed modification would render the prior art invention being modified unsatisfactory for its intended purpose, then there is no suggestion or motivation to make the proposed modification. In re Gordon, 733 Fed.2d 900 (Fed. Cir. 1984). If the proposed modification or combination of the prior would change the principle of operation of the prior art invention being modified, then the teachings of the references are not sufficient to render the claims prima facie obvious. In re Ratti, 270 Fed.2d 810 (CCPA 1959).

In the present case, the Examiner argues that modification of the primary reference (Pelchy, et al.) is proper because use of a TAB imager could also be applied to a CMOS-based imager. Applicant respectfully disagrees with the Examiner's conclusion and believes that there is express teaching away from the combination of the two references.

6

The Examiner relies on the suggestion of interchanging a CMOS imager with a TAB imager as found in Pelchy, et al. at column 1, lines 7-10. This portion reads "The increased availability of smaller solid state imagers based on CCD or CMOS technologies has surpassed the availability of conventional wire bonding techniques to take full advantage of the space savings afforded by these small imagers."

Taken in the context of Pelchy as a whole, this sentence simply means that as applied to wire bonding techniques for interconnecting electronic components, CCD and CMOS technology has surpassed these traditional wire bonding techniques such that it is actually the wire bonding techniques which place a limitation on how small an imager can be packaged. It is improper to interpret this sentence as meaning that the TAB imager disclosed in Pelchy is applicable universally to all CCD and CMOS imagers, or that any CCD or CMOS imager is substitutable for the TAB imager disclosed.

The Laser Focus article at the first page, column 2, first full paragraph, specifically discusses why substituting CMOS technology for standard CCD technology, such as disclosed in Pelchy, et al., is impractical for purposes of creating imaging devices which are more like cameras on a chip, as opposed to imaging devices which are found on multiple circuit boards. Here, the articles states that "By shifting imager designs to CMOS processing, designers can implement many camera functions on a chip . . . many of the functions that were previously performed by a frame grabber or that required external control can now be implemented on-chip as well." Furthermore, the article discusses why it may not be desirable to simply substitute a CMOS imager with a CCD imager. At the fourth page of the article, in the sub-section entitled "Performance trade-offs," the article states "Just as application needs vary, so will imager based camera systems. No CMOS imager will satisfy every application, and there are finite limits to the practical uses of the technology. For example, the (CMOS) devices will not in the foreseeable future be available to the ultra-low noise scientific market that niche will remain filled by the CCD or CCD/CMOS hybrid. ... A photodiode array can be read in a non-integration mode, so applications requiring this performance will remain outside the province of CMOS imagers." Therefore, it is clear that some CCD devices have distinct advantages over CMOS devices, and visa versa. Thus, this article makes it clear that, absent some more clear suggestion or motivation found in the references, one cannot simply substitute one imaging device for the other because each has its own advantages depending upon the particular application.

Pelchy, et al. is directed to an improvement wherein the TAB imager package is made shorter in length as compared to the prior art (column 2, lines 66-67; column 3, lines 1-5). In short, Pelchy, et al. takes the single circuit board of the prior art (Reference No. 115, Figure 10) and breaks this circuit board in half to create two smaller circuit boards (Reference Nos. 27 and 28 of Figure 2). The reduction in length of the circuit board trailing the image sensor requires the use of "tape automated bonding" (TAB) in order to connect the imager sensor to its timing and control circuitry. It is clear from a full reading of Pelchy, et al. that the type of invention disclosed is only relevant to imagers which are enhanced by the use of tape automated bonding. The tape automated bonding is used to maintain a small frontal profile and also allows supporting circuitry to be placed in the manner as shown in Pelchy, *i.e.*, two parallel circuit boards placed in <u>perpendicular</u> <u>arrangement</u> with the imaging device 20. There is no suggestion or

teaching in Pelchy, et al. that any circuitry whatsoever should be placed coplanar with the CCD imaging device 20. In fact, even if a CCD imaging device of Pelchy could be configured to accept control circuitry which is co-planar with its pixel array, such an arrangement would further teach away from the use of the CCD imaging device in an endoscope application as such a co-planar arrangement would greatly increase the profile of the imaging device making it impossible to use for introduction in the body. Accordingly, the need for a small frontal profile is exactly why the board 115 of the prior art, and boards 27 and 28 of Pelchy, et al. are placed directly behind and perpendicular to the CCD imager 20. The Laser Focus article at page 3, discloses the use of timing and control circuitry which is found co-planar with the imaging elements "To overcome the lower biasing requirements and to improve noise characteristics of passive pixels, photogates or photodiodes feature an amplifier at the end of each row or column, along with FPN correction circuitry." Substituting the imager structure of the Laser Focus article in Pelchy, et al. would defeat the sole purpose stated in Pelchy, et al. of providing tape automated bonding to connect circuitry elements. In other words, the substitution of the CMOS imaging device as disclosed in the article would expressly defeat the purpose of having tape automated bonding because certain control circuitry would be found co-planar with the pixel array and would need no special type of bonding or connecting means.

Stated in yet another way, the combination of Pelchy, et al. with the imaging device disclosed in the *Laser Focus* article would clearly violate the case law set forth above which guides how references may be combined to set forth a proper obviousness rejection. Pelchy, et al. expressly teaches away from placing any circuitry on the same plane with the imager because

9

the sole purpose of providing tape automated bonding is to allow circuitry to be remoted from the imager plane. As discussed above, CCD devices have some advantages over CMOS devices; therefore, substituting a CMOS imaging device would actually detract from the stated purposes found in Pelchy, et al.

The Examiner argues that CMOS technology in general provides certain advantages (low power consumption) and, therefore, this provides the motivation to combine the references. In harmony with Bausch & Lombe, Inc., the references must be considered as a whole, and portions arguing against or teaching away from the claimed invention must be considered. The express and clear purpose stated in Pelchy, et al. for providing tape automated bonding is defeated if a CMOS based imager is used within the structure of Pelchy, et al. In accordance with In re Ratti, the proposed modification or combination of the references changes the basic principle of operation of Pelchy, et al. That is, providing timing and control circuitry which is co-planar with the image sensor in Pelchy, et al. eliminates the need for utilizing a tape automated bonding process. Furthermore, in accordance with In re Gordon, the proposed modification to the Pelchy, et al. reference would clearly render the invention being modified unsatisfactory for its intended purpose. The incorporation of timing and control circuitry co-planar with the image sensor would completely negate the need for tape automated bonding to include the circuit boards 27 and 28 in Pelchy, et al. The Examiner's argument that minimizing power consumption provides the motivation to combine the references ignores the express teachings by both of the references as to why their combination is improper. It is well known that CMOS devices use

less power than CCD devices; however, this clearly does not provide the necessary motivation to combine the references.

Claims 1 and 6 require an array of CMOS pixels and circuitry means on said first plane and coupled to said array of CMOS pixels for timing and control of said array of CMOS pixels. As discussed above, Pelchy in combination with the *Laser Focus* article does not meet this limitation.

Independent Claims 1 and 14 have been amended to require that the video processor board handles all of the processing of the image signal so that the post-video signal is made for direct reception by a video device. Neither Pelchy or any references combined with Pelchy teach this limitation that a video processor board lying in a second plane spaced from the CMOS imager performs all the image signal processing. Pelchy clearly requires the external processor 13 (column 3, lines 10-15). Therefore, it is irrelevant whether or not Pelchy is combinable with the *Laser Focus* article because neither of these references meet this limitation. Therefore, Claims 1 and 14 should be allowed.

Claim 24 is allowable for the same reasons as set forth above with respect to Claim 1. Claim 24 requires an array of CMOS pixels and circuitry means for timing and control of the CMOS pixels to lie on a first plane. Pelchy and the *Laser Focus* article are not combinable to meet this limitation.

Claims 11-13 and 30-32 were rejected under 35 U.S.C. §103 as being unpatentable over Pelchy in view of *Laser Focus* and further in view of Danna, et al. In this rejection, the Examiner stated that Pelchy failed to disclose the parallel positioning of the circuit boards, and that Danna disclosed such a parallel arrangement. Pelchy at column 2, lines 66-67, and column 3, lines 1-5, discusses the problem being overcome by Pelchy

11

which is to shorten the length of the circuitry attached to the imager by creating two boards in perpendicular arrangement behind the imager. To rearrange the circuit boards 27 and 28 in Pelchy in a parallel arrangement with the imager 20 would expressly defeat the purpose of the Pelchy reference which is provide to a modified tape automated bonding invention. As best seen in Figure 2 of Pelchy, rearranging the boards 27 and 28 in parallel arrangement behind the imager 20 would actually greatly increase the width/profile of the imager. Also, it is clear that the tape automated bonding structure disclosed in Pelchy would be greatly modified as leads 24 and protective strips 31 would at least have to be greatly lengthened, if not having to be totally redesigned. Therefore, the use of any arrangement of parallel circuit boards with the TAB imager of Pelchy would clearly defeat the purpose of having tape automated bonding. It is also brought to the Examiner's attention that Danna also discloses a CCD-type imager which completely isolates the imager 25 from any processing circuitry. Therefore, this is further evidence that even in the construction of endoscopes designed for compact size, the idea of incorporating timing and control circuitry co-planar with an imaging element is not obvious. Claims 11 and 30 both require a circuit board to be longitudinally aligned with an array of CMOS pixels, and further that the circuit board lie in a second plane which is off-set from and substantially parallel to the first plane on which the CMOS pixels lie. This limitation is clearly not taught by a combination of any other references. Therefore, the rejection of Claims 11-13 and 30-32 should be withdrawn.

Claims 4-5 and 23 were rejected under 35 U.S.C. §103 as being unpatentable over Pelchy in view of the 6/97 *Laser Focus* article and further in view of Danna et al. Claims 4 and 5 depend directly and

12
indirectly, respectively, from Claim 1, and Claim 23 depends directly from Claim 14. For the same reasons as set forth above with respect to independent Claims 1 and 14, Claims 4-5 and 23 are allowable because each of these claims add additional limitations not overcome by the prior art of record. Therefore, the rejection for Claims 4-5 and 23 should be withdrawn.

Claims 22 and 29 were rejected under 35 U.S.C. §103 as being unpatentable over Pelchy in view of the 6/97 *Laser Focus* article and further in view of Steinberg. Claim 22 depends directly from Claim 14, and Claim 29 depends directly from Claim 24. For the same reasons as set forth above with respect to Claims 14 and 24, Claims 22 and 29 are allowable because each of these claims again add additional limitations which are not overcome by the prior art of record. Therefore, this rejection should also be withdrawn.

A sincere effort has been made to place this application in a condition for allowance; therefore, such favorable action is earnestly solicited.

Respectfully submitted,

FIELDS & JOHNSON, P.C.

Gary D. Fields () Brent P. Johnson Attorneys for Applicant 8480 East Orchard Road, Suite 5600 Englewood, CO 80111 (303) 689-9100

Date: _ 9/1/99



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| APPLICATION NO. | FILING DATE | FIRST NAMED IN | ENTOR | | ATTORNEY DOCKET NO. |
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Please find below and/or attached an Office communication concerning this application or proceeding.

Commissioner of Patents and Trademarks

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| 0/// | Application No. 09/175,685 | Applicant(s, Adair et al. |
|---|-------------------------------|---------------------------------------|
| Office Action Summary | Examiner Anand R | Group Art Unit 2713 |
| Responsive to communication(s) filed on <u>Sep 1, 1</u> | 999 | |
| This action is FINAL. | | |
| Since this application is in condition for allowance e in accordance with the practice under Ex parte Qu | | |
| A shortened statutory period for response to this action longer, from the mailing date of this communication. F application to become abandoned. (35 U.S.C. § 133). 37 CFR 1.136(a). | ailure to respond within th | ne period for response will cause the |
| Disposition of Claim | | |
| X Claim(s) <u>1-8 and 11-32</u> | | is/are pending in the applica |
| Of the above, claim(s) | | is/are withdrawn from considerat |
| X Claim(s) <u>14-29</u> | | |
| X Claim(s) <u>1-8, 11-13, and 30-32</u> | | is/are rejected. |
| Claim(s) | | |
| Claims | | |
| The drawing(s) filed on The proposed drawing correction, filed on The specification is objected to by the Examiner. The oath or declaration is objected to by the Examiner. The oath or declaration is objected to by the Examiner. The oath or declaration is objected to by the Examiner. The oath or declaration is objected to by the Examiner. The oath or declaration is objected to by the Examiner. The oath or declaration is objected to by the Examiner. The oath or declaration is objected to by the Examiner. The oath or declaration is objected to by the Examiner. The oath or declaration is objected to by the Examiner. The oath or declaration is objected to by the Examiner. Priority under 35 U.S.C. § 119 Acknowledgement is made of a claim for foreign All Some* None of the CERTIFIED of received. received in Application No. (Series Code/S is received in this national stage application for the Certified conies not received: | is is in international Bure | approveddisapproved. |
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Art Unit: 2713

DETAILED ACTION

Response to Amendment

1. Applicant's arguments with respect to claims 1-8, 11-13 and 30-32 as put forth in

Paper 12 on 9/1/99 have been considered but are moot in view of the new ground(s) of rejection.

Claim Rejections - 35 USC § 103

2. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

(a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.

3. Claims 1-8, 11-13, and 30-32 are rejected under 35 U.S.C. 103(a) as being unpatentable over Lenhardt et al., (hereinafter referred to as "Lenhardt") in view of the 6/97 Laser Focus article entitled "Imaging options expand with CMOS technology" (hereinafter referred to as "Laser Focus").

Lenhardt discloses a reduced area imaging device (Lenhardt: figure 2), comprising : an image sensor lying in a first plane and including an array of pixels for receiving images thereon, said image sensor producing a pre-video signal; (Lenhardt: column 6, lines 39-45), a pre-video conductor for transmitting said pre-video signal from said first circuit board to a second circuit board (Lenhardt: column 6, lines 45-50); a first circuit board lying in second plane and longitudinally aligned with said image sensor, said first circuit board being connected to said pre-

Serial Number: 09/175,685

Art Unit: 2713

video conductor at said second end thereof, said first circuit board including circuitry means for converting said pre-video signal to a post-video signal for reception by a stand video device signal for direct reception by a standard video device (Lenhardt: column 6, lines 27-35); and a power supply device coupled with said image sensor for driving said array of pixels, and electrically coupled to said first circuit board for driving said circuit board (Lenhardt: column 4, lines 17-25). as specified in claim 1. However, Lenhardt fails to disclose the that the image sensor further includes timing and control circuitry means on said first plane and coupled to said pixel array such as a CMOS imager (Lenhardt: column 6, lines 39-57). The Laser Focus article discloses that the use of a passive CMOS image sensor timing and control circuitry at each CMOS pixel (Laser Focus: third page, right most column, lines 32-60) is preferable to using a CCD because the standard CCD imagers as contained by the original Lenhardt apparatus waste more power (Laser Focus: second page, leftmost column, lines 35-50). Accordingly, given the Laser Focus article's teaching of advantageously using a passive CMOS image sensor, it would have been obvious for one of ordinary skill in the art to modify the Lenhardt apparatus by incorporating the Laser Focus article's disclosed passive CMOS imager for the standard Lenhardt imager (Lenhardt: figure 2, element 20) in order to minimize power consumption. The Lenhardt apparatus, as modified with the inclusion of the Laser Focus's passive CMOS imager which has timing and control circuitry at each pixel site, has all of the features of claim 1.

Regarding claim 2, the Lenhardt apparatus, as modified with the inclusion of the Laser Focus's passive CMOS imager which has timing and control circuitry at each pixel site, would

Serial Number: 09/175,685

Art Unit: 2713

have the image sensor defining a profile area (Lenhardt: figure 2, element 4), and said first circuit board being positioned not to extend beyond said profile area (Lenhardt: column 5, lines 10-23), as specified.

Regarding claim 3, the Lenhardt apparatus, as modified with the inclusion of the Laser Eocus's passive CMOS imager which has timing and control circuitry at each pixel site, has a second circuit board electronically coupled with said first circuit board and said image sensor for enhancing said pre-video signal as specified, and second circuit board being longitudinally aligned with said first circuit board and said image sensor so as to not extend substantially beyond said profile area (Lenhardt: column 6, lines 45-57), as specified.

Lenhardt discloses a reduced area imaging device (Lenhardt: figure 4), comprising : an image sensor lying in a first plane and including an array of pixels for receiving images thereon, said image sensor producing a pre-video signal; (Lenhardt: column 6, lines 39-41) a pre-video conductor for transmitting said pre-video signal from said first circuit board to a second circuit board (Lenhardt: column 6, lines 45-50); a control box remote from said image sensor, said control box including circuitry means for receiving said pre-video signal from the image sensor as specified (Lenhardt: column 6, lines 30-32); and a power supply device coupled with said image sensor for driving said array of pixels, and electrically coupled to said first circuit board for driving said circuit board (Lenhardt: column 6, lines 38-42), as specified in claim 6. However, Lenhardt fails to disclose the that the image sensor further includes timing and control circuitry means on said first plane and coupled to said pixel array such as a CMOS imager (Lenhardt: column 3, lines 45-50), even though the reference recognizes that the use of a TAB imager could be also apply CMOS based imager (Lenhardt: column 1, lines 7-10). The Laser Focus article discloses that the use of a passive CMOS image sensor timing and control circuitry at each CMOS pixel (Laser Focus: third page, right most column, lines 32-60) is preferable to using a CCD because the standard CCD imagers as contained by the original Lenhardt endoscope waste more power (Laser Focus: second page, leftmost column, lines 35-50). Accordingly, given the Laser Focus article's teaching of advantageously using a passive CMOS image sensor, it would have been obvious for one of ordinary skill in the art to modify the Lenhardt apparatus by incorporating the Laser Focus article's disclosed passive CMOS imager for the standard Lenhardt imager (Lenhardt: figure 2, element 20) in order to minimize power consumption. The Lenhardt apparatus, as modified with the inclusion of the Laser Focus's passive CMOS imager which has timing and control circuitry at each pixel site, has all of the features of claim 6.

Regarding claim 7, the Lenhardt apparatus, as modified with the inclusion of the <u>Laser</u> <u>Focus</u>'s passive CMOS imager which has timing and control circuitry at each pixel site, has a supplementary circuit board electronically coupled with said first circuit board and said image sensor for enhancing said pre-video signal as specified (Lenhardt: figure 2, elements 21), as specified.

Regarding claim 8, the Lenhardt apparatus, as modified with the inclusion of the Laser Focus's passive CMOS imager which has timing and control circuitry at each pixel site, has an

Serial Number: 09/175,685

Art Unit: 2713

array of passive CMOS pixels which includes a photo diode and access transistor pair (Laser Focus: page 3, rightmost column, lines 28-38), as specified.

Regarding claim 9, the Lenhardt apparatus, as modified with the inclusion of the <u>Laser</u> <u>Focus</u>'s passive CMOS imager which has timing and control circuitry at each pixel site, has an array of passive CMOS pixels which includes a photo diode and access transistor pair (<u>Laser</u> <u>Focus</u>: page 3, rightmost column, lines 28-38), as specified.

Regarding claim 10, the Lenhardt apparatus, as modified with the inclusion of the <u>Laser</u> <u>Focus</u>'s active CMOS imager which has timing and control circuitry at each pixel site, has an amplifier for each individual pixel (<u>Laser Focus</u>: page 2, rightmost column, lines 4-9), as in the claim.

Lenhardt discloses a reduced area imaging device (Lenhardt: figure 4), comprising : an image sensor lying in a first plane and including an array of pixels for receiving images thereon (Lenhardt: column 5, lines 10-20); a circuit board longitudinally aligned with and lying in a second plane and electrically coupled to with said image sensor, said first circuit board including circuitry means for converting said pre-video signal to a post-video signal for direct reception by a stand video device signal for reception by a standard video device (Lenhardt: column 6, lines 27-35); and a power supply device coupled with said image sensor for driving said array of pixels, and electrically coupled to said first circuit board for driving said circuit board (Lenhardt: column 6, lines 38-47), and that the image sensor is parallel to the first circuit board (Lenhardt: column 6, lines 49-51)as specified in claim 11. However, Lenhardt fails to disclose the that the image sensor

Samsung Exhibit 1003 Page 152 of 208

Serial Number: 09/175,685

Art Unit: 2713

further includes timing and control circuitry means on said first plane and coupled to said pixel array such as a CMOS imager (Lenhardt: column 3, lines 45-50), even though the reference recognizes that the use of a TAB imager could be also apply CMOS based imager (Lenhardt: column 1, lines 7-10). The Laser Focus article discloses that the use of a passive CMOS image sensor timing and control circuitry at each CMOS pixel (Laser Focus: third page, right most column, lines 32-60) is preferable to using a CCD because the standard CCD imagers as contained by the original Lenhardt endoscope waste more power (Laser Focus: second page, leftmost column, lines 35-50). Accordingly, given the Laser Focus article's teaching of advantageously using a passive CMOS image sensor, it would have been obvious for one of ordinary skill in the art to modify the Lenhardt apparatus by incorporating the Laser Focus article's disclosed passive CMOS imager for the standard Lenhardt imager (Lenhardt: figure 2, element 20) in order to minimize power consumption. The Lenhardt apparatus, as modified with the inclusion of the Laser Focus's passive CMOS imager which has timing and control circuitry at each pixel site, has all of the features of the features of claim 11.

Regarding claim 12, the Lenhardt-Laser-Focus apparatus, has an array of passive CMOS pixels which includes a photo diode and access transistor pair (Laser Focus: third page, rightmost column, lines 28-38), as specified.

Regarding claim 13, the Lenhardt-Laser-Focus apparatus has a supplementary circuit board electronically coupled with said first circuit board and said image sensor for enhancing said pre-video signal as specified (Lenhardt: column 6, lines 45-57; column 7, lines 1-3), as specified.

Samsung Exhibit 1003 Page 153 of 208

Lenhardt discloses a reduced area imaging device (Lenhardt: figure 4), comprising: an image sensor lying in a first plane and including an array of pixels for receiving images thereon (Lenhardt: column 5, lines 10-20); a circuit board longitudinally aligned with and second plane and electrically coupled to with said image sensor, said first circuit board including circuitry means for converting said pre-video signal to a post-video signal for reception by a stand video device signal for reception by a standard video device (Lenhardt: figure 2, element 21); a control box remote from said image sensor, said control box including circuitry means for receiving said pre-video signal from the image sensor as specified (Lenhardt: column 6, lines 25-35); and a power supply device coupled with said image sensor for driving said array of pixels, and . electrically coupled to said first circuit board for driving said circuit board (Lenhardt: column 6, lines 39-41) and that the circuit board is substantially parallel to the image sensor plane (Lenhardt: column 6, lines 45-57), as specified in claim 30. However, Lenhardt fails to disclose the that the image sensor is a CMOS image and further includes timing and control circuitry means thereon, even though the reference recognizes that the use of a TAB imager could be also apply CMOS based imager (Lenhardt: column 1, lines 7-10). The Laser Focus article discloses that the use of a active CMOS image sensor timing and control circuitry at each CMOS pixel (Laser Focus: second page, rightmost column, lines 4-8) is preferable to using a CCD because the standard CCD imagers as contained by the original Lenhardt endoscope waste more power (Laser Focus: second page, leftmost column, lines 35-50). Accordingly, given the Laser Focus article's teaching of advantageously using a active CMOS image sensor, it would have been obvious for one of

Samsung Exhibit 1003 Page 154 of 208

Serial Number: 09/175,685

Art Unit: 2713

ordinary skill in the art to modify the Lenhardt apparatus by incorporating the Laser Focus article's disclosed active CMOS imager for the standard Lenhardt imager (Lenhardt: figure 2, element 20) in order to minimize power consumption. The Lenhardt apparatus, as modified with the inclusion of the Laser Focus's active CMOS imager which has timing and control circuitry at each pixel site, has all of the features of claim 30.

Regarding claim 31, the Lenhardt-Laser-Focus apparatus, has an array of passive CMOS pixels which includes a photo diode and access transistor pair (Laser Focus: third page, rightmost column, lines 28-38), as specified.

Regarding claim 32, Lenhardt-Laser-Focus apparatus, has an amplifier for each individual pixel (Laser Focus: second page, rightmost column, lines 4-9), as in the claim.

Allowable Subject Matter

Claims 14-29 are allowed.

Independent claims 14 and 24 are allowed because these claims recite the arrangement of the use of an endoscope with the CMOS pixels array with resident timing and control circuitry, and the second longitudinally aligned video processing board as in the claims. Dependent claims 15-23, and 25-29 are allowed for the reasons as indicated for the independent claims. Accordingly, if rejected claims 1-13 and 30-32 are canceled, the application would be placed in a condition for allowance.

Samsung Exhibit 1003 Page 155 of 208 Serial Number: 09/175,685

Art Unit: 2713

Conclusion

5. Any inquiry concerning this communication or earlier communications from the examiner should be directed to Anand S. Rao whose telephone number is (703)-305-4813.

asr

ANDY RAO PRIMARY EXAMINER

October 19, 1999

Samsung Exhibit 1003 Page 156 of 208

| | Nation of Data | | Application No. 09/175,685 | Applicant(s) | Adair e | t al. | |
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| 1 | Notice of References Cited | | Examiner Group Art U | | | T | Page 1 of 1 |
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| | | U | S. PATENT DOCUMENTS | | | | _ |
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| A | 5,453,785 | 9/26/95 | Lenhard | t et al. | | 348 | 357 |
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U. S. Patent and Trademark Office PTO-892 (Rev. 9-95)

Notice of References Cited

NOV-08-99 MON 10:24 AM FIELDS & JOHNSON, P.C. FAX NO. 3036899250

FIELDS & JOHNSON OF FICIAL FAX RECEIVED NOV

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ATTORNEYS AT LAW PATENTS - TRADEMARKS - COPYRIGHTS - LITIGATION Group 2700

ORCHARD POINTE 8480 EAST ORCHARD ROAD, SUITE 5600 ENGLEWOOD, COLORADO 80111-5028

TELEPHONE: (303) 689-9100 - FACSIMILE: (303) 689-9250 - e-mail: firm@fj-patentlaw.com

GARY D. FIELDS BRENT P. JOHNSON

FACSIMILE COVER SHEET

| DATE: | November 8, 1999 |
|-------------|---|
| TO: | Examiner Anand S. Rao (Andy) |
| ENTITY: | U.S. Patent and Trademark Office, Art Unit 2713 |
| FAX NO .: _ | 705-308-5359 |
| FROM: | Brent P. Johnson |
| SUBJECT : | Amendment to U.S Continuation-in-Part Patent Application Serial No. |
| SOBDECT | 09/175,685 Entitled "Reduced Area Imaging Devices" to Edwin L. Adair, et al. filed 10/20/98; Docket No. F97.13 CIP 2 |
| | 11 |

NO. OF PAGES (including cover page): 11

REMARKS

See enclosed Amendment

The original of the transmitted document(s) will be sent: xx By Fax Only First Class Mail Overnight

CONFIDENTIAL COMMUNICATION

The information contained in or attached to this FAX message is intended only for the confidential use of the individual (s) named above. If you are not the named recipient or an agent responsible for delivering it to the named recipient, you are hereby notified that you have received this document in error and that review, dissemination or copying of this communication is prohibited. If you have received this communication in error, please notify us immediately by telephone and return the attached documents to us by mail. THANK YOU.

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NOV 8 1999

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE OUD 2700

| | the Continuation in Part |) AMENDMENT #14 E |
|--------|--|---|
| Applie | cation of |) Examiner: A. Rao 11-8-29 |
| | n L. Adair, Jeffrey L. Adair, dall S. Adair |) Art Unit: 2713 |
| Serial | No.: 09/175,685 |) VIA FACSIMILE TRANSMISSION) 703-308-5359 |
| Filed | October 20, 1998 |) CERTIFICATE OF FACSIMILE TRANSMISS. |
| For: | "Reduced Area Imaging Devices" |) I hereby certify that this paper for reg./ser. no.) <u>09/175,685</u> is being faceimile transmitted to the Patent and Trademark Office fax number <u>103 308 5359</u> on the date shown below. |
| | tant Commissioner for Pate ington, D.C. 20231 | |
| Dim | | Superiure & Houselules 11/8/99 |

Sir:

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This amendment is responsive to the Office Action dated October 19, 1999 which was faxed to the applicant on November 3, 1999, the above-identified application being amended as follows:

IN THE CLAIMS:

Amend Claim 1 as follows:

I. (Twice amended) A reduced area imaging device comprising:

an imager sensor lying in a first plane and including an array of CMOS pixels for receiving images thereon, said image sensor further including circuitry means on said first plane and coupled to said array of CMOS pixels for timing and control of said array of CMOS pixels, said image sensor producing a pre-video signal;

a pre-video conductor for transmitting said pre-video signal, said pre-video conductor having first and second ends, said first end communicating with said image sensor;

> Samsung Exhibit 1003 Page 159 of 208

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a first circuit board lying in a second plane and longitudinally aligned with said image sensor, said first circuit board being connected to said pre-video conductor at said second end thereof, said first circuit board including circuitry means for converting said pre-video signal to a postvideo signal for direct reception by a standard video device; [and]

a power supply electrically coupled with said image sensor for driving said array of pixels and said timing and control means, and electrically coupled to said first circuit board for driving said circuit board[.] : and

a non-removable lens integral with said imaging device for focusing images on said image sensor.

Amend Claim 6 as follows:

(Twice amended) A reduced area imaging device comprising:

an image sensor lying in a first plane and including an array of CMOS pixels for receiving images thereon, said image sensor further including circuitry means on said first plane and coupled to said array of CMOS pixels for timing and control of said array of CMOS pixels, said image sensor producing a pre-video signal;

a control box remote from said image sensor, said control box including circuitry means for receiving said pre-video signal from said image sensor, and for converting said pre-video signal to a post-video signal which may be received by a standard video device; [and] a power supply coupled to said control box and said image sensor for providing power thereto[.] : and

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a non-removable lens integral with said imaging device for focusing images on said image sensor.

Amend Claim 11 as follows:

9. N. (Twice amended) A reduced area imaging device comprising:

an array of CMOS pixels defining a profile area and lying in a first plane, said array of CMOS pixels for receiving images thereon;

a circuit board longitudinally aligned with and electrically coupled to said array of CMOS pixels, said circuit board lying in a second plane which is offset from said first plane and substantially parallel to said first plane, said circuit board including circuitry means for timing and control of said array of CMOS pixels, said timing and control means producing a pre-video signal, said circuit board further including circuitry means for receiving said pre-video signal from said timing and control means and converting said pre-video signal to a post-video output signal for direct reception by a video device; [and]

a power supply electrically coupled to said array of said

15 CMOS pixels and said circuit board[.] : and

a non-removable lens integral with said imaging device for focusing images on said image sensor.

Amend Claim 30 as follows:

 30. (Amended) A reduced area imaging device comprising: an array of CMOS pixels defining a profile area and lying in a first plane, said array of said CMOS pixels for receiving images thereon;

Samsung Exhibit 1003 Page 161 of 208

a circuit board longitudinally aligned with and electrically

5 coupled to said array of CMOS pixels, said circuit board lying in a second plane which is offset from said first plane and substantially parallel to said first plane, said circuit board including timing and control means for controlling the release of information from said array of CMOS pixels, said timing and control means producing a pre-video signal;

a control box remote from said array of said CMOS pixels and said circuit board, said control box including circuitry means for receiving said pre-video signal, and for converting said pre-video signal to a post-video signal which may be received by a standard video device; [and]

a power supply coupled to said control box, said array of CMOS pixels and said timing and control means for providing power. thereto[.]: and

a non-removable lens integral with said imaging device for focusing images on said array of CMOS pixels.

REMARKS

Pursuant to the telephonic interview with the Examiner on November 4, 1999, the applicant has amended each of the remaining independent claims, namely, Claims 1, 6, 11 and 30, in order to overcome the newly cited reference to Lenhardt, U.S. Patent No. 5,453, 785. Each of the independent claims has been amended to require a non-removable lens which is integral with the imaging device. This limitation finds clear antecedent support in the specification at page 12, lines 12-17. The term "non-removable" as used in the claims shall mean that the lens does not incorporate the use of any connection means which allows the lens to be

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readily and normally removed. It should also be understood that the term "non-removable lens" as now found in Claims 1, 6, 11 and 30 does not mean that the lens may not be manipulated for axial adjustment for focusing. Thus, the term "non-removable" means that there is a continual attachment of the lens to the imaging device, albeit that the attachment could be made in such a manner that the lens could be moved with respect to the imaging sensor.

In Lenhardt, the invention disclosed therein requires that the lens system be physically removed from the rest of the measurement camera. Column 5, lines 5-10, explain that a bayonet connection comprised of a bayonet flange 10 on the front side of the measuring head 3 (Figure 3) and a retaining ring of 13 on the connecting side of the objective 1 (Figure 4) are utilized to enable replacement of the objective 1. Column 6, lines 56end, explain that different objectives 1 can be used which can be matched to the respective measuring goal and respectively substituted for one another depending upon the measuring results actually to be accomplished. In other words, in order to achieve the different measuring goals, the objective 1, which contains the plurality of lenses, must be removable. Accordingly, each of the remaining independent claims now clearly distinguishes over the teachings in Lenhardt.

It is brought to the Examiner's attention that a Second Supplementary Preliminary Amendment was filed in connection with this application on July 29, 1999. Enclosed herewith is this Amendment which includes amendments to Claim 24 and the addition of dependent Claims 33 and 34. The instant Office Action did not indicate the presence of new Claims 33 and 34.

Sai

Also enclosed is a copy of the return postcard indicating receipt by the Patent Office on August 4, 1999. Claims 33 and 34 depend from Claim 24, and simply add other limitations which are not disclosed by the prior art references of record. Therefore, it is respectfully requested that the Examiner also indicate the existence of Claims 33 and 34.

Applicant gratefully acknowledges the allowability of Claims 14-29.

A sincere effort has been made to place this application in a condition for allowance; therefore, such favorable action is earnestly solicited.

Respectfully submitted,

FIELDS & JOHNSON, P.C.

Gary D. Fields Brent P. Johnson Attorneys for Applicant 8480 East Orchard Road Englewood, CO 80111

Date: U/R/Rg

NOV-08-99 MON 10:28 AM FIELDS & JOHNSON, P.C.

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| IN THE UNITED STATES I | PATENT AND TRADEMARK OFF | TCEGroup 2700 |
| In Re the Continuation in Part Application of |) <u>SECOND SUPPLEMENTAL</u>) <u>PRELIMINARY</u>) <u>AMENDMENT</u> | Rose 11-8-99 |
| Edwin L. Adair, Jeffrey L. Adai | r,) | |
| Randall S. Adair |) Examiner: A. Rao) | |
| Serial No.: 09/175,685 |) Art Unit: 2713 | 200 |
| Filed: October 20, 1998 |) I hereby carely that this correspondent deposited with the United States Postal first class mail in an envelope add | rassad to: |
| For: "Reduced Area Imaging Devices" |) Assistant Commissioner 7/29/4 D.C. 20231. on 7/29/4 Date of Dense Date of Dense | 9 mealures |
| Assistant Commissioner for Pat | ents Marne of epphoant, ascignos, or Regia | Blag rist. |
| Washington, D.C. 20231 | | |
| | | |

Sir:

Please amend the above-identified application as follows:

IN THE CLAIMS:

22. 24. (Amended) An endoscope comprising:

a tubular portion including a central passageway extending therethrough, a proximal end and a distal end;

a CMOS image sensor positioned at said distal end of said tubular portion for receiving images of a surgical site, said CMOS imager defined by an array of CMOS pixels <u>and</u> [wherein individual pixels within said array of said CMOS pixels each include an amplifier], said CMOS imager lying in a first plane;

circuitry means for timing and control of said CMOS image sensor placed adjacent to said CMOS image sensor on said first plane; a control box remote from said tubular portion and coupled to

said CMOS image sensor, said control box including circuitry means for receiving a pre-video signal from said CMOS image sensor, and for

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Samsung Exhibit 1003 Page 165 of 208

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converting said pre-video signal to a post-video signal which may be received by a standard video device; and a power supply coupled to said control box and said CMOS

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image sensor for providing power thereto.

Add the following new claims:

31. 33. An endoscope, as claimed in claim 24, wherein:

individual pixels within said array of CMOS pixels each include an amplifier.

32. 22.
34. An endoscope, as claimed in claim 24, wherein: said array of CMOS pixels includes a plurality of passive
CMOS pixels, and wherein individual passive CMOS pixels of said
plurality of passive CMOS pixels each include a photo diode for producing
photo electrically generated signals, and an access transistor
communicating with said photo diode to control the release of said photo
electrically generated signals.

REMARKS

By the foregoing, Claim 24 has been amended, and new Claims 33 and 34 have been added. As a review of the claims in this application, Claims 1-7 were filed originally with the application, Claims 8-29 were added in the Preliminary Amendment filed on March 8, 1999, and Claims 30-32 were added in a first Supplementary Preliminary Amendment filed on March 24, 1999. Enclosed herewith is a check in the amount of \$18.00

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to cover the additional fees for new Claims 33 and 34. Any shortfall may be charged to Deposit Account No. 06-0778.

Respectfully submitted,

FIELDS & JOHNSON, P.C.

Gary D. Fields Brent P. Johnson 8480 East Orchard Road, Suite 5600 Englewood, CO 80111 (303) 689-9100

Date: 7/29/99

NOV-08-99 MON 10:30 AM FIELDS & JOHNSON, P. C. FAX NO. °036899250 P. 11 July 29, 1999 RE: U.S. Continuation-in-Part Patent Application Serial No. 09/175,685 Entitled "Reduced Area Imaging ces" to Edwin L. Adair, et al.; Docket No. F97, 18 CT 22 Enclosed herewith for filing: Second Supplemental Preliminary Amendment (x) Transmittal Form. (x) (x) Fee Transmittal Form (1.original & 1 cop) (x) Check for \$18.00 Return postcard Patent Application Fee Determination Record (x) (x) W/ ED /klg 0 9 1999 AUG 8.16

Samsung Exhibit 1003 Page 168 of 208



UNITED STA. 3 DEPARTMENT OF COMMERCE Patent and Trademark Office

Address: COMMISSIONER OF PATENTS AND TRADEMARKS Washington, D.C. 20231

| APPLICATION NO. | FILING DATE | FIRST NAMED I | WENTOR | 1 | TTORNEY DOCKET NO. |
|------------------------------|--------------------------------------|---------------|--------|--------------|--------------------|
| 09/175,685 | 10/20/98 | ADAIR | | E F | 97.13-CIF2 |
| - | | LM61/1122 | - | 6 | EXAMINER |
| BRENT P JOHN FIELDS & JOH | | | | RAD, A | |
| SUITE 5600 | | | | ART UNIT | PAPER NUMBER |
| 8480 EAST OF ENGLEWOOD CO | a service of contrast and service as | | | 2713 | |
| | | | | DATE MAILED: | 11/22/99 |

Please find below and/or attached an Office communication concerning this application or proceeding.

Commissioner of Patents and Trademarks

| | Application No. 09/175,685 | Applic_a(s) | Adair et | al. |
|---|---------------------------------|---------------|---------------------------------|---------------------------------|
| Notice of Allowability | Examiner Anand R | ao | Group Art Unit 2713 | |
| All claims being allowable, PROSECUTION ON THE M herewith (or previously mailed), a Notice of Allowance in due course. | | | | |
| X This communication is responsive to the Amenda | nents filed on 11/8/99 as P | apers 13 and | 14 | |
| X) The allowed claim(s) is/are _1-8, 11-34 (respectfull | y renumbered as claims 1- | 32) | | |
| X The drawings filed onOct 20, 1998a | re acceptable. | | | |
| Acknowledgement is made of a claim for foreign pr | | 0/21/01 | | |
| All Some* None of the CERTIFIED cop received. | 이 같은 것에서 이 것 같은 것이 하는 것이 같이 없다. | | 1 | |
| received in Application No. (Series Code/Ser | rial Number) | | | |
| received in this national stage application from the stage application f | m the International Bureau | (PCT Rule 1 | 7.2(a)) | |
| *Certified copies not received. | | | | |
| Acknowledgement is made of a claim for domestic | priority under 35 U.S.C. § | 119(e). | | |
| A SHORTENED STATUTORY PERIOD FOR RESPON THREE MONTHSROM THE "DATE MAILED" of this Off ABANDONMENT of this application. Extensions of tim | fice action Failure to time | v comply will | rocult in | |
| Note the attached EXAMINER'S AMENDMENT or N the oath or declaration is deficient. A SUBSTITUTE | | PLICATION | DTO 152 whie | |
| Applicant MUST submit NEW FORMAL DRAWINGS | 3 | | | |
| because the originally filed drawings were declar | red by applicant to be infor | mal | | |
| Including changes required by the Notice of Draft Paper No. | tsperson's Patent Drawing | Review, PTO | | |
| including changes required by the proposed draw approved by the examiner. | | | , wh | ch has been |
| including changes required by the attached Example | niner's Amendment/Comme | ent | | |
| Identifying Indicia such as the application numbe the drawings. The drawings should be filed as a Draftsperson. | | | en on the reve ter addressed | erse side of to the Official |
| Note the attached Examiner's comment regarding RE | EQUIREMENT FOR THE D | EPOSIT OF F | | ATEDIAL |
| Any response to this letter should include, in the upper ri CODE/SERIAL NUMBER). If applicant has received a Ne and DATE of the NOTICE OF ALLOWANCE should also | ight hand corner, the APPL | | | |
| Attachment(s) | be moladed, | | | |
| Notice of References Cited, PTO-892 | | | | |
| Information Disclosure Statement(s), PTO-1449, P | aper No(s). | 622 | | d. 1. 10 |
| □ Notice of Draftsperson's Patent Drawing Review, F | PTO-948 | | | 1.1 |
| Notice of Informal Patent Application, PTO-152 | | 63 | ANDY RAO | |
| Interview Summary, PTO-413 | | PR | IMARY EXAN | INER |
| Examiner's Amendment/Comment | | / | A. | SAL. |
| Examiner's Comment Regarding Requirement for [| Deposit of Biological Mater | ial // | | |
| X Examiner's Statement of Reasons for Allowance | | | | |

otice of Allowability

Part Sangsung, Exhibit 1003 Page 170 of 208 Art Unit: 2713

Allowable Subject Matter

Claims 1-8, 11-34 are allowed.

Independent claims 14 and 24 are allowed because these claims recite the arrangement of the use of an endoscope with the CMOS pixels array with resident timing and control circuitry, and the second longitudinally aligned video processing board as in the claims. Dependent claims 15-23, 25-29, and 33-34 are allowed for the reasons as indicated for the independent claims. Independent claims 1, 6, 11, and 30 are allowed because these claims recite the arrangement of the use of a reduced area image device with the CMOS pixels array with resident timing and control circuitry, and the second longitudinally aligned video processing board, and further stipulate a non-removable lens integral with said imaging device, as in the claims. Dependent claims 2-8, 12-13, 31-32 are allowed for the reasons concerning claims 1, 6, 11, and 30.

Conclusion

 Any inquiry concerning this communication or earlier communications from the examiner should be directed to Anand S. Rao whose telephone number is (703)-305-4813.

> ANDY RAO PRIMARY EXAMINER

asr October 19, 1999

Samsung Exhibit 1003 Page 171 of 208



UNITED STATE DEPARTMENT OF COMMERCE Patent and Trademark Office

NOTICE OF ALLOWANCE AND ISSUE FEE DUE

LM61/1122

BRENT P JOHNSON FIELDS & JOHNSON SUITE 5600 8480 EAST ORCHARD ROAD ENGLEWOOD CO 80111

| APPLICATION NO. | FILING DATE | TOTAL CLAIMS | EXAMINER AND GROUP ART UNIT | 1.1.1 | DATE MAILED |
|---------------------------------|-------------|--------------|-----------------------------|---------|-------------|
| 09/175.685 | 10/20/98 | 032 | RAO, A | 2713 | 11/22/9 |
| First Named ADAIR, Applicant | | 35 1 | JSC 154(b) term ext. * | Ø Davs. | |
| LEOF REDUCED AREA | IMAGING DE | VICES | | | |

| ATTY | S DOCKET NO. | CLASS- | SUBCLASS | BATCH NO. | APP | PLN. TYPE | SMALL ENTITY | FEE DUE | DATE DUE |
|------|--------------|--------|----------|-----------|-----|-----------|--------------|----------|----------|
| 2 | F97.13-C | IP2 | 348-0 | 76.000 | Z99 | UTILIT | Y YES | \$505.00 | 02/22/08 |

THE APPLICATION IDENTIFIED ABOVE HAS BEEN EXAMINED AND IS ALLOWED FOR ISSUANCE AS A PATENT. PROSECUTION ON THE MERITS IS CLOSED.

THE ISSUE FEE MUST BE PAID WITHIN THREE MONTHS FROM THE MAILING DATE OF THIS NOTICE OR THIS APPLICATION SHALL BE REGARDED AS ABANDONED. THIS STATUTORY PERIOD CANNOT BE EXTENDED.

HOW TO RESPOND TO THIS NOTICE:

- I. Review the SMALL ENTITY status shown above. If the SMALL ENTITY is shown as YES, verify your current SMALL ENTITY status:
 - A. If the status is changed, pay twice the amount of the FEE DUE shown above and notify the Patent and Trademark Office of the change in status, or
- If the SMALL ENTITY is shown as NO:
- A. Pay FEE DUE shown above, or
- B. If the status is the same, pay the FEE DUE shown above.
- B. File verified statement of Small Entity Status before, or with, payment of 1/2 the FEE DUE shown above.
- II. Part B-Issue Fee Transmittal should be completed and returned to the Patent and Trademark Office (PTO) with your ISSUE FEE. Even if the ISSUE FEE has already been paid by charge to deposit account, Part B Issue Fee Transmittal should be completed and returned. If you are charging the ISSUE FEE to your deposit account, section "4b" of Part B-Issue Fee Transmittal should be completed and an extra copy of the form should be submitted.
- III. All communications regarding this application must give application number and batch number. Please direct all communications prior to issuance to Box ISSUE FEE unless advised to the contrary.

IMPORTANT REMINDER: Utility patents issuing on applications filed on or after Dec. 12, 1980 may require payment of maintenance fees. It is patentee's responsibility to ensure timely payment of maintenance fees when due.

PATENT AND TRADEMARK OFFICE COPY PTOL-85 (REV. 10-96) Approved for use through 06/30/99. (0651-0033)

Samsung Exhibit 1003 U.S. Page: 172:06:208

| After Allowance Communication of Appeal Communication to Board of Appeal Communication to Board of Appeal Sommunication to Group Appeal Communication to Group Appeal Communication to Group Proprietary Information |
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| Status Letter Additional Enclosure(s) (please identify below): |
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Samsung Exhibit 1003 Page 173 of 208

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

DEC 1 8 1999

In Re the Continuation-in-Part Application of

Edwin L. Adair, Jeffrey L. Adair, Randall S. Adair

Serial No.: 09/175,685

Filed: October 20, 1998

For: "Reduced Area Imaging Devices")

BOX ISSUE FEE - AMENDMENTS c/ o Technology Center 2700 U.S. Patent and Trademark Office Washington, D.C. 20231 AMENDMENT UNDER 37 C.F.R. §312

Examiner: A. Rao

Art Unit: 2713

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JAN 4 7000

Publishing Division 03

Sir:

Please amend the above-identified application as follows:

IN THE CLAIMS:

Amend Claim 28 as follows:

28. (Twice Amended) An endoscope, as claimed in claim 24,

further including:

a lens positioned at said distal end of said tubular portion [of sensor].

REMARKS

Claim 28 has been amended from the previously filed Amendment dated September 1, 1999 to correct a typographical error found therein. Since this Amendment does not affect the scope of the claims or require an additional search by the Patent Examiner, it is earnestly requested that this Amendment be entered.

Respectfully submitted,

FIELDS & JOHNSON, P.C.

Gary D. Fields Brent P. Johnson 8480 East Orchard Road, Suite 5600 Englewood, CO 80111-5028 (303) 689-9100

Date: 12/16/99

| Please type a plus sign (+) Under the Paperwo valid OMB control | rk Reduction Act of 1995, no pers | EXPRESS MAIL NO. Approved for un Patent and Trademark Offic sons are required to respond to a co | PTO/SB/21 (6-98) se through 09/30/2000. OMB 0651-0031 e: U.S. DEPARTMENT OF COMMERCE Allection of information unless it displays a |
|---|---|---|--|
| ~ | | Application Number | 09/175,685 |
| TRANS | SMITTAL | Filing Date | October 20, 1998 |
| | DRM | First Named Inventor | Edwin L. Adair, et al. |
| | spondence after initial filing) | Group Art Unit | 2713 |
| | | Examiner Name | A. Rao |
| Total Number of Page | s In This Submission 2 | Attorney Docket Number | er F97.13 CIP2 |
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| I hereby certify that this envelope addressed to: | correspondence is being dep Assistant Commissioner for | posited with the United States Patents, Washington, D.C. 202 | Postal Service as first oness mail in an 231 on this date: 12/16/99 |
| Typed or printed name | Katherine L. Gon | | |
| Signature | Radierine L. X | fonfalles Date | 12/16/99 |

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE



| In Re the Continuation-in-Part Application of | <u>COMMENTS ON STATEMENT</u> <u>OF REASONS FOR</u> <u>ALLOWANCE</u> |
|---|---|
| Edwin L. Adair, Jeffrey L. Adair, Randall S. Adair |)) Examiner: A. Rao)) Art Unit: 2713 |
| Serial No.: 09/175,685 |) RECEIVED |
| Filed: October 20, 1998 |) 1900 4 2000 م |
| For: "Reduced Area Imaging Devices" |) Publishing Division) 03 |

BOX ISSUE FEE - Post Allowance Correspondence c/o Technology Center 2700 U.S. Patent and Trademark Center Washington, DC 20231

Sir:

In the Notice of Allowability dated November 22, 1999, the Examiner, on page 2 thereof, provided an explanation of Reasons for Allowance. The Examiner's statements with regard to the allowability of Claims 6 and 24 are not accurate. For Claim 6, the Examiner indicated that it recited the arrangement of a reduced area imaging device with the CMOS pixel array with resident timing and control circuitry, the second longitudinally aligned video processing board, and a non-removable lens integral with the imaging device. Claim 6 has no limitation directed to a second longitudinally aligned video processing board. As for Claim 24, the Examiner also stated that this claim recited the arrangement of the use of an endoscope, a CMOS pixel array with resident timing and control circuitry, and a second longitudinally aligned video processing board. Claim 24 has no limitation directed to a second longitudinally aligned video processing board. board. It was clearly understood through the prosecution of Claims 6 and 24 that they were allowable for additional reasons not articulated in the Notice of Allowability.

Respectfully submitted,

FIELDS & JOHNSON, P.C.

Gary D. Field\$/ Brent P. Johnson Attorneys for Applicant 8480 East Orchard Road Englewood, CO 80111

Date: 12/16/99

Samsung Exhibit 1003 Page 178 of 208



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In Re the Application of

Edwin L. Adair, Jeffrey L. Adair and Randall S. Adair

Serial No.: 09/175,685

Filed: October 20, 1998

For: "Reduced Area Imaging Devices"

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Samsung Exhibit 1003 Page 181 of 208

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Samsung Exhibit 1003 Page 187 of 208



United States Patent [19]

Adair et al.

[54] REDUCED AREA IMAGING DEVICES

- [76] Inventors: Edwin L. Adair, 317 Paragon Way, Castle Pines Village, Colo. 80104; Jeffrey L. Adair, 1861 E. Redfox Pl., Highlands Ranch, Colo. 80126; Randall S. Adair, 3082 S. Flamingo Way, Denver, Colo. 80222
- [21] Appl. No.: 09/175,685
- [22] Filed: Oct. 20, 1998

Related U.S. Application Data

- [63] Continuation-in-part of application No. 08/944,322, Oct. 6, 1997.

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Primary Examiner-Andy Rao

Attorney, Agent, or Firm-Fields and Johnson, P.C.

[57] ABSTRACT

A reduced area imaging device is provided for use in medical or dental instruments such as an endoscope. In one configuration of the imaging device, the image sensor is placed remote from the remaining circuitry. In another configuration, all of the circuitry to include the image sensor is placed in a stacked fashion at the same location. In a first embodiment of the invention, the entire imaging device can be placed at the distal tip of an endoscope. In a second embodiment, the image sensor is remote from the remaining circuitry according to the first configuration, and wherein a control box can be provided which communicates with the image sensor and is placed remotely from the endoscope. In yet another embodiment, the imaging device can be incorporated in the housing of a standard medical camera which is adapted for use with traditional rod lens endoscopes. In any of the embodiments, the image sensor may be placed alone on a first circuit board, or timing and control circuits may be included on the first circuit board containing the image sensor. One or more video processing boards can be stacked in a longitudinal fashion with respect to the first board, or the video processing boards may be placed in the control box.

32 Claims, 11 Drawing Sheets



Samsung Exhibit 1003 Page 188 of 208





Samsung Exhibit 1003 Page 190 of 208

















Samsung Exhibit 1003 Page 197 of 208





REDUCED AREA IMAGING DEVICES

This application is a continuation-in-part of U.S. Ser. No. 08/944,322, filed Oct. 6, 1997, and entitled "Reduced Area Imaging Devices Incorporated Within Surgical Instru- 5 ments."

TECHNICAL FIELD

This invention relates to solid state image sensors and associated electronics, and more particularly, to solid state 10 image sensors which are configured to be of a minimum size.

BACKGROUND ART

15 In recent years, endoscopic surgery has become the accepted standard for conducting many types of surgical procedures, both in the medical and dental arenas. The availability of imaging devices enabling a surgeon or dentist to view a particular surgical area through a small diameter 20 endoscope which is introduced into small cavities or openings in the body results in much less patient trauma as well as many other advantages.

In many hospitals, the rod lens endoscope is still used in endoscopic surgery. The rod lens endoscope includes a very 25 precise group of lenses in an elongate and rigid tube which are able to accurately transmit an image to a remote camera in line with the lens group. The rod lens endoscope, because of its cost of manufacture, failure rate, and requirement to be housed within a rigid and straight housing, is being increas- 30 on Integrated Process" found in *Electronic News*, Jan. 20, ingly replaced by solid state imaging technology which enables the image sensor to be placed at the distal tip of the investigating device. The three most common solid state image sensors include charged coupled devices (CCD), charge injection devices (CID) and photo diode arrays 35 imaging is the development of CMOS imaging sensor which (PDA). In the mid-1980s, complementary metal oxide semiconductors (CMOS) were developed for industrial use. CMOS imaging devices offer improved functionality and simplified system interfacing. Furthermore, many CMOS imagers can be manufactured at a fraction of the cost of 40 and sense amplifiers much like standard memory chips. With other solid state imaging technologies.

One particular advance in CMOS technology has been in the active pixel-type CMOS imagers which consist of randomly accessible pixels with an amplifier at each pixel site. One advantage of active pixel-type imagers is that the 45 amplifier placement results in lower noise levels than CCDs or other solid state imagers. Another major advantage is that these CMOS imagers can be mass produced on standard semiconductor production lines. One particularly notable advance in the area of CMOS imagers including active 50 has been called MOSAD (multiplexed over sample analog to pixel-type arrays is the CMOS imager described in U.S. Pat. No. 5,471,515 to Fossum, et al. This CMOS imager can incorporate a number of other different electronic controls that are usually found on multiple circuit boards of much larger size. For example, timing circuits, and special func- 55 tions such as zoom and anti-jitter controls can be placed on the same circuit board containing the CMOS pixel array without significantly increasing the overall size of the host circuit board. Furthermore, this particular CMOS imager requires 100 times less power than a CCD-type imager. In short, the CMOS imager disclosed in Fossum, et al. has enabled the development of a "camera on a chip."

Passive pixel-type CMOS imagers have also been improved so that they too can be used in an imaging device which qualifies as a "camera on a chip." In short, the major 65 difference between passive and active CMOS pixel arrays is that a passive pixel-type imager does not perform signal

amplification at each pixel site. One example of a manufacturer which has developed a passive pixel array with performance nearly equal to known active pixel devices and being compatible with the read out circuitry disclosed in the U.S. Pat. No. 5,471,515 is VLSI Vision, Ltd., 1190 Saratoga Avenue, Suite 180, San Jose, Calif. 95129. A further description of this passive pixel device may be found in co-pending application, Ser. No. 08/976,976, entitled "Reduced Area Imaging Devices Incorporated Within Surgical Instruments," and is hereby incorporated by reference.

In addition to the active pixel-type CMOS imager which is disclosed in U.S. Pat. No. 5,471,515, there have been developments in the industry for other solid state imagers which have resulted in the ability to have a "camera on a chip." For example, Suni Microsystems, Inc. of Mountain View, Calif., has developed a CCD/CMOS hybrid which combines the high quality image processing of CCDs with standard CMOS circuitry construction. In short, Suni Microsystems, Inc. has modified the standard CMOS and CCD manufacturing processes to create a hybrid process providing CCD components with their own substrate which is separate from the P well and N well substrates used by the CMOS components. Accordingly, the CCD and CMOS components of the hybrid may reside on different regions of the same chip or wafer. Additionally, this hybrid is able to run on a low power source (5 volts) which is normally not possible on standard CCD imagers which require 10 to 30 volt power supplies. A brief explanation of this CCD/CMOS hybrid can be found in the article entitled "Startup Suni Bets 1997 issue. This reference is hereby incorporated by reference for purposes of explaining this particular type of imaging processor.

Another example of a recent development in solid state is able to achieve analog to digital conversion on each of the pixels within the pixel array. This type of improved CMOS imager includes transistors at every pixel to provide digital instead of analog output that enable the delivery of decoders this new technology, it may, therefore, be possible to manufacture a true digital "camera on a chip." This CMOS imager has been developed by a Stanford University joint project and is headed by Professor Abbas el-Gamal.

A second approach to creating a CMOS-based digital imaging device includes the use of an over-sample converter at each pixel with a one bit comparator placed at the edge of the pixel array instead of performing all of the analog to digital functions on the pixel. This new design technology digital) conversion. The result of this new process is low power usage, along with the capability to achieve enhanced dynamic range, possibly up to 20 bits. This process has been developed by Amain Electronics of Simi Valley, Calif. A brief description of both of the processes developed by Stanford University and Amain Electronics can be found in an article entitled "A/D Conversion Revolution for CMOS Sensor?," September 1998 issue of Advanced Imaging. This reference is also hereby incorporated by reference for pur-60 poses of explaining these particular types of imaging processors.

The above-mentioned developments in solid state imaging technology have shown that "camera on a chip" devices will continue to be enhanced not only in terms of the quality of imaging which may be achieved, but also in the specific construction of the devices which may be manufactured by new breakthrough processes.

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Although the "camera on a chip" concept is one which has great merit for application in many industrial areas, a need still exists for a reduced area imaging device which can be used in even the smallest type of endoscopic instruments in order to view areas in the body that are particularly difficult 5 to access, and to further minimize patient trauma by an even smaller diameter invasive instrument.

It is one object of this invention to provide reduced area imaging devices which take advantage of "camera on a chip" technology, but rearrange the circuitry in a stacked 10 relationship so that there is a minimum profile presented when used within a surgical instrument or other investigative device. It is another object of this invention to provide low cost imaging devices which may be "disposable." It is yet another object of this invention to provide reduced area 15 imaging devices which may be used in conjunction with standard endoscopes by placing the imaging device through channels which normally receive other surgical devices, or receive liquids or gases for flushing a surgical area. It is yet another object of this invention to provide a surgical device 20 with imaging capability which may be battery powered and only requires one conductor for transmitting a pre-video signal to video processing circuitry within or outside the sterile field of the surgical area.

In addition to the intended use of the foregoing invention ²⁵ with respect to surgical procedures conducted by medical doctors, it is also contemplated that the invention described herein has great utility with respect to oral surgery and general dental procedures wherein a very small imaging device can be used to provide an image of particularly difficult to access locations. Additionally, while the foregoing invention has application with respect to the medical and dental fields, it will also be appreciated by those skilled in the art that the small size of the imaging device set forth herein can be applied to other functional disciplines wherein the imaging device can be used to view difficult to access locations for industrial equipment and the like. Therefore, the imaging device of this invention could be used to replace many industrial boroscopes.

The "camera on a chip" technology can be furthered improved with respect to reducing its profile area and incorporating such a reduced area imaging device into very small investigative instruments which can be used in the medical, dental, or other industrial fields.

DISCLOSURE OF THE INVENTION

In accordance with the present invention, reduced area imaging devices are provided. The term "imaging device" as used herein describes the imaging elements and processing 50 cessing circuitry. In the other configuration of the imaging circuitry which is used to produce a video signal which may be accepted by a standard video device such as a television or video monitor accompanying a personal computer. The term "image sensor" as used herein describes the components of a solid state imaging device which captures images 55 and stores them within the structure of each of the pixels in the array of pixels found in the imaging device. As further discussed below, the timing and control circuits can be placed either on the same planar structure as the pixel array, in which case the image sensor can also be defined as an 60 integrated circuit, or the timing and control circuitry can be placed remote from the pixel array. The terms "signal" or "image signal" as used herein, and unless otherwise more specifically defined, refer to an image which at some point during its processing by the imaging device, is found in the 65 ment specifically illustrating the arrangement of the image form of electrons which have been placed in a specific format or domain. The term "processing circuitry" as used

herein refers to the electronic components within the imaging device which receive the image signal from the image sensor and ultimately place the image signal in a usable format. The terms "timing and control circuits" or "circuitry" as used herein refer to the electronic components which control the release of the image signal from the pixel array.

In a first embodiment, the image sensor, with or without the timing and control circuitry, may be placed at the distal tip of the endoscopic instrument while the remaining processing circuitry may be found in a small remote control box which may communicate with the image sensor by a single cable.

In a second embodiment, the image sensor and the processing circuitry may all be placed in a stacked arrangement of circuit boards and positioned at the distal tip of the endoscopic instrument. In this embodiment, the pixel array of the image sensor may be placed by itself on its own circuit board while the timing and control circuitry and processing circuitry are placed on one or more other circuit boards. Alternatively, the circuitry for timing and control may be placed with the pixel array on one circuit board, while the remaining processing circuitry can be placed on one or more of the other circuit boards.

In yet another embodiment, the imaging device may be adapted for use with a standard rod lens endoscope wherein the imaging device is placed within a standard camera housing which is configured to connect to a standard "C" or "V" mount connector.

A generic endoscope may be used in the first and second embodiments which includes a very small diameter tubular portion which is inserted within the patient. The tubular portion may be made of a flexible material having a central lumen or opening therein for receiving the elements of the imaging device. The tubular portion may be modified to include an additional concentric tube placed within the central lumen and which enables a plurality of light fibers to be placed circumferentially around the periphery of the distal end of the tubular portion. Additionally, control wires may extend along the tubular portion in order to make the endoscope steerable. The material used to make the endoscope can be compatible with any desired sterilization protocol, or the entire endoscope can be made sterile and 45 disposable after use.

For the configuration of the imaging device which calls for the array of pixels and the timing and control circuitry to be placed on the same circuit board, only one conductor is required in order to transmit the image signal to the prodevice wherein the timing and control circuits are incorporated onto other circuit boards, a plurality of connections are required in order to connect the timing and control circuitry to the pixel array and the one conductor is also required to transmit the image signal.

BRIEF DESCRIPTION OF THE DRAWINGS

FIG. 1a illustrates a first embodiment including a fragmentary cross-sectional view of a generic endoscopic instrument, and a fragmentary perspective view of a control box, the endoscope and control box each incorporating elements of a reduced area imaging device;

FIG. 1b is an enlarged fragmentary partially exploded perspective view of the distal end of the endoscopic instrusensor with respect to the other elements of the tubular portion of the endoscope;

FIG. 2a is a fragmentary cross-sectional view of a second embodiment of this invention illustrating another generic endoscope wherein the imaging device is incorporated in its entirety at the distal tip of the endoscope;

FIG. 2b is an enlarged fragmentary partially exploded 5 perspective view of the distal end of the endoscope of FIG. 2a illustrating the imaging device;

FIG. 3a is an elevational fragmentary cross-sectional view of the image sensor incorporated with a standard camera housing for connection to a rod lens endoscope;

FIG. 3b is a fragmentary cross-sectional view of the imaging device incorporated within the camera housing of FIG. 3a;

FIG. 3c is a fragmentary cross-sectional view similar to 15 that of FIG. 3b illustrating a battery as an alternate source of power;

FIG. 4 is a schematic diagram of the functional electronic components which make up the imaging device;

FIG. 4a is an enlarged schematic diagram of a circuit 20 board which may include the array of pixels and the timing and control circuitry;

FIG. 4b is an enlarged schematic diagram of a video processing board having placed thereon the processing circuitry which processes the pre-video signal generated by the 25 array of pixels and which converts the pre-video signal to a post-video signal which may be accepted by a standard video device; and

example of specific circuitry which may be used to make the imaging device.

BEST MODE FOR CARRYING OUT THE INVENTION

In accordance with one embodiment of the invention as shown in FIG. 1a, an endoscope 10 is provided which incorporates a reduced area imaging device 11, shown in FIG. 1b. As further discussed below, the elements of the imaging device may all be found at one location or the 40 fied to be in a planar and circular shape to better fit within elements may be separated from one another and interconnected by the appropriate cable(s). The array of pixels making up the image sensor captures images and stores them in the form of electrical energy by conversion of light photons to electrons. This conversion takes place by the 45 prior to it being impinged upon the array of pixels on the photo diodes in each pixel which communicate with one or more capacitors which store the electrons. The structure of the endoscope 10 includes a flexible or rigid tubular portion 14 which is inserted into the body of the patient and is placed at the appropriate location for viewing a desired surgical 50 1b, there are only three conductors which are necessary for area. The tubular portion 14 attaches at its proximal end to a handle portion 12 which may be grasped by a surgeon who is conducting the endoscopic procedure. The handle 12 may include a central lumen or channel 13 which receives therethrough one or more cables or other structures which 55 image signal conductor 48 each of which are hard wired to extend to the distal end 16 of tubular portion 14. Handle portion 12 may further include a supplementary channel 15 which intersects with central channel 13 and which may provide another point of entry for other cables, fluids or operative instruments to be placed through the endoscope. 60

FIG. 1b illustrates the distal end of the endoscope 16. The distal end 16 may be characterized by an outer tube 18 which traverses the length of the tubular portion 14 and connects to the handle portion 12. Placed concentrically within the outer tube 18 may be one or more inner tubes 20. In FIG. 1b, the 65 gap between inner tube 20 and outer tube 18 forms a space in which one or more light fibers 22 or control wires 24 may

be placed. As well understood by those skilled in the art, a plurality of circumferentially spaced light fibers as illustrated in FIG. 1b can be used to illuminate the surgical site. Additionally, the control wires 24 may communicate with a control mechanism (not shown) integrated on the handle portion 12 for manipulating the distal end 16 of the endoscope in a desired direction. The flexible tubular portion 14 coupled with a steerable feature enables the endoscope to be placed within winding bodily passages or other locations difficult to reach within the body.

An image sensor 40 may be placed within the central channel defined by inner tube 20. In the configuration shown in FIG. 1b, a cable 26 is used to house the conductors which communicate with the image sensor 40. An intermediate support tube 28 may be placed concentrically outside of cable 26 and concentrically within inner tube 20 to provide the necessary support for the cable 26 as it traverses through the inner channel defined by inner tube 20. In lieu of support tube 28, other well-known means may be provided to stabilize the cable 26 such as clips or other fastening means which may attach to the inner concentric surface of inner tube 20.

A control box 30 may be placed remote from the endoscope 10. The control box 30 contains some of the processing circuitry which is used to process the image signal produced by image sensor 40. Therefore, the imaging device 11 as previously defined would include the processing circuitry within control box 30 and the image sensor 40 located at the distal tip of the endoscope. Control box 30 FIGS. 5a-5e are schematic diagrams that illustrate an $_{30}$ communicates with image sensor 40 by means of cable 32 which may simply be an insulated and shielded cable which houses therein cable 26. Cable 32 is stabilized with respect to the handle portion 12 by means of a fitting 34 which ensures that cable 32 cannot be inadvertently pushed or 35 pulled within channel 13. Additionally, an additional fitting 35 may be provided to stabilize the entry of a light cable 36 which houses the plurality of light fibers 22.

> Image sensor 40 is illustrated as being a planar and square shaped member. However, the image sensor may be modithe channel defined by inner tube 20. Accordingly, FIG. 1b further shows an alternate shaped image sensor 40' which is round. A lens group or system 42 may be incorporated at the distal end of the endoscope in order to manipulate the image image sensor 40. This lens system 42 may be sealed at the distal end 16 of the endoscope so that the tubular portion 14 is impervious to fluids entering through the distal end 16. In the configuration of the imaging device 11 in FIGS. 1a and providing power to the image sensor 40, and for transmitting an image from the image sensor 40 back to the processing circuitry found within control box 30. Namely, there is a power conductor 44, a grounding conductor 46, and an the image sensor. Thus, cable 26 may simply be a threeconductor 50 ohm cable.

> Image sensor 40 can be as small as 1 mm in its largest dimension. However, a more preferable size for most endoscopic procedures would dictate that the image sensor 40 be between 4 mm to 8 mm in its largest dimension. The image signal transmitted from the image sensor through conductor 48 is also herein referred to as a pre-video signal. Once the pre-video signal has been transmitted from image sensor 40 by means of conductor 48, it is received by video processing board 50. Video processing board 50 then carries out all the necessary conditioning of the pre-video signal and places it

in a form so that it may be viewed directly on a standard video device, television or standard computer video monitor. The signal produced by the video processing board 50 can be further defined as a post-video signal which can be accepted by a standard video device. As shown in FIG. 1a, 5 a conductor 49 is provided which transmits the post-video signal to an output connector 58 on the exterior surface of control box 30. The cable (not shown) extending from the desired video device (not shown) may receive the post-video signal by means of connector 58. Power supply board 52 may convert incoming power received through power source 54 into the desired voltage. In the preferred imager incorporated in this invention, the power to the imaging device is simply a direct current which can be a 1.5 volt to a 12 volt source. Incoming power from, for example, a wall receptacle, communicates with power supply board 52 by connector 56. Power supply board 52 takes the incoming power source and regulates it to the desired level. Additionally, ground 46 is also shown as extending back to the source of power through connector 56.

FIG. 2a illustrates a second embodiment of this invention wherein the imaging device is self-contained entirely within the distal end 16 of the endoscope, and a power source which drives the circuitry within the imaging device may come from a battery 66 housed within handle portion 12.

As shown in FIG. 2b, the video processing board 50 may be placed directly behind image sensor 40. A plurality of pin connectors 62 serve to electrically couple image sensor 40 with video processing board 50 depending upon the specific configuration of image sensor 40, pin connectors 62 may be 30 provided either for structural support only, or to provide a means by which image signals are transmitted between image sensor 40 and board 50. When necessary, one or more supplementary boards 60 may be provided which further present it in a form which may be directly received by a desired video device. The area which is occupied by image sensor 40 may be defined as the profile area of the imaging device and which determines its critical dimensions. Any imaging elements that are found on boards 50 or 60 must be 40 able to be placed on one or more circuit boards which are longitudinally aligned with image sensor 40 along longitudinal axis XX. If the profile area is not critical in terms of limiting the largest sized imaging element within the imaging device, then the additional circuit boards 50 and 60 45 which are normally placed in line with image sensor 40 can be aligned in an offset manner or may be larger than the profile area of image sensor 40. In the configuration of FIG. 2b, it is desirable that elements 40, 50 and 60 be approximately the same size so that they may fit uniformly within 50 eter channel which may allow conductor 48 or 49 to comthe central channel of the endoscope. Additionally, image sensor 40 may be bonded to lens system 42 in order to provide further structural support to the imaging device 11 when mounted within the distal end 16.

Referring back to the handle portion 12 in FIG. 2a, an 55 additional channel 64 may be provided in order that a power supply cable 68 may communicate with battery 66. Conveniently, battery 66 may itself be mounted within a well 65 formed in handle portion 12. Cable 68 carries the conductor 44 and ground 46. Cable 68 may intersect with 60 cable 33 within channel 13, cables 68 and 33 extending then to the distal end 16. Cable 33 can be a single conductor cable which transmits the post-video signal to a desired video device. In other words, cable 33 may simply be an insulated and shielded housing for conductor 49 which carries the 65 post-video signal. Because a preferred image sensor of the imaging device 11 may only require a 5 volt power supply,

a battery is an ideal power source in lieu of a conductor which would trail the endoscope. Accordingly, the endoscope is made more mobile and easier to handle by eliminating at least one of the trailing cables.

FIG. 3a illustrates vet another preferred embodiment of this invention, wherein the imaging device can be used in conjunction with a standard rod lens endoscope 70. As shown, rod lens endoscope 70 includes a lens train 72 which includes a plurality of highly precise lenses (not shown) which are able to transmit an image from the distal end of the endoscope, to a camera in line with the endoscope. The rod lens endoscope is equipped with a light guide coupling post 74. Light guide post 74 connects to a source of light in the form of a cable 77 having a plurality of fiber optic strands 15 (not shown) which communicate with a source of light (not shown). The most common arrangement of the rod lens endoscope also includes a "C" or "V" mount connector 78 which attaches to the eyepiece 76. The "C" or "V" mount attaches at its other end to a camera group 80. The camera group 80 houses one or more of the elements of the imaging 20 device. In this embodiment, the small size of the imaging device is not a critical concern since the imaging device is not being placed at the distal end of the endoscope. However, the incorporation of the imaging device in a housing which would normally hold a traditional camera 25 still provides an advantageous arrangement. As shown, the camera group 80 may include a housing 82 which connects to a power/video cable 86. Fitting 87 is provided to couple cable 86 to the interior elements of the camera group 80 found within housing 82. FIG. 3a illustrates an arrangement of the imaging device 11 wherein the image sensor 40 is placed by itself within the housing 82 and the processing circuitry of the imaging device can be positioned in a remote control box as shown in FIG. 1a. Accordingly, only three contain processing circuitry to process the image signal and 35 conductors 44, 46 and 48 are necessary for providing power to the image sensor 40 and for transmitting the pre-video signal to the control box. Alternatively, as shown in FIG. 3b, the entire imaging device 11 may be incorporated within camera group 80, each of the elements of the imaging device being placed in the stacked arrangement similar to FIG. 2b. As discussed above, size is not as much of a concern in the embodiment of FIG. 3a and 3b since the camera group housing 82 is much larger than the distal tip of the endoscope of FIGS. 1a and 2a.

> FIG. 3c also illustrates the use of a battery 66 which provides source of power to the imaging device in either FIG. 3a or 3b. In this arrangement, housing 82 is altered to include a battery housing 69 which houses the battery 66 therein. Battery housing 69 may include a very small diammunicate directly with the processing circuitry or video device, respectively. It will also be understood that the embodiment in FIG. 1a may incorporate the use of a battery 66 as the source of power. Thus, handle 12 in FIG. 1a may be altered in the same way as housing 82 to allow a battery to be attached to the handle portion 12.

> FIG. 4 is a schematic diagram illustrating one way in which the imaging device 11 may be constructed. As illustrated, the image sensor 40 may include the timing and control circuits on the same planar structure. Power is supplied to image sensor 40 by power supply board 52. The connection between image sensor 40 and board 52 may simply be a cable having two conductors therein, one for ground and another for transmitting the desired voltage. These are illustrated as conductors 44 and 46. The output from image sensor 40 in the form of the pre-video signal is input to video processor board 50 by means of the conductor

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48. In the configuration of FIG. 4, conductor 48 may simply be a 50 ohm conductor. Power and ground also are supplied to video processing board 50 by conductors 44 and 46 from power supply board 52. The output signal from the video processor board 50 is in the form of the post-video signal and which may be carried by conductor 49 which can also be a 50 ohm conductor.

In the first embodiment illustrated in FIG. 1a, cable 32 can be used to house conductors 44, 46 and 48. In the embodiment shown in FIG. 2a, cable 33 can be used to house 10 conductor 49 by itself when a battery power source is used, or alternatively, cable 33 may house conductors 44, 46 and 49 if the embodiment of FIG. 2a utilizes a power source from board 52.

Optionally, a supplementary processing board 60 may be 15 provided to further enhance the pre-video signal. As shown in FIG. 4, the supplementary board 60 may be placed such that the pre-video signal from image sensor 40 is first sent to the supplementary board and then output to the video processor board 50. In this case, the output from board 50 can be carried along conductor 51. This output can be defined as an enhanced pre-video signal. Furthermore, the post-video signal from video processor board 50 may return to the supplementary board 60 for further processing, as further discussed below. The conductor used to transmit the 25 post-video signal back to the supplementary board is shown as conductor 59. The power supply board 52 may also provide power to the supplementary board in the same manner as to image sensor 40 and board 50. That is, a simple hard-wired connection is made onto the supplementary 30 encompasses any image sensor which may be configured for board for the ground and voltage carrying conductors. As discussed above, image sensor 40 may be placed remotely from boards 50 and 60. Alternatively, image sensor 40, and boards 50 and 60 each may be placed within the distal end of the endoscope.

Although FIG. 4 illustrates the image sensor and the timing and control circuits being placed on the same planar structure, it is possible to separate the timing and control circuits from the pixel array and place the timing and control circuits onto video processing board 50. The advantage in 40 placing the timing and control circuits on the same planar structure as the image sensor is that only three connections are required between image sensor 40 and the rest of the imaging device, namely, conductors 44, 46 and 48. Additionally, placing the timing and control circuits on the 45 same planar structure with the pixel array results in the pre-video signal having less noise. Furthermore, the addition of the timing and control circuits to the same planar structure carrying the image sensor only adds a negligible amount of array is to be the only element on the planar structure, then additional connections must be made between the planar structure and the video processing board 50 in order to transmit the clock signals and other control signals to the a plurality of 50 ohm coaxial cables (not shown) must be used in order to control the downloading of information from the pixel array. Each of these additional connections would be hard wired between the boards.

FIG. 4a is a more detailed schematic diagram of image 60 sensor 40 which contains an array of pixels 90 and the timing and control circuits 92. One example of a pixel array 90 which can be used within the invention is similar to that which is disclosed in U.S. Pat. No. 5,471,515 to Fossum, et al., said patent being incorporated by reference herein. More 65 specifically, FIG. 3 of Fossum, et al. illustrates the circuitry which makes up each pixel in the array of pixels 90. The

array of pixels 90 as described in Fossum, et al. is an active pixel group with intra-pixel charged transfer. The image sensor made by the array of pixels is formed as a monolithic complementary metal oxide semiconductor integrated circuit which may be manufactured in an industry standard complementary metal oxide semiconductor process. The integrated circuit includes a focal plane array of pixel cells, each one of the cells including a photo gate overlying the substrate for accumulating the photo generated charges. In broader terms, as well understood by those skilled in the art, an image impinges upon the array of pixels, the image being in the form of photons which strike the photo diodes in the array of pixels. The photo diodes or photo detectors convert the photons into electrical energy or electrons which are stored in capacitors found in each pixel circuit. Each pixel circuit has its own amplifier which is controlled by the timing and control circuitry discussed below. The information or electrons stored in the capacitors is unloaded in the desired sequence and at a desired frequency, and then sent to 20 the video processing board 50 for further processing.

Although the active pixel array disclosed in U.S. Pat. No. 5,471,515 is mentioned herein, it will be understood that the hybrid CCD/CMOS described above, or any other solid state imaging device may be used wherein timing and control circuits can be placed either on the same planar structure with the pixel array, or may be separated and placed remotely. Furthermore, it will be clearly understood that the invention claimed herein is not specifically limited to an image sensor as disclosed in the U.S. Pat. No. 5,471,515, but use in conjunction with the other processing circuitry which makes up the imaging device of this invention.

The timing and control circuits 92 are used to control the release of the image information or image signal stored in 35 the pixel array. In the image sensor of Fossum, et al., the pixels are arranged in a plurality of rows and columns. The image information from each of the pixels is first consolidated in a row by row fashion, and is then downloaded from one or more columns which contain the consolidated information from the rows. As shown in FIG. 4a, the control of information consolidated from the rows is achieved by latches 94, counter 96, and decoder 98. The operation of the latches, counter and decoder is similar to the operation of similar control circuitry found in other imaging devices. That is, a latch is a means of controlling the flow of electrons from each individual addressed pixel in the array of pixels. When a latch 94 is enabled, it will allow the transfer of electrons to the decoder 98. The counter 96 is programmed to count a discrete amount of information based upon a clock size to one dimension of the planar structure. If the pixel 50 input from the timing and control circuits 92. When the counter 96 has reached its set point or overflows, the image information is allowed to pass through the latches 94 and be sent to the decoder 98 which places the consolidated information in a serial format. Once the decoder 98 has decoded pixel array. For example, a ribbon-type cable (not shown) or 55 the information and placed it in the serial format, then the row driver 100 accounts for the serial information from each row and enables each row to be downloaded by the column or columns. In short, the latches 94 will initially allow the information stored in each pixel to be accessed. The counter 96 then controls the amount of information flow based upon a desired time sequence. Once the counter has reached its set point, the decoder 98 then knows to take the information and place it in the serial format. The whole process is repeated, based upon the timing sequence that is programmed. When the row driver 100 has accounted for each of the rows, the row driver reads out each of the rows at the desired video rate.

The information released from the column or columns is also controlled by a series of latches 102, a counter 104 and a decoder 106. As with the information from the rows, the column information is also placed in a serial format which may then be sent to the video processing board 50. This 5 serial format of column information is the pre-video signal carried by conductor 48. The column signal conditioner 108 places the column serial information in a manageable format in the form of desired voltage levels. In other words, the from the downloaded column(s).

The clock input to the timing and control circuits 92 may simply be a quartz crystal timer. This clock input is divided into many other frequencies for use by the various counters. The run input to the timing and control circuit 92 may 15 simply be an on/off control. The default input can allow one to input the pre-video signal to a video processor board which may run at a frequency of other than 30 hertz. The data input controls functions such as zoom. At least for a CMOS type active pixel array which can be accessed in a 20 random manner, features such as zoom are easily manipulated by addressing only those pixels which locate a desired area of interest by the surgeon.

A further discussion of the timing and control circuitry which may be used in conjunction with an active pixel array is disclosed in U.S. Pat. No. 5,471,515 and is also described in an article entitled "Active Pixel Image Sensor Integrated With Readout Circuits" appearing in NASA Tech Briefs, October 1996, pp. 38 and 39. This particular article is also 30 incorporated by reference.

Once image sensor 40 has created the pre-video signal, it is sent to the video processing board 50 for further processing. At board 50, as shown in FIG. 4b, the pre-video signal is passed through a series of filters. One common filter 35 arrangement may include two low pass filters 114 and 116, and a band pass filter 112. The band pass filter only passes low frequency components of the signal. Once these low frequency components pass, they are then sent to detector 120 and white balance circuit 124, the white balance circuit 40 distinguishing between the colors of red and blue. The white balance circuit helps the imaging device set its normal, which is white. The portion of the signal passing through low pass filter 114 then travels through gain control 118 which reduces the magnitude or amplitude of this portion to a manageable level. The output from gain control 118 is then fed back to the white balance circuit 124. The portion of the signal traveling through filter 116 is placed through the processor 122. In the processor 122, the portion of the signal carrying the luminance or non-chroma is separated and sent to the Y chroma mixer 132. Any chroma portion of the signal is held in processor 122.

Referring to the output of the white balance circuit 124, this chroma portion of the signal is sent to a delay line 126 where the signal is then further reduced by switch 128. The 55 output of switch 128 is sent through a balanced modulator 130 and also to the Y chroma mixer 132 where the processed chroma portion of the signal is mixed with the processed non-chroma portion. Finally, the output from the Y chroma mixer 132 is sent to the NTSC/PAL encoder 134, commonly known in the art as a "composite" encoder. The composite frequencies are added to the signal leaving the Y chroma mixer 132 in encoder 134 to produce the post-video signal which may be accepted by a television.

Referring back to FIG. 4, it further illustrates supplemen- 65 tary board 60 which may be used to digitally enhance or otherwise further condition the pre-video signal produced

from image sensor 40. For example, digital enhancement can brighten or otherwise clarify the edges of an image viewed on a video screen. Additionally, the background images may be removed thus leaving only the foreground images or vice versa. The connection between image sensor 40 and board 60 may simply be the conductor 48 which may also transfer the pre-video signal to board 50. Once the pre-video signal has been digitally enhanced on supplementary board 60, it is then sent to the video processor board 50 column signal conditioner 108 only accepts desired voltages 10 by means of another conductor 51. The pre-video signal is an analog signal. The digitally enhanced pre-video signal may either be a digital signal or it may be converted back to the analog domain prior to being sent to board 50.

In addition to digital enhancement, supplementary board 60 may further include other circuitry which may further condition the post-video signal so that it may be viewed in a desired format other than NTSC/PAL. As shown in FIGS. 4, intermediate conductor 59 may transmit the signal output from Y chroma mixer 132 back to the supplementary board 60 where the signal is further encoded for viewing in a particular format. One common encoder which can be used includes an RGB encoder 154. The RGB encoder separates the signal into three separate colors (red, green and blue) so that the surgeon may selectively choose to view only those images containing one or more of the colors. Particularly in tissue analysis where dyes are used to color the tissue, the RGB encoder may help the surgeon to identify targeted tissue.

The next encoder illustrated in FIG. 4 is a SVHS encoder 156 (super video home system). This encoder splits or separates the luminance portion of the signal and the chroma portion of the signal prior to entering the video device. Some observers believe that a cleaner signal is input to the video device by such a separation which in turn results in a more clear video image viewed on the video device. The last encoder illustrated in FIG. 4 is a VGA encoder 158 which enables the signal to be viewed on a standard VGA monitor which is common to many computer monitors.

One difference between the arrangement of image sensor 40 and the outputs found in FIG. 3 of the Fossum, et al. patent is that in lieu of providing two analog outputs [namely, VS out (signal) and VR out (reset)], the reset function takes place in the timing and control circuitry 92. Accordingly, the pre-video signal only requires one conductor 48

FIGS. 5a-5e illustrate in more detail one example of circuitry which may be used in the video processing board 50 in order to produce a post-video signal which may be 50 directly accepted by a video device such as a television. The circuitry disclosed in FIGS. 5a-5e is very similar to circuitry which is found in a miniature quarter-inch Panasonic camera, Model KS-162. It will be understood by those skilled in the art that the particular arrangement of elements found in FIGS. 5a-5e are only exemplary of the type of video processing circuitry which may be incorporated in order to take the pre-video signal and condition it to be received by a desired video device.

As shown in FIG. 5a, 5 volt power is provided along with ₆₀ a ground by conductors 44 and 46 to board 50. The pre-video signal carried by conductor 48 is buffered at buffer 137 and then is transferred to amplifying group 138. Amplifying group 138 amplifies the signal to a usable level as well as achieving impedance matching for the remaining circuitry.

The next major element is the automatic gain control 140 shown in FIG. 5b. Automatic gain control 140 automatically controls the signal from amplifying group 138 to an acceptable level and also adds other characteristics to the signal as discussed below. More specifically, automatic gain control **140** conditions the signal based upon inputs from a **12** channel digital to analog converter **141**. Converter **141** retrieves stored information from EEPROM (electrically 5 erasable programmable read only memory) **143**. EEPROM **143** is a non-volatile memory element which may store user information, for example, settings for color, tint, balance and the like. Thus, automatic gain control **140** changes the texture or visual characteristics based upon user inputs. The 10 signal leaving the automatic gain control **140** is an analog signal until being converted by analog to digital converter **142**.

Digital signal processor 144 of FIG. 5c further processes the converted signal into a serial type digital signal. One ¹⁵ function of the microprocessor 146 is to control the manner in which digital signal processor 144 sorts the digital signals emanating from converter 142. Microprocessor 146 also controls analog to digital converter 142 in terms of when it is activated, when it accepts data, when to release data, and ²⁰ the rate at which data should be released. Microprocessor 146 may also control other functions of the imaging device such as white balance. The microprocessor 146 may selectively receive the information stored in the EEPROM 143 and carry out its various commands to further control the ²⁵ other elements within the circuitry.

After the signal is processed by digital signal processor **144**, the signal is sent to digital encoder **148** illustrated in FIG. **5***d*. Some of the more important functions of digital encoder **148** are to encode the digital signal with ³⁰ synchronization, modulated chroma, blanking, horizontal drive, and the other components necessary so that the signal may be placed in a condition for reception by a video device such as a television monitor. As also illustrated in FIG. **5***d*, once the signal has passed through digital encoder **148**, the ³⁵ signal is reconverted into an analog signal through digital to analog converter **150**.

This reconverted analog signal is then buffered at buffers 151 and then sent to amplifier group 152 of FIG. 5e which amplifies the signal so that it is readily accepted by a desired video device. Specifically, as shown in FIG. 5e, one SVHS outlet is provided at 160, and two composite or NTSC outlets are provided at 162 and 164, respectively.

From the foregoing, it is apparent that an entire imaging device may be incorporated within the distal tip of an endoscope, or may have some elements of the imaging device being placed in a small remote box adjacent to the endoscope. Based upon the type of image sensor used, the profile area of the imaging device may be made small solution to be placed into an endoscope which has a very small diameter tube. Additionally, the imaging device may be placed into the channels of existing endoscopes to provide additional imaging capability without increasing the size of the endoscope. The imaging device may be powered by a standard power input connection in the form of a power cord, or a small lithium battery may be used.

This invention has been described in detail with reference to particular embodiments thereof, but it will be understood that various other modifications can be effected within the $_{60}$ spirit and scope of this invention.

What is claimed is:

1. A reduced area imaging device comprising:

an imager sensor lying in a first plane and including an array of CMOS pixels for receiving images thereon, 65 said image sensor further including circuitry means on said first plane and coupled to said array of CMOS pixels for timing and control of said array of CMOS pixels, said image sensor producing a pre-video signal;

- a pre-video conductor for transmitting said pre-video signal, said pre-video conductor having first and second ends, said first end communicating with said image sensor;
- a first circuit board lying in a second plane and longitudinally aligned with said image sensor, said first circuit board being connected to said pre-video conductor at said second end thereof, said first circuit board including circuitry means for converting said pre-video signal to a post-video signal for direct reception by a standard video device;
- a power supply electrically coupled with said image sensor for driving said array of pixels and said timing and control means, and electrically coupled to said first circuit board for driving said circuit board; and
- a non-removable lens integral with said imaging device for focusing images on said image sensor.

2. A reduced area imaging device, as claimed in claim 1, wherein:

said image sensor defines a profile area in said first plane, and said first circuit board being positioned so as not to extend substantially beyond said profile area.

3. A reduced area imaging device, as claimed in claim 1, further including:

a second circuit board electrically coupled with said first circuit board and said image sensor for enhancing said pre-video signal prior to reception by said first circuit board, said second circuit board being longitudinally aligned with said first circuit board and said image sensor so as not to extend substantially beyond said profile area.

4. A reduced area imaging device, as claimed in claim 1, wherein:

said first and second planes are offset from and substantially parallel to one another.

5. A reduced area imaging device, as claimed in claim 3, 40 wherein:

- said second circuit board lies in a third plane which is offset from and extends substantially parallel to said first and second planes.
- 6. A reduced area imaging device comprising:
- an image sensor lying in a first plane and including an array of CMOS pixels for receiving images thereon, said image sensor further including circuitry means on said first plane and coupled to said array of CMOS pixels for timing and control of said array of CMOS pixels, said image sensor producing a pre-video signal;
- a control box remote from said image sensor, said control box including circuitry means for receiving said prevideo signal from said image sensor, and for converting said pre-video signal to a post-video signal which may be received by a standard video device;
- a power supply coupled to said control box and said image sensor for providing power thereto; and
- a non-removable lens integral with said imaging device for focusing images on said image sensor.

7. A reduced area imaging device, as claimed in claim 6, wherein said control box further includes:

a supplementary circuit board for digitally enhancing the pre-video signal, said supplementary circuit board coupled to said circuitry means for receiving said pre-video signal and for converting said pre-video signal.

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8. A reduced area imaging device, as claimed in claim 1, wherein said array of CMOS pixels further includes:

- an array of passive CMOS pixels, wherein individual passive CMOS pixels of said array of passive CMOS pixels each includes a photo diode for producing photoelectrically generated signals and an access transistor communicating with said photo diode to control the release of said photoelectrically generated signals.
- 9. A reduced area imaging device comprising:
- an array of CMOS pixels defining a profile area and lying ¹⁰ in a first plane, said array of CMOS pixels for receiving images thereon;
- a circuit board longitudinally aligned with and electrically coupled to said array of CMOS pixels, said circuit board lying in a second plane which is offset from said first plane and substantially parallel to said first plane, said circuit board including circuitry means for timing and control of said array of CMOS pixels, said timing and control means producing a pre-video signal, said circuit board further including circuitry means for receiving said pre-video signal from said timing and control means and converting said pre-video signal to a post-video output signal for direct reception by a video device;
- a power supply electrically coupled to said array of said CMOS pixels and said circuit board; and
- a non-removable lens integral with said imaging device for focusing images on said image sensor.

10. A reduced area imaging device, as claimed in claim 9 30 ing: wherein:

said array of CMOS pixels includes an array of passive CMOS pixels.

11. A reduced area imaging device, as claimed in claim 9, further including:

 a supplementary circuit board communicating with said array of CMOS pixels and said circuit board for enhancing said pre-video signal, said supplementary circuit board being longitudinally aligned with said array of CMOS pixels and said circuit board, and being positioned so as not to extend substantially beyond said profile area.

12. An endoscope with integral imaging capability for producing images to be viewed on a video device, said endoscope comprising:

- a tubular portion including a distal end, a proximal end and a central passageway extending therethrough;
- means for providing light to said distal end to illuminate a surgical site;
- a CMOS image sensor lying in a first plane and positioned at said distal end of said tubular portion for receiving images of the surgical site, said CMOS image sensor defining a profile area, and said CMOS image sensor producing an image signal;
- circuitry means electrically coupled to said CMOS image sensor for timing and control of said CMOS image sensor, said circuitry means for timing and control placed within said tubular portion;
- a video processor board lying in a second plane spaced 60
 a from and longitudinally aligned with said CMOS
 image sensor within said tubular portion and adjacent
 said distal end thereof and communicating with said
 CMOS image sensor to receive said image signal, said
 video processor board including circuitry means for 65 ing:
 processing said image signal and converting said image
 a signal to a post-video signal for direct reception by the

video device, said video processor board being positioned so as not to extend substantially beyond said profile area; and

- a power supply electrically coupled to said CMOS image sensor and said video processor board.
- 13. An endoscope, as claimed in claim 12, wherein:
- said CMOS image sensor includes an array of CMOS pixels, and wherein individual CMOS pixels within said array of CMOS pixels each includes an amplifier.14. An endoscope, as claimed in claim 12, wherein:
- said CMOS image sensor includes a plurality of passive CMOS pixels.
- 15. An endoscope, as claimed in claim 12, wherein:
- said CMOS image sensor includes a plurality of passive CMOS pixels, and wherein individual passive CMOS pixels of said plurality of passive CMOS pixels each includes a photo diode for producing photoelectrically generated signals, and an access transistor communicating with said photo diode to control the release of said photoelectrically generated signals.
- 16. An endoscope, as claimed in claim 12, wherein:
- said circuitry means for timing and control is placed on said first plane adjacent said CMOS image sensor.
- 17. An endoscope, as claimed in claim 12, wherein:
- said circuitry means for timing and control is placed on said second plane adjacent said circuitry means for processing and converting.

18. An endoscope, as claimed in claim 12, further includng:

- a handle connected to said proximal end of said tubular portion for grasping by surgeon.
- 19. An endoscope, as claimed in claim 12, further including:
- a lens positioned at said distal end of said tubular portion and distally of said CMOS image sensor for producing a modified image on said CMOS image sensor.
- 20. An endoscope, as claimed in claim 12, wherein:
- said power supply is a battery attached to said handle.
- 21. An endoscope, as claimed in claim 12, wherein:
- said second plane is offset from and substantially parallel to said first plane.

22. An endoscope comprising:

- a tubular portion including a central passageway extending therethrough, a proximal end and a distal end;
- a CMOS image sensor positioned at said distal end of said tubular portion for receiving images of a surgical site, said CMOS imager defined by an array of CMOS pixels and, said CMOS imager lying in a first plane;
- circuitry means for timing and control of said CMOS image sensor placed adjacent to said CMOS image sensor on said first plane;
- a control box remote from said tubular portion and coupled to said CMOS image sensor, said control box including circuitry means for receiving a pre-video signal from said CMOS image sensor, and for converting said pre-video signal to a post-video signal which may be received by a standard video device; and
- a power supply coupled to said control box and said CMOS image sensor for providing power thereto.
- 23. An endoscope, as claimed in claim 22, wherein:
- said power supply is located in said control box.

24. An endoscope, as claimed in claim 22, further includ-

a handle connected to said proximal end of said tubular portion for grasping by a surgeon. 25. An endoscope, as claimed in claim 22, further including:

a supplementary circuit board for digitally enhancing said pre-video signal, said supplementary circuit board electrically coupled to said circuitry means for receiving ⁵ and converting.

26. An endoscope, as claimed in claim 22, further including:

- a lens positioned at said distal end of said tubular portion of sensor.
- 27. An endoscope, as claimed in claim 22, wherein:
- said power supply is a battery attached to said handle.

28. A reduced area imaging device comprising:

- an array of CMOS pixels defining a profile area and lying 15 in a first plane, said array of said CMOS pixels for receiving images thereon;
- a circuit board longitudinally aligned with and electrically coupled to said array of CMOS pixels, said circuit board lying in a second plane which is offset from said 20 first plane and substantially parallel to said first plane, said circuit board including timing and control means for controlling the release of information from said array of CMOS pixels, said timing and control means producing a pre-video signal; 25
- a control box remote from said array of said CMOS pixels and said circuit board, said control box including circuitry means for receiving said pre-video signal, and for converting said pre-video signal to a post-video signal which may be received by a standard video ³⁰ device;

- a power supply coupled to said control box, said array of CMOS pixels and said timing and control means for providing power thereto; and
- a non-removable lens integral with said imaging device for focusing images on said array of CMOS pixels.
- **29**. A reduced area imaging device, as claimed in claim **28**, wherein said array of CMOS pixels further includes:
- an array of passive CMOS pixels, wherein individual passive CMOS pixels of said array of passive CMOS pixels each includes a photo diode for producing photoelectrically generated signals; and
- an access transistor communicating with said photo diode to control the release of said photoelectrically generated signals.
- **30**. A reduced area imaging device, as claimed in claim **28**, wherein said array of CMOS pixels further includes:
 - an array of active CMOS pixels, wherein individual active CMOS pixels within said array of active CMOS pixels each includes an amplifier.
 - 31. An endoscope, as claimed in claim 22, wherein:
 - individual pixels within said array of CMOS pixels each include an amplifier.
 - 32. An endoscope, as claimed in claim 22, wherein:
 - said array of CMOS pixels includes a plurality of passive CMOS pixels, and wherein individual passive CMOS pixels of said plurality of passive CMOS pixels each include a photo diode for producing photo electrically generated signals, and an access transistor communicating with said photo diode to control the release of said photo electrically generated signals.

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